

MCU with 2KB ECC SRAM/32KB ECC E-Flash for Touch Key

GENERAL DESCRIPTION

CS8974 is a general-purpose MCU with 32KB code memory (organized as 32Kx16) of embedded-flash memory and 2KB (organized as 2Kx13) SRAM for data manipulations. Both SRAM and e-Flash implement built-in ECC that corrects 1-bit error and detects two-bit errors. CPU can access the e-Flash through program address read and through Flash Controller which can perform software read/write operations of e-Flash for EEPROM emulations.

CPU in CS8974 is 1-T 8051 with enhanced multiplication and division accelerator. There are two clock sources for the system, one is a 16MHz IOSC (manufacturer calibrated +/- 2%) and the other one is SOSC32KHz (typical 32KHz) which is divided by a slow oscillator (SOSC) 128KHz. Both clock sources have a clock programmable divider for scaling down the frequency to save power dissipations. The clock selections are combined with flexible power management schemes, including NORMAL, IDLE, STOP, and SLEEP modes to balance speed and power consumption.

There are T0/T1/T2/T3/T4/T5 timers coupled with CPU and two WDT where WDT0 is clocked by SYSCLK, and WDT2/WDT3 are clocked by a non-stop SOSC32KHz. An 8-bit/16-bit checksum and 16-bit CRC accelerator is included. There are a EUART/LIN controller, I²C master and slave controllers, and a SPI master/slave controller. The interfaces of these controllers are multiplexed with GPIO pins. Other useful peripherals include a buzzer/melody control, 6 channels of 8-bit PWM, and one channel of timer/capture and quadrature decoder.

Analog peripherals include touch key controllers with up to 20-bit resolution employing dual-slope chargesharing capacitance conversion. The touch key controller also has shield output capability for moisture immunity. The touch key controller allows sleep mode (5uA) and auto-detection for wakeup. The maximum number of key scans is 19. IS31CS8974 can support passive proximity sensing.

CS8974 also provides a flexible means of flash programming that supports ISP and IAP. The protection of data loss is implemented in hardware by access restriction of critical storage segments. The code security is reinforced with sophisticated writer commands and ISP commands. The on-chip breakpoint processor also allows easy debugging which can be integrated with ISP. A reliable power-on-reset circuit and low supply voltage detection allow reliable operations under harsh environments.

APPLICATIONS

- Touch key applications with high robustness and reliability requirements
- Automotive and appliance

FEATURES

CPU and Memory

- Up to 25MHz 1-Cycle 8051 CPU core (16MHz zero wait state)
- 16-bit Timers T0/T1/T2/T3/T4 and 24-bit Timer T5
- Checksum and CRC accelerator
- WDT1 by SYSCLK, WDT2/WDT3 by SOSC32KHz
- Clock fault monitor
- Integrated breakpoint controller and debug port through I²C slave
- All GPIO pins can be assigned to two external interrupts
- Power saving modes IDLE, STOP, and SLEEP
- 256B IRAM and 1792B XRAM with ECC
- 32Kx16 Flash Memory and two 512x16 Information Block
 - Program read with hardware ECC
 - Software read/write direct access
 - Code security and data loss protection
 - 100K Endurance and 10 years Retention

Clock Sources

Internal oscillator at 16MHz of +/- 2% accuracy

- Spread Spectrum option
- Internal low-power slow oscillator 128KHz
- External clock option

Digital Peripherals

- 6 CH 8-bit center-aligned PWM controller with trigger interrupt and polarity control
- Timer/Capture and quadrature decoder
- Buzzer and melody waveform generator
- One I²C Master, two I²C Slave
 - I2CS1 allows address match wakeup and two address
 - I2CS2 for ISP and debug
- One SPI Master/Slave Controller
- One 8051 UART and One full-duplex LINcapable EUART2

Analog Peripherals

- Capacitance sense touch-key controller
 - Dual slope charge transfer for higher PSRR and CMRR with up to 20-bit resolutions
 - Up to 19 key inputs with low power wakeup (5uA) function
 - Shield output for moisture immunity Power-on reset and Low voltage detection (2.0V-4.5V)



Miscellaneous

- Up to 20 GPIO pins
 - Noise filters and Dual edge interrupt/wakeup
- 2.5V to 5.5V single supply

- Low power standby (1uA) in SLEEP mode
- Operating temperature -40°C to 85°C
- TSSOP-24 and QFN-24 package
- RoHS & Halogen-Free compliant package
- TSCA compliance

BLOCK DIAGRAM

REGULATOR	RESET	LOW SUPPLY	IOSC	WDT1 WDT2	SOSC	WAKE UP	TIMER[5]	
		DETECT	16MHz	WDT3	32/128KHz		TIMER[0-4]	
2KB ECC							CS/CRC	I/O MULTIPLE XER AND BUFFERS AND PIN INTERRUPT
IRAM/XF	RAM						PORT0	RRI
4KB							PORT1	Ë
ECC							PORT2	
Boot Code								I I O
				1-CYCLE			I2CS2	ANI
28KB	티구리			8051			I2CS1 ISP	RS S
ECC	ASH						12051 15P	
Code FLASH	FLASH CONTROL						I2CM0	BU
FLASH								DN N
							UART0	ER,
512B IFB								×
X 2							EUART2	
							LIN	40L
16-Bit PCA	8-Bit PCA						SPI M/S	Q
тсс	6-CH		19-KEY TO	UCH KEY C	ONTROLLER	R		
QEC	PWM						BUZZER	
							MELODY	
		I/O MULT	IPLEXER AND	BUFFERS	AND PIN INT	FERRUPT		
L								



<u>PINOUT</u>

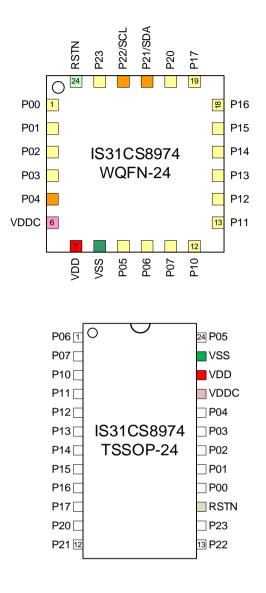




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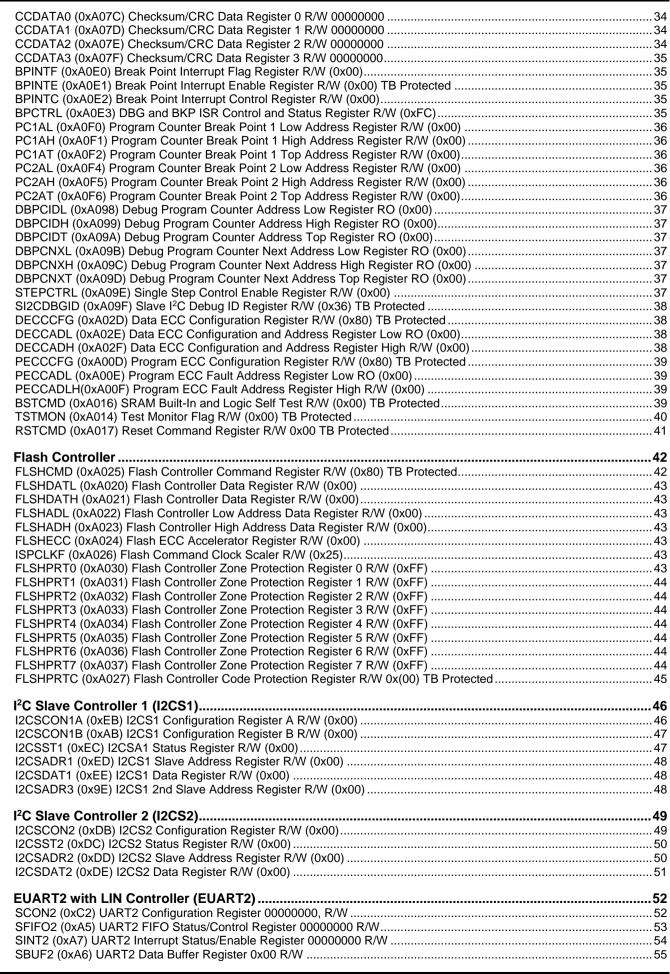
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	TK3BASEL (0xA028) TK3 Baseline Register L R/W (0x00)	
	TK3BASEH (0xA029) TK3 Baseline Register H R/W (0x00)	
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1. PIN Multifunction Table

DINI#		MECEO		MECEO	MECEO	MFCFG	MECEO	MECEO		
PIN# Q/S*	MFCFG 0	MFCFG 1	MFCFG 2	MFCFG 3	MFCFG 4	MFCFG 5	MFCFG 6	MFCFG 7	ANIO 1	ANIO 2
1/16	P00	PHA	XCAPT	SSN	BZ	TX0	PWM0	-	KEY	SHIELD
2/17	P01	PHB	CC	MOSI	Т0	RX0	PWM1	-	KEY	SHIELD
3/18	P02	INDEX	XCAPT	MISO	SSDA1	TX2	PWM2	-	KEY	SHIELD
4/19	P03	XCAPT	тс	SCLK	SSCL1	RX2	PWM3	-	KEY	SHIELD
5/20	P04	PHA	тс	СС	BZ	TKC2	PWM4	XCLKIN	CREF	CREF
6/21	VDDC	Core sup decouplin		at normal m	ode, 1.40\	/ at sleep n	node. Conr	nect 1uF ar	nd 0.1uF to	VSS for
7/22	VDD	Power su	pply 2.2V t	o 5.5V						
8/23	VSS	Ground s	upply 0V.							
9/24	P05	PHB	XCAPT	MISO	T0	TX2	PWM5	-	KEY	SHIELD
10/1	P06	INDEX	СС	MOSI	T1	RX2	PWM0	-	KEY	SHIELD
11/2	P07	XCAPT	тс	SCLK	T2	TX2	PWM1	-	KEY	SHIELD
12/3	P10	PHA	СС	SSN	Т0	RX2	PWM2	-	KEY	SHIELD
13/4	P11	PHB	тс	СС	T1	BZ	PWM3	XCLKIN	KEY	SHIELD
14/5	P12	INDEX	XCAPT	SSCL2	MSCL	SSCL1	PWM4	-	KEY	SHIELD
15/6	P13	XCAPT	CC	SSDA2	MSDA	SSDA1	PWM5	-	KEY	SHIELD
16/7	P14	PHA	тс	SSN	CC	TX2	PWM0	-	KEY	SHIELD
17/8	P15	PHB	XCAPT	SSN	T2	BZ	PWM1	-	KEY	SHIELD
18/9	P16	INDEX	тс	MISO	СС	RX2	PWM2	-	KEY	SHIELD
19/10	P17	XCAPT	тс	MOSI	СС	TX2	PWM3	-	KEY	SHIELD
20/11	P20	PHA	XCAPT	SCLK	BZ	RX2	PWM4	-	KEY	SHIELD
21/12	P21	PHB	СС	SSDA2	MSDA	SSDA1	PWM5	-	KEY	SHIELD
22/13	P22	INDEX	тс	SSCL2	MSCL	SSCL1	PWM0	-	KEY	SHIELD
23/14	P23	XCAPT	СС	SSN	RX2	TX2	PWM1	-	KEY	SHIELD
24/15	RSTN		E	xternal res	et input, lo	w active. Ir	nternal 6K 0	Dhm pull-up	Э.	

Table 1-1 PIN Multifunction Table

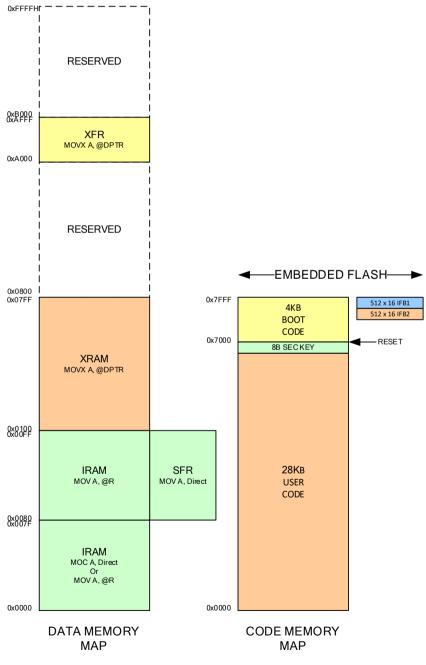
- 1. More than one function can be enabled. The outputs are OR-ed.
- 2. Input for GPIO port, interrupt/wakeup is always enabled. For other functions, the inputs are multiplexed to the specific function blocks.
- 3. Pin 21 (P21) as SDA and Pin 22 (P22) as SCL are used for In-System-Programming (ISP).
- Pin 19 (P17) as CEB, Pin 20 (P20) as SCK, Pin 21 (P21) as SDI, Pin 22 (P22) as SDO, along with Pin 24 (RSTN) are used in Writer Mode. Pin 23 (P23) for Flash TBIT ready output is optional for Writer Mode. RSTN is also necessary for Writer Mode.
- 5. Pin number is shown in QFN24/TSSOP24.
- 6. If customers would like to use our CS89XX Touch Key Library software tool, please refer to our IS3XCS89XX Touch Key Library Tool User's Manual before starting your hardware schematics design.



2. Memory Map

There is a total of 256 bytes of internal RAM in CS8974, the same as standard 8052. And there is a total of 1792 bytes of auxiliary RAM allocated in the 8051 extended RAM area at 0x0100h – 0x07FFh. Programs can use "MOVX" instructions to access the XRAM.

There is a 32Kx16 (64KB) embedded Flash memory for code storage. For CPU program access (Readonly), the lower byte is used for actual access, and the upper byte is used for ECC check. The ECC is performed in nibble bases with each nibble in the high byte corresponding to the nibbles in the low byte. ECC in this case is capable of one-bit correction and two-bit detection for each nibble. This is significantly more robust than 8:5 ECC. ECC check is through hardware and is performed automatically. The embedded Flash can also be accessed through the Flash controller. For erase operations, the page size of the Flash is 512x16. There are two 512x16 IFB blocks in Flash. The first IFB is used for manufacturing and calibration data, and some areas are for user OTP data. The 2nd IFB is open for user applications with no restriction. Also, there is an 8-byte code security key located at the last 8 bytes of user program space for protection from pirate access to information.



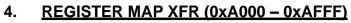


3. REGISTER MAP SFR (0x80 – 0xFF)

The SFR address map maintains maximum compatibilities to the most commonly existing 8051-like MCU. The following table shows the SFR address map. Since SFR can be accessed by direct addressing mode, registers of built-in peripherals that require fast access are mostly located in SFR. XFR is mainly used for on-chip peripheral control and configurations.

	0	1	2	3	4	5	6	7
0XF0	В	-	CLSR	CHSR	I2CMSA	I2CMCR	I2CMBUF	I2CMTP
0XE0	ACC	-	-	-	-	-	-	-
0XD0	PSW	-	-	-	-	-	-	-
0XC0	-	-	SCON2	I2CMTO	PMR	STATUS	MCON	ТА
0XB0	-	-	-	-	-	-	-	-
0XA0	P2	SPICR	SPIMR	SPIST	SPIDATA	SFIFO2	SBUF2	SINT2
0X90	P1	EXIF	WTST	DPX	-	DPX1	-	-
0X80	P0	SP	DPL	DPH	DPL1	DPH1	DPS	PCON
	8	9	Α	В	С	D	E	F
0XF8	EXIP	MD0	MD1	MD2	MD3	MD4	MD5	ARCON
0XE8	EXIE	СН	MXAX	I2CSCON1A	I2CSST1	I2CSADR1	I2CSDAT1	-
0XD8	WDCON	CL	DPXR	I2CSCON2	I2CSST2	I2CSADR2	I2CSDAT2	-
0XC8	T2CON	TB	RLDL	RLDH	TL2	TH2	-	T34CON
0XB8	IP	-	-	-	-	-	-	-
0XA8	IE	-	-	I2CSCON1B	TL4	TH4	TL3	TH3
0X98	SCON0	SBUF0	-	ESP	-	ACON	I2CSADR3	WKMASK
0X88	TCON	TMOD	TL0	TL1	TH0	TH1	CKCON	CKSEL

Table 3-1 SFR Register map



	0	1	2	3	4	5	6	7
A000	REGTRM	IOSCITRM	IOSCVTRM	-	-	-	-	SOSCTRM
A010	LVDCFG	LVDTHD	LVDHYS	-	TSTMON	-	BSTCMD	RSTCMD
A020	FLSHDATL	FLSHDATH	FLSHADL	FLSHADH	FLSHECC	FLSHCMD	ISPCLKF	FLSHPRTC
A030	FLSHPRT0	FLSHPRT1	FLSHPRT2	FLSHPRT3	FLSHPRT4	FLSHPRT5	FLSHPRT6	FLSHPRT7
A040	NTAFRQL	NTAFRQH	NTADUR	NTAPAU	NTBFRQL	NTBFRQH	NTBDUR	NTBPAU
A050	TCCFG1	TCCFG2	TCCFG3	-	TCPRDL	TCPRDH	TCCMPL	TCCMPH
A060	TCCPTRL	TCCPTRH	TCCPTFL	TCCPTFH	-	-	-	-
A070	QECFG1	QECFG2	QECFG3	-	QECNTL	QECNTH	QEMAXL	QEMAXH
	8	9	Α	В	С	D	E	F
A008	TK2CFGA	TK2CFGB	TK2CMD	TK2CNTL	TK2CNTH	PECCCFG	PECCADL	PECCADH
A018	TK3CFGA	TK3CFGB	TK3CFGC	TK3CFGD	TK3HDTYL	TK3HDTYH	TK3LDTYL	TK3LDTYH
A028	TK3BASEL	TK3BASEH	TK3THDL	TK3THDH	TK3PUD	DECCCFG	DECCADL	DECCADH
A038	-	-	-	-	-	-	-	-
A048	BZCFG	NTPOW	NOTETU	-	-	-	-	-
A058	-	-	-	-	-	-	-	-
A068	T5CON	TL5	TH5	TT5	-	-	-	-
A078	CCCFG	-	-	-	CCDATA0	CCDATA1	CCDATA2	CCDATA3

	0	1	2	3	4	5	6	7
A080	PWMCFG1	PWMCFG2	PWMCFG3	-	-	-	-	-
A090	LINCTRL	LINCNTRH	LINCNTRL	LINSBRH	LINSBRL	LININT	LININTEN	-
A0A0	-	SBAUD3H	SBAUD3L	SBAUD4H	SBAUD4L	-	-	-
A0B0	LINTCON	TXDTOL	TXDTOH	RXDTOL	RXDTOH	BSDCLRL	BSDCLRH	BSDWKC
A0C0	-	-	-	-	-	-	-	-
A0D0	-	-	-	-	-	-	-	-
A0E0	BPINTF	BPINTE	BPINTC	BPCTRL	-	-	-	-
A0F0	PC1AL	PC1AH	PC1AT	-	PC2AL	PC2AH	PC2AT	-
	8	9	Α	В	С	D	E	F
A088	8 PWM0DTY	9 PWM1DTY	A PWM2DTY	B PWM3DTY	C PWM4DTY	D PWM5DTY	-	F -
A088 A098							E - STEPCTRL	F - SI2CDBGID
	PWM0DTY	PWM1DTY	PWM2DTY	PWM3DTY	PWM4DTY	PWM5DTY	-	-
A098	PWM0DTY	PWM1DTY	PWM2DTY	PWM3DTY	PWM4DTY	PWM5DTY	-	-
A098 A0A8	PWM0DTY DBPCIDL -	PWM1DTY	PWM2DTY	PWM3DTY	PWM4DTY	PWM5DTY	-	-
A098 A0A8 A0B8	PWM0DTY DBPCIDL -	PWM1DTY	PWM2DTY	PWM3DTY	PWM4DTY	PWM5DTY	-	-
A098 A0A8 A0B8 A0C8	PWM0DTY DBPCIDL - BSDACT -	PWM1DTY DBPCIDH - - -	PWM2DTY DBPCIDT - - -	PWM3DTY DBPCNXL - - -	PWM4DTY DBPCNXH - - -	PWM5DTY DBPCNXT - - -	-	-

	0	1	2	3	4	5	6	7
A100	IOCFGO00	IOCFGO01	IOCFGO02	IOCFGO03	IOCFGO04	IOCFGO05	IOCFGO06	IOCFGO07
A110	IOCFGI00	IOCFGI01	IOCFGI02	IOCFGI03	IOCFGI04	IOCFGI05	IOCFGI06	IOCFGI07
A120	MFCFG00	MFCFG01	MFCFG02	MFCFG03	MFCFG04	MFCFG05	MFCFG06	MFCFG07
A130	IOCFGO20	IOCFGO21	IOCFGO22	IOCFGO23	IOCFGO24	IOCFGO25	IOCFGO26	IOCFGO27
A140	IOCFGI20	IOCFGI21	IOCFGI22	IOCFGI23	IOCFGI24	IOCFGI25	IOCFGI26	IOCFGI27
A150	MFCFG20	MFCFG21	MFCFG22	MFCFG23	MFCFG24	MFCFG25	MFCFG26	MFCFG27
A160	-	-	-	-	-	-	-	-
A170	-	-	-	-	-	-	-	-
	8	9	Α	В	С	D	ш	F
A108	IOCFGO10	IOCFGO11	IOCFGO12	IOCFGO13	IOCFGO14	IOCFGO15	IOCFGO16	IOCFGO17
A118	IOCFGI10	IOCFGI11	IOCFGI12	IOCFGI13	IOCFGI14	IOCFGI15	IOCFGI16	IOCFGI17
A128	MFCFG10	MFCFG11	MFCFG12	MFCFG13	MFCFG14	MFCFG15	MFCFG16	MFCFG17
A138	IOCFGO30	IOCFGO31	IOCFGO32	IOCFGO33	IOCFGO34	IOCFGO35	IOCFGO36	IOCFGO37
A148	IOCFGI30	IOCFGI31	IOCFGI32	IOCFGI33	IOCFGI34	IOCFGI35	IOCFGI36	IOCFGI37
A158	MFCFG30	MFCFG31	MFCFG32	MFCFG33	MFCFG34	MFCFG35	MFCFG36	MFCFG37
A168	-	-	-	-	-	-	-	-
A178	-	-	-	-	-	-	-	-

	0	1	2	3	4	5	6	7
A180	IOCFGO40	IOCFGO41	IOCFGO42	IOCFGO43	IOCFGO44	IOCFGO45	IOCFGO46	IOCFGO47
A190	IOCFGI40	IOCFGI41	IOCFGI42	IOCFGI43	IOCFGI44	IOCFGI45	IOCFGI46	IOCFGI47
A1A0	MFCFG40	MFCFG41	MFCFG42	MFCFG43	MFCFG44	MFCFG45	MFCFG46	MFCFG47
A1B0	IOCFGO60	IOCFGO61	IOCFGO62	IOCFGO63	IOCFGO64	IOCFGO65	IOCFGO66	IOCFGO67
A1C0	IOCFGI60	IOCFGI61	IOCFGI62	IOCFGI63	IOCFGI64	IOCFGI65	IOCFGI66	IOCFGI67
A1D0	MFCFG60	MFCFG61	MFCFG62	MFCFG63	MFCFG64	MFCFG65	MFCFG66	MFCFG67
A1E0	-	-	-	-	-	-	-	-
A1F0	-	-	-	-	-	-	-	-
	8	9	Α	В	С	D	E	F
A188				10050050				
/100	IOCFGO50	IOCFGO51	IOCFGO52	IOCFGO53	IOCFGO54	IOCFGO55	IOCFGO56	IOCFGO57
A198	IOCFGO50 IOCFGI50	IOCFG051 IOCFGI51	IOCFG052 IOCFGI52	IOCFG053	IOCFG054 IOCFGI54	IOCFG055 IOCFGI55	IOCFGO56 IOCFGI56	IOCFG057 IOCFGI57
A198	IOCFGI50	IOCFGI51	IOCFGI52	IOCFGI53	IOCFGI54	IOCFGI55	IOCFGI56	IOCFGI57
A198 A1A8	IOCFGI50 MFCFG50	IOCFGI51 MFCFG51	IOCFGI52 MFCFG52	IOCFGI53 MFCFG53	IOCFGI54 MFCFG54	IOCFGI55 MFCFG55	IOCFGI56 MFCFG56	IOCFGI57 MFCFG57
A198 A1A8 A1B8	IOCFGI50 MFCFG50 IOCFGO70	IOCFGI51 MFCFG51 IOCFGO71	IOCFGI52 MFCFG52 IOCFGO72	IOCFGI53 MFCFG53 IOCFGO73	IOCFGI54 MFCFG54 IOCFGO74	IOCFGI55 MFCFG55 IOCFGO75	IOCFGI56 MFCFG56 IOCFGO76	IOCFGI57 MFCFG57 IOCFGO77
A198 A1A8 A1B8 A1C8	IOCFGI50 MFCFG50 IOCFGO70 IOCFGI70	IOCFGI51 MFCFG51 IOCFG071 IOCFGI71	IOCFGI52 MFCFG52 IOCFG072 IOCFGI72	IOCFGI53 MFCFG53 IOCFGO73 IOCFGI73	IOCFGI54 MFCFG54 IOCFG074 IOCFGI74	IOCFGI55 MFCFG55 IOCFG075 IOCFGI75	IOCFGI56 MFCFG56 IOCFGO76 IOCFGI76	IOCFGI57 MFCFG57 IOCFG077 IOCFGI77

Table 4-1 TA Protected Register map XFR



5. 8051 CPU

5.1 **CPU Register**

ACC (0xE0) Accumulator R/W (0x00)

	7	6	5	4	3	2	1	0
RD				ACC	[7-0]			
WR				ACC	[7-0]			

ACC is the CPU accumulator register and engages in the direct operations of many instructions. ACC is bit addressable.

B (0xF0) B Register R/W (0x00)

	7	6	5	4	3 2 1		1	0
RD				B[7	'- 0]			
WR				B[7	'- 0]			

B register is used in standard 8051 multiply and divide instructions and is also used as an auxiliary register for temporary storage. B is also bit addressable.

PSW (0xD0) Program Status Word R/W (0x00)

	7	6	5	4	3	2	1	0
RD	CY	AC	F0	RS1	RS0	OV	UD	Р
WR	CY	AC	F0	RS1	RS0	OV	UD	Р
C	Y	Carry Flag						
A	С	Auxil	iary Carry Fla	ag (BCD Oper	ations)			
F	0	Gene	eral Purpose	Flag 0				
R	S1, RS0							
0	V	Over	flow Flag					

UD User Defined (reserved) Parity Flag

Р

SP (0x81) Stack Pointer R/W (0x00)

	7	6	5		3	2	1	0
RD				SP[7-0]			
WR				SP[7-0]			

PUSH will result ACC to be written to SP+1 address. POP will load ACC from IRAM with the address of SP.

ESP (0x9B) Extended Stack Pointer R/W (0x00)

	7	6	5			1	0	
RD				ESP	[7-0]			
WR				ESP	[7-0]			

In FLAT address mode, ESP and SP together form a 16-bit address for stack pointer. ESP holds the higher byte of the 16-bit address.

STATUS (0xC5) Program Status Word RO(0x00)

	7	6	5	4	3	2	1	0
RD	-	HIP	LIP	-	SPTA1	SPRA1	SPTA0	SPRA0
WR	-	-	-	-	-	-	-	-
H	IP	HIP=	0 indicates n	Interrupt Stat o HP interrup	t			
LI	Ρ	Low	Priority (LP) I	IP interrupt pr nterrupt Statu o LP interrupt	is			



SPTA1	LIP=1 indicates LP interrupt progressing UART1 Transmit Activity Status SPTA1=0 indicates no UART1 transmit activity
SPRA1	SPTA1=1 indicates UART1 transmit active UART1 Receive Activity Status
	SPRA1=0 indicates no UART1 receive activity SPRA1=1 indicates UART1 receive active
SPTA0	UART0 Transmit Activity Status SPTA0=0 indicates no UART0 transmit activity
	SPTA0=1 indicates UART0 transmit active
SPRA0	UART0 Receive Activity Status SPRA0=0 indicates no UART0 receive activity
	SPRA0=1 indicates UART0 receive active

The program should check status conditions before entering SLEEP, STOP, or IDLE modes to prevent loss of intended functions from delayed entry until these events are finished.

5.2 Addressing Timing and Memory Modes

The clock speed of an MCU with embedded flash memory is usually limited by the access time of on-chip flash memory. While in modern process technology, the CPU can operate much faster and the access time of flash memory is usually around 40 nanoseconds, which becomes a bottleneck for CPU performance. To mitigate this problem, a programmable wait state function is incorporated to allow a faster CPU clock rate to access slower embedded flash memory. The wait state is controlled by the WTST register as shown in the following,

	7	6	5		4		3	5	2	2	1	0	
RD	-	-	-		-		WTS	ST3	WT	ST2	WTST1	WTST	ГО
WR	-	-	-		-		WTS	ST3	WT	WTST2 WTST1 \		WTST	ГО
V	/TST[3-0]	Wai	Wait State Control register. WTST sets the wait state						te in CF	PU clock perio	od.		
		v	VTST3	WT	ST2	WT	ST1	WT	ST0	V	Vait State Cy	cle	
			0		0		0	()		0		
			0		0		0		1		1		
			0		0		1	()		2		
			0	(0		1		1		3		
			0		1		0	()		4		
			0		1		0		1		5		
			0		1		1	()		6		
			0		1		1		1		7		
			1	(0		0	()		8		
			1	(0		0	-	1		9		
			1		0		1	()		10		
			1	(0		1	-	1		11		
			1		1		0	()		12		
			1		1		0		1		13		
			1		1		1	()		14		
			1		1		1		1		15		

WTST (0x92) R/W (0x07)

The default setting of the wait state control register after reset is 0x07 and the software must initialize the setting to change the wait state setting. Using a SYSCLK of 4MHz, the WTST can be set to minimum because one clock period is 250ns, which is longer than the typical embedded flash access time. If SYSCLK is above 16MHz, then WTST should be set higher than 1 to allow enough read access time.





MCON (0xC6) XRAM Relocation Register R/W (0x00) TA Protected

	7	6	5	4 3 2 1		1	0			
RD		MCON[7-0]								
WR				MCO	N[7-0]					

MCON holds the starting address of XRAM in 2KB steps. For example, if MCON[7-0]=0x01, the starting address is 0x001000h. MCON is not meaningful in this chip because it only contains on-chip XRAM and MCON should not be modified from 0x00.

The LARGE mode, addressing mode is compatible with standard 8051 in 16-bit address. FLAT mode extends the program address to 20-bit and expands the stack space to 16-bit data space. The data space is always 16-bit in either LARGE or FLAT mode.

ACON (0x9D) R/W (0x00) TA Protected

	7	6	5	4	3	2	1	0
RD	-	-	IVECSEL	-	DPXREN	SA	AM1	AM0
WR	-	-	IVECSEL	-	DPXREN	SA	AM1	AM0

ACON is addressing mode control register.

à
3

5.3 MOVX A, @Ri Instructions

DPXR (0xDA) R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		DPXR[7-0]								
WR		DPXR[7-0]								

DPXR is used to replace P2 [7-0] for the high byte of XRAM address bit [15-7] for "MOVX, @Ri" instructions only if DPXREN=1.

MXAX (0xEA) MOVX Extended Address Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		MXAX[7-0]								
WR		MXAX[7-0]								

MXAX is used to provide the top 8-bit address for "MOVX @Ri" instructions only. MXAX does not affect other MOVX instructions.

When accessing XRAM using "MOVX, @DPTR" instruction, the address of XRAM access is formed by DPHi: DPLi depending on which data pointer is selected. Another form of MOVX instruction is "MOVX, @Ri". This instruction provides an efficient programming method to move content within a 256-byte data block. In the "@RI" instruction, the XRAM address [15-7] can be derived from two sources. If ACON.DPXREN = 0, the high order address [15-8] is from P2 (0xA0), if ACON.DPXREN = 1, the high order address is from DPXR (0xDA) register.

The maximum addressing space of XRAM is up to 16MB and requires a 24-bit address. For "MOVX, @DPTR", the

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XRAMADDR [23-16] is from either DPX (0x93) or DPX1 (0x95) depending on which data pointer is selected. For "MOVX, @Ri", the XRAMUADDR [23-16] is from MXAX (0xEA) register.

5.4 Dual Data Pointers and MOVX operations

In standard 8051, there is only one data pointer DPH: DPL to perform MOVX. The enhanced CPU provides 2nd data pointer DPH1:DPL1 to speed up the movement or copy of data block. The active DPTR is selected by setting DPS (Data Pointer Select) register. Through the control DPS, efficient programming can be achieved.

DPS (0x86) Data Pointer Select R/W (0x00)

	7	6	5	4	3	2	1	0
RD	ID1	ID0	TSL	-	-	-	-	SEL
WR	ID1	ID0	TSL	-	-	-	-	SEL

ID[1:0]

Define the operation of Increment Instruction of DPTR, "INC DPTR". Standard 8051 only has increment DPTR instruction. ID [1-0] changes the definitions of "INC DPTR" instruction and allows flexible modifications of DPTR when "INC DPTR" instructions are executed.

ID1	ID0	SEL=0	SEL=1					
0	0	INC DPTR	INC DPTR1					
0	1	DEC DPTR	INC DPTR1					
1	0	INC DPTR	DEC DPTR1					
1	1	DEC DPTR	DEC DPTR1					

TSL

SEL

Enable toggling selection of DPTR selection. When this bit is set, the selection of DPTR is toggled when DPTR is used in instruction and executed.

DPTR selection bit. Set to select DPTR1, and clear to select DPTR. SEL is also affected by the state of ID [1:0] and TSL after DPTR is used in an instruction. When read, SEL reflects the current selection of command.

DPL (0x82) Data Pointer Low R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		DPL[7-0]								
WR		DPL[7-0]								

DPL register holds the low byte of data pointer, DPTR.

DPH (0x83) Data Pointer High R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		DPH[7-0]								
WR		DPH[7-0]								

DPH register holds the high byte of data pointer, DPTR.

DPL1 (0x84) Extended Data Pointer Low R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		DPL1[7-0]							
WR		DPL1[7-0]							

DPL1 register holds the low byte of extended data pointer 1, DPTR1.

DPH1 (0x85) Extended Data Pointer High R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		DPH1[7-0]								
WR		DPH1[7-0]								

DPH1 register holds the high byte of extended data pointer 1, DPTR1.



DPX (0x93) Data Pointer Top R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	DPX[7-0]								
WR	DPX[7-0]								

DPX is used to provide the top 8-bit address of DPTR when the address is above 64KB. The lower 16-bit address is formed by DPH and DPL. DPX is not affected in LARGE mode and will form a full 24-bit address in FLAT mode, meaning auto increment and decrement when DPTR is changed. DPX value has no effect if on-chip data memory is less than 64KB.

DPX1 (0x95) Extended Data Pointer Top R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	DPX1[7-0]								
WR		DPX1[7-0]							

DPX1 is used to provide the top 8-bit address of DPTR when the address is above 64KB. The lower 16-bit address is formed by DPH1 and DP1L. DPX1 is not affected in LARGE mode and will form a full 24-bit address in Flat mode, meaning auto increment and decrement when DPTR is changed. DPX1 value has no effect if on-chip data memory is less than 64KB.

5.5 Interrupt System

The CPU implements an enhanced Interrupt Control that allows a total of 15 interrupt sources and each with two programmable priority levels. The interrupts are sampled at the rising edge of SYSCLK. If interrupts are present and enabled, the CPU enters the interrupt service routine by vectoring to the highest priority interrupt. Among the 15 interrupt sources, 7 of them are from CPU internal integrated peripherals, 6 of them are from on-chip external peripherals, and 2 of them are used for external pin interrupt expansion. When an interrupt is shared, the interrupt service routine must determine which source is requesting the interrupt by examining the corresponding interrupt flag of sharing peripherals.

The following table shows the interrupt sources and corresponding interrupt vectors. The Flag Reset column shows whether the corresponding interrupt flag is cleared by hardware (self-cleared) or software. Software can only clear the interrupt flag but not set the interrupt flag. The Natural Priority column shows the inherent priority if more than one interrupt is assigned to the same priority level. The interrupts assigned with higher priority levels always get serviced first compared with interrupts assigned with lower priority levels regardless of the natural priority sequence.

Interrupt	Peripheral Source Description	Vectors (*Note) IVECSEL=0/1	Flag Reset	Natural Priority
PINT0	Expanded Pin INT0.x	0x0003/0xX003	Software	1
TF0	Timer 0	0x000B/0xX00B	Hardware	2
PINT1	Expanded Pin INT1.x	0x0013/0xX013	Software	3
TF1	Timer 1	0x001B/0xX01B	Hardware	4
TI0/RI0	UART0	0x0023/0xX023	Software	5
TF2	Timer 2	0x002B/0xX02B	Software	6
TI2/RI2	EUART2/LIN/LIN_FAULT	0x0033/0xX033	Software	7
I2CM	I ² C Master	0x003B/0xX03B	Software	8
INT2	LVT	0x0043/0xX043	Software	9
INT3	ТКС2/ТКС3	0x004B/0xX04B	Software	10
INT4	Reserved	0x0053/0xX053	Software	11
WDIF	Watchdog WDT1	0x005B/0xX05B	Software	12
INT6	PWM/TCC/QE	0x0063/0xX063	Software	13
INT7	SPI/I ² C Slave	0x006B/0xX06B	Software	14
INT8	T3/T4/T5/Buzzer	0x0073/0xX073	Software	15



Interrupt	Peripheral Source Description	Peripheral Source Description Vectors (*Note) IVECSEL=0/1		Natural Priority
ECC	ECC/WDT2	0x007B/0xX07B	Software	0
BKP	Break Point	0xX080	Software	0
DBG	I2CS Debug	0xX0C0	Software	0

Table 5-1 Interrupt sources and interrupt vectors

Note: When IVECSEL=1, the interrupt vector is relocated to the top available 4KB memory space for boot code usage. Therefore, X value is based on the MCU embedded flash size like X=F for 64K, X=B for 48K, X=7 for 32K, and X=3 for 16K flash size. In addition to the 15 peripheral interrupts, there are two highest priority interrupts associated with debugging and breakpoint. DBG interrupt is generated when I²C slave is configured as a debug port and a debug request from the host matches the debug ID. BKP interrupt is generated when breakpoint match condition occurs. DBG has a higher priority than BKP. The BKP and DBG interrupts are not affected by the global interrupt enable, EA bit, IE register (0xA8).

The interrupt-related registers are listed in the following. Each interrupt can be individually enabled or disabled by setting or clearing the corresponding bit in IE, EXIE, and integrated peripherals' control registers.

IE (0xA8) Interrupt Enable Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	EA	ES2	ET2	ES0	ET1	PINT1EN	ET0	PINT0EN
WR	EA	ES2	ET2	ES0	ET1	PINT1EN	ET0	PINT0EN

EA	Global Interrupt Enable bit.
ES2	LIN-capable16550-likeUART2 Interrupt Enable bit.
ET2	Timer 2 Interrupt Enable bit.
ES0	UART0 Interrupt Enable bit.
ET1	Timer 1 Interrupt Enable bit.
PINT1EN	Pin PINT1.x Interrupt Enable bit.
ET0	Timer 0 Interrupt Enable bit.
PINT0EN	Pin PINT0.x Interrupt Enable bit.

EXIE (0xE8) Extended Interrupt Enable Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	EINT8	EINT7	EINT6	EWD1	EINT4	EINT3	EINT2	EI2CM
WR	EINT8	EINT7	EINT6	EWD1	EINT4	EINT3	EINT2	EI2CM
EI EI EI	NT8 NT7 NT6 WD1 NT4 NT3	SPI a PWM Enat Wato Rese Touc	and I ² C Slave <i>I</i> , Timer with ble bit. chdog Timer I erved	Interrupt Ena Compare/Cap nterrupt Enab	oture (TCC), C le bit.	Quadrature Er	ncoder (QE) Ir III (TKC3) Inte	·
	NT2 2CM	bit. Low Voltage Detection (LVT) Interrupt Enable bit. I ² C Master Interrupt Enable bit.						

Each interrupt can be individually assigned to either high or low. When the corresponding bit is set to 1, it indicates it is of high priority.

IP (0xB8) Interrupt Priority Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	-	PS2	PT2	PS0	PT1	PX1	PT0	PX0		
WR	-	PS2	PT2	PS0	PT1	PX1	PT0	PX0		
P	S2	2 LIN-capable 16550-like UART2 Priority bit.								
P	Т2	Time	Timer 2 Priority bit.							



PS0	UART 0 Priority bit.
PT1	Timer 1 Priority bit.
PX1	Pin Interrupt INT1 Priority bit.
PT0	Timer 0 Priority bit.
PX0	Pin Interrupt INT0 Priority bit.

EXIP (0xF8) Extended Interrupt Priority Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD	PINT8	PINT7	PINT6	PWDI	PINT4	PINT3	PINT2	PI2CM			
WR	PINT8	PINT7	PINT6	PWDI	PINT4	PINT3	PINT2	PI2CM			
PI	NT8 NT7 NT6	INT8 Timer 3, Timer 4, Timer 5 and Buzzer Priority bit. INT7 SPI and I ² C Slave Priority bit. INT6 PWM, Timer with Compare/Capture (TCC) and Quadratu Priority bit.						er (QE)			
-	WDI INT4		hdog Priority erved for INT4								
PI PI	NT3 NT2 2CM	INT3 INT2	Reserved for INT4 Priority bit. INT3 Touch Key Controller II (TKC2) and Touch Key Controller III (TKC3) Priority bit. INT2 Low Voltage Detection (LVT) Priority bit. I ² C Master Priority bit.								

EXIF (0x91) Extended Interrupt Flag R/W (0x00)

	7	6	5	4	3	2	1	0			
RD	INT8F	INT7F	INT6F	-	INT4F	INT3F	INT2F	I2CMIF			
WR	-	-	-	-	-	-	-	I2CMIF			
IN	NT8F	INT8	Timer 3, Tim	ner 4, Timer 5	, and Buzzer	Interrupt Flag	bit				
INT7F		INT7	INT7 SPI and I ² C Slave interrupt Flag bit								
INT6F			INT6 PWM, Timer with Compare/Capture (TCC) and Quadrature Encoder (QE) Interrupt Flag bit								
IN	NT4F	Rese	Reserved for INT4 Interrupt Flag bit								
IN	NT3F		INT3 Touch Key Controller II (TKC2) and Touch Key Controller III (TKC3) Interrupt Flag bit								
IN	INT2F		INT2 Low Voltage Detection (LVT) Interrupt Flag bit								
12	2CMIF	I ² C N	I ² C Master Interrupt Flag bit. This bit must be cleared by software								
Ν	ote: Writing to	INT2F to INT	8F has no ef	fect.							

The interrupt flag of internal peripherals is stored in the corresponding flag registers in the peripheral and EXIF registers. These peripherals include T0, T1, T2, and WDT. Software needs to clear the corresponding flags located in the peripherals (for T0, T1, T2, and WDT). For I2CM, the interrupt flag is located in the EXIF register bit I2CMIF. This needs to be cleared by software.

INT2 to INT8 is used to connect to the external peripherals. INT2F to INT8F is the direct equivalent of the interrupt flag from the corresponding peripherals. These peripherals include Timer 3, Timer 4, Timer 5, Buzzer, SPI, I2CS, PWM, TCC, QE, TKC2, TKC3, etc.

WKMASK (0x9F) R/W (0xFF) Wake Up Mask Register TB Protected

	7	6	5	4	3	2	1	0			
RD	WEINT8	WEINT7	WEINT6	WEINT4	WEINT3	WEINT2	WEPINT1	WEPINT0			
WR	WEINT8	WEINT7	WEINT6	WEINT4	WEINT3	WEINT2	WEPINT1	WEPINT0			
W	'EINT8	Set t	Set this bit to allow INT8 to trigger the wake-up of CPU from STOP modes.								
W	'EINT7	Set t	Set this bit to allow INT7 to trigger the wake-up of CPU from STOP modes.								
W	'EINT6	Set this bit to allow INT6 to trigger the wake-up of CPU from STOP modes.									
W	'EINT4	Set t	Set this bit to allow INT4 to trigger the wake-up of CPU from STOP modes.								
W	EINT3	Set t	his bit to allow	v INT3 to trigg	ger the wake-	up of CPU fro	m STOP mod	les.			
WEINT2		Set t	his bit to allow	v INT2 to trigg	ger the wake-	up of CPU fro	m STOP mod	les.			
WEPINT1		Set t	Set this bit to allow INT1 to trigger the wake-up of CPU from STOP modes.								
W	EPINT0	Set t	his bit to allow	v INT0 to trigg	ger the wake-	up of CPU fro	m STOP mod	les.			

WKMASK register defines the wake-up control of the interrupt signals from the STOP/SLEEP mode. The wake-up



is performed by these interrupts and SYSCLK resumes if the internal oscillator is turned on. The interrupt can be set as a level trigger or an edge trigger and the wake-up always runs in accordance with the edge. The wake-up control is wired separately from the interrupt logic, therefore, after waking up, the CPU does not necessarily enter the interrupt service routine if the corresponding interrupt is not enabled. In this case, the CPU continues onto the next instruction, which initiates the STOP/SLEEP mode. Extra attention should be exerted for the modes of exit and re-entry to ensure proper operation.

All clocks are stopped in STOP/SLEEP mode, therefore, peripherals which require clock such as Timer 3, Timer 4, Buzzer, SPI, PWM, UART0, and LVD cannot perform the wake-up function. Only external pins and peripherals that do not require a clock (or can use SOSC32KHz clock) can be used for wake-up purposes. Such peripherals are like I2CS1, LIN, WDT2, Timer 5, and TK3.

PINT0 and PINT1 are used for external GPIO pin Interrupts. All GPIO pins can be enabled to generate PINT0 or PINT1 depending on its MFCFG register setting. Each GPIO pin also contains the rising/falling edge detections and either or both edges can be used for interrupt triggering. The same signaling can be used for generating wake-up.

	7	6	5	4	3	2	1	0			
RD	TF1	TR1	TF0	TR0	PINT1F	-	PINT0F	-			
WR	-	TR1	-	TR0	PINT1F	-	PINT0F	-			
Т	F1	Timer 1 Interrupt Flag bit. TF1 is cleared by hardware when entering the interrupt routine.									
Т	R1	Timer 1 Run Control bit. Set to enable Timer 1.									
Т	F0	Time routi	•	Flag. TF0 is c	leared by har	dware when e	entering the in	terrupt			
Т	R0	Time	er 0 Run Cont	rol bit. Set to	enable Timer	0.					
PINT1F Pin INT1 Interrupt Flag bit. PINT1F is cleared by hardware interrupt routine.						when enterir	ng the				
PINTOF Pin INTO Interrupt Flag bit. PINTOF is cleared by hardware v interrupt routine.						when enterir	ng the				

TCON (0x88) R/W (0x00)

5.6 Register Access Control

One important aspect of the embedded MCU is its reliable operations in a harsh environment. Many system failures result from the accidental loss of data or changes of critical registers that may lead to catastrophic effects. The CPU provides several protection mechanisms, which are described in this section.

	7	6	5	4	3	2	1	0		
RD	-	-	-	-	-	-	-	TASTAT		
WR	TA Register									

TA (0xC7) Time Access A Control Register2 WO xxxxxx0

TA access control emulates a ticket that must be purchased before modifying a critical register. To modify or write into a TA protected register, TA must be accessed in a predefined sequence to obtain the ticket. The ticket is used when an intended modification operation is done to the TA protected register. To obtain the next access a new ticket must be obtained again by performing the same predefined sequence on TA. TA does not limit the read access of the TA protect registers. The TA protected register includes RWT bit of WDCON (0xD8), MCON (0xC6), and ACON (0x9D) registers. The following predefined sequence is required to modify the content of MCON.

MOV TA, #0xAA;

MOV TA, #0x55;

MOV MCON, #0x01;

Once access is granted, there is no time limitation of access. The access is voided if any operation is performed in TA address. When read, TASTAT indicates whether TA is locked or not (1 indicates "unlock" and 0 indicates "lock").



TB (0xC9) Time Access B Control Register2 RW (0x00)

	7	6	5	4	3	2	1	0		
RD	-	-	-	-	-	-	-	TBSTAT		
WR	TB Register									

TB access control functions are like TA control, except the ticket is for multiple uses with a time limit. Once access is granted, the access is open for 256 clock periods and then expires. The software can also read TB addresses to obtain the current TB status. The TB protected registers include two SFR registers, CKSEL (0x8F) and WKMASK (0x9F), and several XFR registers, such as FLSHCMD (0xA025), ISPCLKF (0xA026), FLSHPRTC (0xA027), FLSHPRT0 (0xA030), BPINTE (0xA0E1), and SI2C_DebugID (0xA09F) etc. To modify registers with TB protection, the following procedure must be performed.

MOV TB, #0xAA

MOV TB, #0x55

This action creates a timed window of 256 SYSCLK periods to allow write access of these TB protected registers. If any of the above-mentioned sequences are repeated before the 128 cycles expire, a new 128 cycles is extended. The current 256 cycles can be terminated immediately by writing #0x00 to TB registers, such as

MOV TB, #0x00

It is recommended to terminate the TB access window once the user program finishes the modifications of TB protected registers.

Because TA and TB are critical reassurance of the reliable operation of the MCU that prevents accidental hazardous uncontrollable modifications of critical registers, the operation of these two registers should bear extreme cautions. It is strongly advised that these two registers should be turned on only when needed. Both registers use synchronous CPU clock, therefore, it is imperative that any running tasks of TA and TB should be terminated before entering IDLE mode or STOP mode. Both modes turn off the CPU clock and if TA and TB are enabled, they stay enabled until the CPU clock resumes, and thus may create vulnerabilities for critical registers.

Another reliability concern of embedded Flash MCU is that the important content in the Flash can be accidentally erased. This concern is addressed by the content protection in the Flash controller.

5.7 Clock Control and Power Management Modes

This section describes the clock control and power-saving modes of the CPU and its integrated peripherals. The settings are controlled by PCON (0x87) and PMR (0xC4) registers. The register description is defined as follows.

	7	6	5	4	3	2	1	0
RD	SMOD0	-	-	-	-	-	-	-
WR	SMOD0	-	-	-	-	SLEEP	STOP	IDLE
SI	MOD0				is is used to s ow. This defir			node 1, 2 or 3 ard 8051.
SI	LEEP	CPU exits Slee cons mode	and all perip when non-clo p bit and Stop umption, the e. SLEEP mo	herals is disal ocked interrup bit in PCON following rela de is the sam	this bit and th bled and ente ots or resets o is automatica tionship applie e as STOP m very low pow	rs SLEEP mo occur. Upon ex Illy cleared. In es: IDLE mod ode, except i	de. The SLEE kiting SLEEP terms of pow e > STOP mo t also turns of	EP mode mode, the ver vde > SLEEP f the band

waking up from SLEEP mode, it takes a longer time (< 64 IOSC clock cycles) compared with STOP mode because the regulator requires more time to stabilize.

Stop Mode Control Bit. The clock of the CPU and all peripherals is disabled and enters STOP mode if the Sleep bit is in the reset state. The STOP mode can only be terminated by non-clocked interrupts or resets. Upon exiting STOP mode, the Stop

Idle Bit. If the IDLE bit is set, the system goes into IDLE mode. In Idle mode, CPU

clock becomes inactive and the CPU and its integrated peripherals such as WDT, T0/T1/T2, and UART0 are paused. But the clocks of external peripherals and CPU like PCA, LIN-capable16550-like UART2, SPI, T3, I²C slave, and the others are still

PCON (0x87) R/W (0x00)

STOP

IDLE

bit in PCON is automatically cleared.

_ ..



active. This allows the interrupts generated by these peripherals and external interrupts to wake up the CPU. The exit mechanism of IDLE mode is the same as STOP mode. The Idle bit is automatically cleared after the exit of the IDLE mode.

PMR (0)	«C4) R/W (01	0xxxxx)						
	7	6	5	4	3	2	1	0
RD	CD1=0	CD0	SWB	-	-	-	-	-
WR	-	CD0	SWB	-	-	-	-	-
	D1, CD0	and ente divid LIN- thus spee	CD1=0, full sp rs PMM mode ed by 257. No capable 1655 may not func ed in PMM mode		n is in effect. and its integra M mode, all ir , WDT, and T All external p	When CD0=1 ated periphera ntegrated peri 0/T1/T2 run a eripherals to 0	, and CD1=1, als operate at pherals such it this reduced CPU still oper	the CPU a clock rate as UART0, rate, and
		internally hard		•				
S	WB			trol bit. Settin cmatically swi				in integrated
N	OTE: PMM m	ode is not su	oported.					
CKSEL	(0x8F) R/W (0x0C) Syster	n Clock Sele	ction Registe	er TB Protect	ed		

	<u>, ,</u>								
	7	6	5	4	3	2	1	0	
RD		IOSCDIV[3-0]				-	CLKSEL[1]	CLKSEL[0]	
WR		IOSCDIV[3-0]				REGRDY[0]	CLKSEL[1]	CLKSEL[0]	

IOSCDIV[3-0]

IOSC Pre-Divider. The default is IOSC.

IOSCDIV[3-0]	SYSCLK
0	IOSC
1	IOSC/2
2	IOSC/4
3	IOSC/6
4	IOSC/8
5	IOSC/10
6	IOSC/12
7	IOSC/14
8	IOSC/16
9	IOSC/32
10	IOSC/64
11	IOSC/128
12	IOSC/256
13	IOSC/256
14	IOSC/256
15	IOSC/256

REGRDY[1-0]

Wake-up delay time for main regulator stable time from reset or from sleep mode wakeup. Default is the longest delay at 256 SOSC32KHz.

REGRDY[1]	REGRDY[0]	Delay time
0	0	4 SOSC32KHz cycle
0	1	16 SOSC32KHz cycle
1	0	64 SOSC32KHz cycle



REGRDY[1]	REGRDY[0]	Delay time
1	1	256 SOSC32KHz cycle

CLKSEL[1-0]

These two bits define the clock source of the system clock SYSCLK. The selections are shown in the following table. The default setting after reset is IOSC.

CLKSEL[1]	CLKSEL[0]	SYSCLK			
0	0	IOSC (through divider)			
0	1	SOSC32KHz (32KHz)			
1	0	IOSC (through divider)			
1	1	XCLKIN			

WKMASK (0x9F) R/W (0xFF) Wake-Up Mask Register TB Protected

Clock Source Selection

	7	6	5	4	3	2	1	0
RD	WEINT8	WEINT7	WEINT6	WEINT4	WEINT3	WEINT2	WEPINT1	WEPINT0
WR	WEINT8	WEINT7	WEINT6	WEINT4	WEINT3	WEINT2	WEPINT1	WEPINT0
10/		Sott	hic hit to allow	VINTS to triac	nor the weke			00

Set this bit to allow INT8 to trigger the wake-up of CPU from STOP modes. WEINT8 WEINT7 Set this bit to allow INT7 to trigger the wake-up of CPU from STOP modes. WEINT6 Set this bit to allow INT6 to trigger the wake-up of CPU from STOP modes. Set this bit to allow INT4 to trigger the wake-up of CPU from STOP modes. WEINT4 WEINT3 Set this bit to allow INT3 to trigger the wake-up of CPU from STOP modes. Set this bit to allow INT2 to trigger the wake-up of CPU from STOP modes. WEINT2 WEPINT1 Set this bit to allow INT1 to trigger the wake-up of CPU from STOP modes. **WEPINTO** Set this bit to allow INT0 to trigger the wake-up of CPU from STOP modes.

WKMASK register defines the wake-up control of the interrupt signals from the STOP/SLEEP mode. The wake-up is performed by these interrupts and SYSCLK resumes if the internal oscillator is turned on. The interrupt can be set as a level trigger or an edge trigger and the wake-up always runs in accordance with the edge. The wake-up control is wired separately from the interrupt logic, and therefore after waking up, the CPU does not necessarily enter the interrupt service routine if the corresponding interrupt is not enabled. In this case, the CPU continues onto the next instruction, which initiates the STOP/SLEEP mode. Extra attention should be paid to the modes of exit and re-entry to ensure proper operation.

All clocks are stopped in STOP/SLEEP mode, therefore, peripherals that require clock such as I²C slave, UARTx, LVD, and T3/T4 cannot perform the wake-up function. Only external pins and peripherals that do not require a clock can be used for wake-up purposes. Such peripherals are LIN Wakeup and Timer 5 with SOSC32KHz.

5.7.1 IDLE Mode

IDLE mode provides power saving by stopping SYSCLK from CPU and its integrated peripherals while other peripherals are still in operation with SYSCLK. Thus, other peripherals still function normally and can generate interrupts that wake up the CPU from IDLE mode. The IDLE mode is enabled by setting IDLE bit to 1.

When the CPU is in idle mode, no processing is possible. All integrated internal peripherals such as T0/T1/T2, UART0, LIN-capable 16550-like UART2 and I²C Master are inaccessible during idling. The IDLE mode can be exited by hardware reset through RSTN pin or by external interrupts as well as the interrupts from external peripherals that are OR-ed with the external interrupts. The triggering external interrupts need to be enabled properly. Upon exiting from IDLE mode, the CPU resumes operation as the clock is turned on. CPU immediately vectors to the interrupt service routine of the corresponding interrupt sources that wake up the CPU. When the interrupt service routine is complete, RETI returns to the program and immediately follows the one that invokes the IDLE mode. Upon returning from IDLE mode to normal mode, the idle bit in PCON is automatically cleared.

5.7.2 STOP Mode

STOP mode provides further power reduction by stopping SYSCLK to all circuits. In STOP mode, IOSC oscillator is disabled. STOP mode is entered by setting STOP=1. To achieve minimum power consumption, it is essential to turn off all peripherals with DC current consumption. It is also important that the software switches to the IOSC clock and disables all other clock generators before entering STOP mode. This is critical to ensure a smooth transition when resuming its normal operations. Upon entering STOP mode, the system uses the last edge of IOSC clock to shut down the IOSC clock generator.



Valid interrupt/wakeup event or reset will result in the exit of STOP mode. Upon exit, STOP bit is cleared by hardware and IOSC is resumed. The triggering interrupt source must be enabled and its wake-up bit is set in the WKMASK register. CPU will resume normal operation and use previous clock settings. When an interrupt occurs, the CPU immediately vectors to the interrupting service routine of the corresponding interrupt source. When the interrupt service routine completes, RETI returns to the program immediately to execute the instruction that invokes the STOP mode.

The on-chip 1.5V regulator for core circuits is still enabled along with its reference voltage. As a result, the power consumption due to the regulator and its reference circuit is still around 100uA to 200uA. The advantage of STOP mode is its immediate resumption of the CPU.

5.7.3 SLEEP Mode

SLEEP mode achieves very low standby consumption by putting the on-chip 1.5V regulator in disabled state. An ultra-low-power backup regulator supplies (typical 1.4v) the internal core circuit and maintains the logic state and SRAM data. The total current drain in SLEEP mode is less than 1uA. Only the backup regulator and the SOSC32KHz circuit are still in operation in SLEEP mode.

The exit of SLEEP mode is the same interrupt/wakeup event as in STOP node, and in addition the on-chip regulator is enabled, then after a delay set by REGRDY (clocked by SOSC32KHz), SYSCLK is resumed. REGRDY delay is necessary to ensure stable operation of the regulator. The larger the decoupling capacitance, the longer delay should be set.

5.7.4 Clock Control

The clock selection is defined by CKSEL register (0x8F). There are two selections either from divided IOSC or SOSC32KHz. The default selection is divided IOSC. The typical power consumption of CPU is 0.150mA/MHZ.

5.8 Watchdog Timer

The Watchdog Timer is a 30-bit timer that can be used by a system supervisor or as an event timer. The Watchdog timer can be used to generate an interrupt or to issue a system reset depending on the control settings. This section describes the register related to the operation of Watchdog Timer and its functions. The following diagram shows the structure of the Watchdog Timer. WDT shares the same clock with the CPU, thus, WDT is disabled in IDLE mode or STOP mode and it runs at a reduced rate in PMM mode.

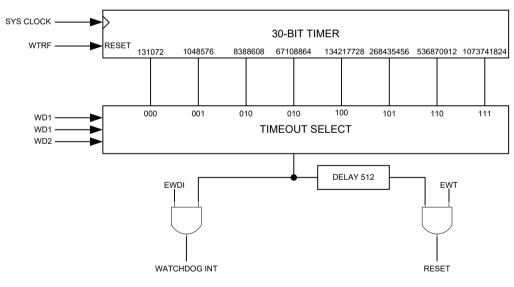


Figure 5-1 Watchdog Timer block diagram

WDCON (0xD8) R/W (0x02) TA protected on bit 0 RWT only

	7	6	5	4	3	2	1	0
RD	-	-	-	-	WDIF	WTRF	EWT	-
WR	-	-	-	-	WDIF	WTRF	EWT	RWT

WDIF

WDT Interrupt Flag bit. This bit is set when the session expires regardless of a WDT interrupt is enabled or not. Note the WDT interrupt enable control is located in EIE (0xE8). 4 EWDI bit. It must be cleared by software.



WTRF	WDT Reset Flag bit. WDRF is cleared by hardware reset including RSTN, POR etc. WTRF is set to 1 after a WDT reset occurs. It can be cleared by software. WTRF can be used by software to determine if a WDT reset has occurred.
EWT	Watchdog Timer Reset Enable bit. Set this bit to enable the watchdog reset function. The default WDT reset is enabled and WDT timeout is set to maximum.
RWT	Reset the Watchdog timer. Writing 1 to RWT resets the WDT timer. RWT bit is not a register and does not hold any value. The clearing action of Watchdog timer is protected by TA access. In another word, to clear Watchdog timer, TA must be unlocked and then followed by writing RWT bit to 1. If TA is still locked, the program can write 1 into RWT bit, but it does not reset the Watchdog timer.

CKCON (0x8E) R/W (0xC4)

	7	6	5	4	3	2	1	0
RD	WD1	WD0	T2CKDCTL	T1CKDCTL	. TOCKDCTL	WD2	-	-
WR	WD1	WD0	T2CKDCTL	T1CKDCTL	. TOCKDCTL	WD2	-	-
Т	2CKDCTL	Tim divi divi	er 2 division f ded by 4. Set	actor to 4, the	Factor Control Timer 2 clock 0 (the default p imer 2 clock fre	frequency eq	uals CPU clo e) sets the Ti	ck freque mer 2
Т	1CKDCTL	Tim frec Tim	er 1 division f quency divide	actor to 4, and by 4. Setting actor to 12, a	Factor Control d the Timer 1 d g this bit to 0 (th nd the Timer 1	lock frequenc	y equals CPL ver-on value)	J clock sets the
Т	OCKDCTL	Tim frec Tim frec	er 0 division f quency divided er 0 division f quency divided	actor to 4, and by 4. Setting actor to 12, a by 12.	Factor Control d the Timer 0 d g this bit to 0 (th nd the Timer 0	lock frequenc ne default pow clock frequen	y equals CPL ver-on value) icy equals CF	J clock sets the 2U clock
V	VD[2:0]				out value of W and the default			. The tim
			WD2					
			WDZ	WD1	VD0	Time Out Va		
			0	0 VD1	VD0 0	Time Out Va 131072		
							alue	
			0	0	0	131072		
			0	0	0 1	131072 1048576		
			0 0 0	0 0 1	0 1 0	131072 1048576 8388608	alue	
			0 0 0 0	0 0 1 1	0 1 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	131072 1048576 8388608 67108864	alue	
			0 0 0 0 1	0 0 1 1 0	0 1 0 1 0 1 0 1 0 0 0 0 0 0 0 0 0 0 0 0	131072 1048576 8388608 67108864 13421772	alue	

A second 16-bit Watchdog Timer (WDT2) clocked by the independent nonstop SOSC32KHz (32KHz) is included. WDT2 can be used to generate interrupt/wakeup timing from STOP/SLEEP mode, or generate software reset.

WDT2CF (0xA0D8) WatchDog Timer 2 Configure Registers R/W (0xA7) TB Protected

	7	6	5	4	3	2	1	0	
RD	-	WDT2REN	WDT2RF	WDT2IEN	WDT2CS[2-0]			WDT2IF	
WR	WDT2CLR	WDT2REN	WDT2RF	WDT2IEN		WDT2CS[2-0]			
W	/DT2CLR /DT2REN /DT2RF	Writin WDT WDT	2 Reset Enat	⁻ 2CLR clears ble figures WDT2		ount to 0. It is a	self-cleared b	y hardware.	



8 msec

128 msec

256 msec

512 msec

1024 msec

	WDT2RF is set to " by writing "0".	1" after a WDT2 reset occurs. T	his must be cleared	by softw				
WDT2IEN	WDT2 Interrupt En	able						
	WDT2IEN=1 enabl	es WDT2 interrupt.						
WDT2CS[2-0]	WDT2 Clock Scaling							
	WDT2CS[2-0]	Clock SOSC32KHz Divider	WDT2 Period					
	000	2^8	8 msec					
	001	2^8	8 msec					
	010	2^8	8 msec					

2^8

2^12

2^13

2^14

2^15

WDT2IF

111 WDT2 Interrupt Flag

011

100

101

110

WDT2IF is set to "1" after a WDT2 interrupt. This must be cleared by software by writing "0".

Please note that the longest effective time WDT2 can be set is approximately 18 hours.

WDT2L (0xA0D9) Watchdog Timer 2 Time Out Value Low Byte RW (0xFF) TB Protected

	7	6	5	4	3	2	1	0
RD		WDT2CNT[7-0]						
WR	WDT2[7-0]							

WDT2H (0xA0DA) Watchdog Timer 2 Time Out Value High Byte RW (0x0F) TB Protected

	7	6	5	4	3	2	1	0
RD	WDT2CNT[15-8]							
WR	WDT2[15-8]							

WDT2L and WDT2H hold the time-out value for watchdog timer 2. When the counter reaches the WDT2 time-out value, an interrupt or reset is generated. Reading this register returns the current count value.

A third Watchdog Timer (WDT3) is also included for further enhancement of fault recovery. WDT3 cannot be disabled in normal mode. The clock scaling of WDT3 is the same as WDT2.

WDT2CS[2-0]	Clock SOSC32KHz Divider	WDT3 Period
000	2^8	8 msec
001	2^8	8 msec
010	2^8	8 msec
011	2^8	8 msec
100	2^12	128 msec
101	2^13	256 msec
110	2^14	512 msec
111	2^15	1024 msec

Therefore, the longest time of WDT3 is about 1 second timing 2^16 equal approximately to 18 hours. In default setting, the time of WDT3 is 8 msec timing 2^8 equal approximately to 2 seconds.



WDT3CF (0xA0DB) WatchDog Timer 3 Configure Registers R/W (0xD1) TB Protected

					. ,			
	7	6	5	4	3	2	1	0
RD	-		-				WDT3RF	
WR	WDT3CLR		-				WDT3RF	
	DT3CLR DT3RF	Writi WDT WDT	3 Reset Flag	T3CLR clears			self-cleared b st be cleared l	•
WDT3L (0xA0DC) Watchdog Timer 3 Time Out Value Low Byte RO (0xFF) TB Protected								

3L (0xA0DC) Watchdog Timer 3 Time Out Value Low Byte RO (0xFF) TB Protected

	7	6	5	4	3	2	1	0
RD		WDT3CNT[7-0]						
WR	WDT3[7-0]							

WDT3H (0xA0DD) Watchdog Timer 3 Time Out Value High Byte RO (0x00) TB Protected

	7	6	5	4	3	2	1	0
RD	WDT3CNT[15-8]							
WR	WDT3[15-8]							

WDT3L and WDT3H hold the time out value for watchdog timer 3. When the counter reaches WDT2 time out value, a reset is generated. Reading this register returns the current count value.

System Timers – T0 and T1 5.9

The CPU contains three 16-bit timers/counters, Timer 0, Timer 1 and Timer 2. In timer mode, Timer 0, Timer 1 registers are incremented every 12 SYSCLK period when the appropriate timer is enabled. In the timer mode, Timer 2 registers are incremented every 12 or 2 SYSCLK period (depending on the operating mode). In the counter mode, the timer registers are incremented every falling edge on their corresponding inputs: T0, T1, and T2. These inputs are read every SYSCLK period.

Timer 0 and Timer 1 are fully compatible with the standard 8051. Timers 0 and 1 are controlled by TCON (0x88) and TMOD (0x89) registers while each timer consists of two 8-bit registers TH0 (0x8C), TL0 (0x8A), TH1 (0x8D), TL1 (0x8B).

TCON (0x88) R/W (0x00)

		/									
	7	6	5	4	3	2	1	0			
RD	TF1	TR1	TF0	TR0	PINT1F	-	PINT0F	-			
WR	-	TR1 - TR0 PINT1F - PINT0F									
TI	=1	Time routii	n entering the	e interrupt							
TI	R1	Timer 1 Run Control bit. Set to enable Timer 1.									
TI	=0	Timer 0 Interrupt Flag. TF0 is cleared by hardware when entering the introduction routine.						terrupt			
TI	R0	Time	r 0 Run Cont	rol bit. Set to	enable Timer	0.					
PI	INT1F	Pin INT1 Interrupt Flag bit. PINT1F is cleared by hardware when entering the interrupt routine.									
PI	INTOF	Pin I	•	Flag bit. PIN	T0F is cleared	d by hardware	when enterir	ng the			

TMOD (0x89) Timer 0 and 1 Mode Control Register

	7	6	5	4	3	2	1	0
RD	GATE1	CT1	T1M1	T1M0	GATE0	CT0	T0M1	T0M0
WR	GATE1	CT1	T1M1	T1M0	GATE0	CT0	T0M1	T0M0

GATE1

Timer 1 Gate Control bit. Set to enable external T1 to function as gating control of the counter.



CT1	Counter or Timer Mode Select bit. Set CT1 to access external T1 as the clock source. Clear CT1 to use the internal clock.							
T1M1	Timer 1	Timer 1 Mode Select bit.						
T1M0	Timer 1	Timer 1 Mode Select bit.						
GATE0	Timer 0	Gate Co	ontrol bit.	Set to enable external T0 to function as gating control of				
	the cour	nter.						
CT0	Counter	Counter or Timer Mode Select bit. Set CT0 to use external T0 as the clock source.						
	Clear C	Clear CT0 to use the internal clock.						
T0M1	Timer 0 Mode Select bit.							
TOMO	Timer 0 Mode Select bit.							
	M1	MO	Mode	Mode Descriptions				
	0	0	0	TL serves as a 5-bit pre-scaler and TH functions as an 8- bit counter/timer. They form a 13-bit operation.				
	0	1	1	TH and TL are cascaded to form a 16-bit counter/timer.				
	1	0	2	TL functions as an 8-bit counter/timer and auto-reloads from TH.				
	1	1	3	TL functions as an 8-bit counter/timer. TH functions as an 8-bit timer, which is controlled by GATE1. Only Timer 0 can be configured in Mode 3. When this happens, Timer 1 can only be used where its interrupt is not required.				

5.9.1 Mode 0

In this mode, TL serves as a 5-bit pre-scaler and TH functions as an 8-bit counter/timer. Both work together as a 13-bit counter/timer. The Mode 0 operation is shown in the following diagram.

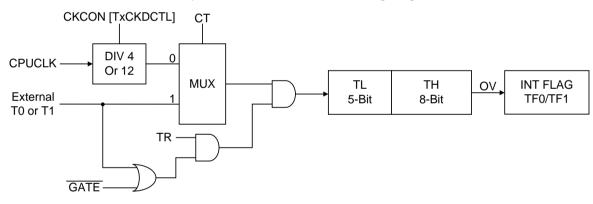
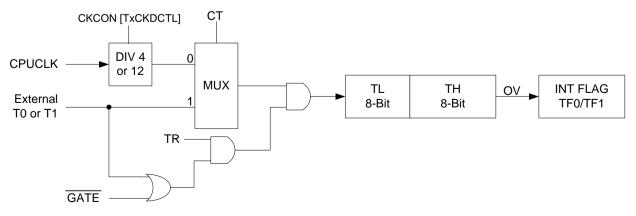


Figure 5-2 Timer/Counter Mode 0: 13-bit counter

5.9.2 Mode 1

Mode 1 operates the same way Mode 0 does, except TL is configured as 8-bit, and thus, forms a 16-bit counter/timer. This is shown as the following diagram.







5.9.3 Mode 2

Mode 2 configures the timer as an 8-bit re-loadable counter. The counter is TL while TH stores the reload data. The reload occurs when TL overflows. The operation is shown in the following diagram:

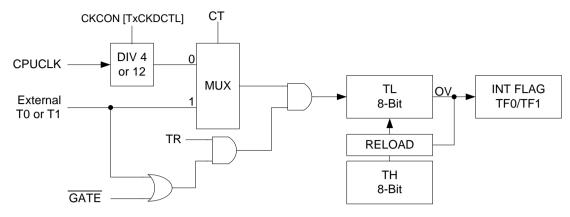
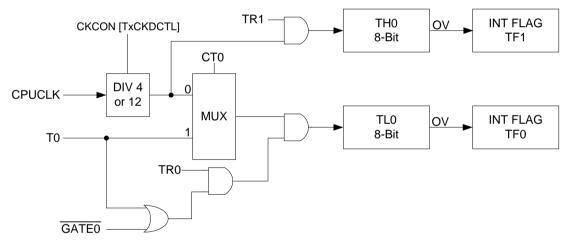


Figure 5-4 Timer/Counter Mode 2: 8-bit re-load

5.9.4 Mode 3

Mode 3 is a special mode for Timer 0 only. In this mode, Timer 0 is configured as two separate 8-bit counters. TL0 uses control and interrupt flags of Timer 0, whereas TH0 uses control and interrupt flag of Timer 1. Since Timer 1's control and flag are occupied, Timer 2 can only be used for counting purposes such as Baud rate generating while Timer 0 is in Mode 3. The operation flow of Mode 3 is shown in the following diagram.





5.10 System Timer – T2

Timer 2 is fully compatible with the standard 8052 timer 2. Timer 2 can be used as the re-loadable counter, capture timer, or baud rate generator. Timer 2 uses five SFR as counter registers, capture registers and a control register.

	7	6	5	4	3	2	1	0	
RD	TF2	EXF2	RCLK	CT2	CPRL2				
WR	TF2	EXF2 RCLK TCLK EXEN2 TR2 CT2							
	=2 XF2	TF2 mea T2E2 This	ns Timer 2 is X Falling Edge	ed by softwar used as an U e Flag bit	re. TF2 is not ART0 Baud ra a falling edge v	ate generator).	· ·	
R	CLK		eive Clock En	able bit					

T2CON (0xC8) Timer 2 Control and Configuration Register



	1 – UART0 receiver is clocked by Timer 2 overflow pulses
	0 – UART0 receiver is clocked by Timer 1 overflow pulses
TCLK	Transmit Clock Enable bit
	 UART0 transmitter is clocked by Timer 2 overflow pulses
	0 – UART0 transmitter is clocked by Timer 1 overflow pulses
EXEN2	T2EX Function Enable bit.
	 Allows capture or reload as T2EX falling edge appears
	0 – Ignore T2EX events
TR2	Start/Stop Timer 2 Control bit
	1 – Start
	0 – Stop
CT2	Timer 2 Timer/Counter Mode Select bit
	 External event counter uses T2 pin as the clock source
	0 – Internal clock timer mode
CPRL2	Capture/Reload Select bit
	1 – Use T2EX pin falling edge for capture
	0 – Automatic reload on Timer 2 overflow or falling edge of T2EX (when EXEN2=1). If RCLK or TCLK is set (Timer 2 is used as a baud rate generator), this bit is ignored and an automatic reload is forced on Timer 2 overflows.

Timer 2 can be configured in three modes of operations -Auto-reload Counter, Capture Timer, or Baud Rate Generator. These modes are defined by RCLK, TCLK, CPRL2 and TR2 bits of T2CON registers. The definition is illustrated in the following table:

RCLK or TCLK	CPRL2	TR2	Mode Descriptions
0	0	1	16-bit Auto-reload Counter mode. Timer 2 overflow sets the TF2 interrupt flag and TH2/TL2 is reloaded with RLDH/RLHL register.
0	1	1	16-bit Capture Timer mode. Timer 2's overflow sets TF2 interrupt flag. When EXEN2=1, TH2/TL2 content is captured into RLDH/RLDL when T2EX falling edge occurs.
1	Х	1	Baud Rate Generator mode. Timer 2's overflow is used for configuring UART0.
Х	Х	0	Timer 2 is stopped.

The block diagram of the Timer 2 operating in Auto-reload Counter and Capture Timer modes are shown in the following diagram:

External T2 and External T2EX are tied together in this product.

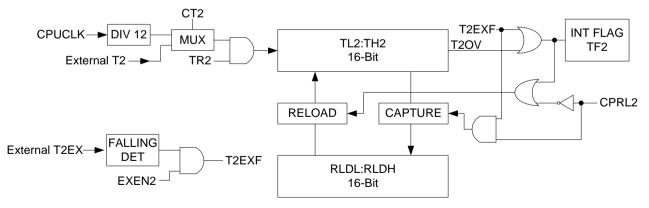
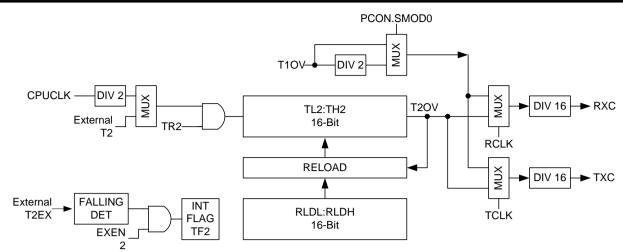


Figure 5-6 Timer 2 block diagram of Auto-reload and Capture

The block diagram of the Timer 2 operating in Baud Rate Generator is shown in the following diagram:







5.11 System Timer – T3 and T4

Both Timer 3 and Timer 4 are simple 16-Bit reload timers or free-run counters and are clocked by the system clock. The block diagram is shown as below.

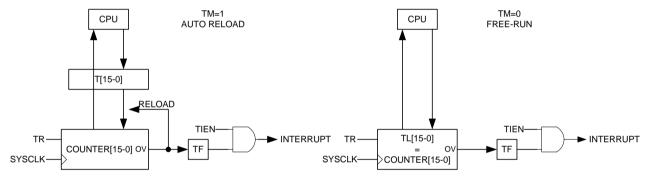


Figure 5-8 Timer 3 and Timer 4 block diagram

T34CON (0xCF) Timer 3 and Timer 4 Control and Status Register

	7	6	5	4	3	2	1	0		
	1	0	5	-	5	L	•	U		
RD	TF4	TM4	TR4	T4IEN	TF3	TM3	TR3	T3IEN		
WR	TF4	TM4	TR4	T4IEN	TF3	TM3	TR3	T3IEN		
TF	TF4 Timer 4 Overflow Interrupt Flag bit.									
TF4 is set by hardware when overflow condition occurs. T software.					ion occurs. T	F4 must be cl	eared by			
T	M4	Timer 4 Mode Control bit. TM4 = 1 set timer 4 as auto reload, and TM4=0 set tir as free-run.						=0 set timer 4		
TF	२4	Time	r 4 Run Cont	rol bit. Set to	enable Timer	4, and clear t	o stop Timer	4.		
T4IEN			Timer 4 Interrupt Enable bit							
					overflow interr	•				
TF	=3			Interrupt Flag						
TF3 is set by hardware when overflow condition occurs. TF3 must be cleared software.					eared by					
Т	TM3 Timer 3 Mode Control bit. TM3 = 1 sets timer 3 as auto reload, and TM3=0 se timer 3 as free-run.						3=0 sets			
TF	२३	Time	r 3 Run Cont	rol bit. Set to	enable Timer	3, and clear t	o stop Timer	3.		
TR3Timer 3 Run Control bit. Set to enable Timer 3, and clear to stop Timer 3.T3IENTimer 3 Interrupt Enable bitT3IEN=0 disables the Timer 3 overflow interrupt.T3IEN=1 enables the Timer 3 overflow interrupt.										



TL3 (0xAE) Timer 3 Low Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0
RD	T3[7-0]							
WR	T3[7-0]							

TH3 (0xAF) Timer 3 High Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0
RD	T3[15-8]							
WR		T3[15-8]						

TL4 (0xAC) Timer 4 Low Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0	
RD		T4[7-0]							
WR		T4[7-0]							

TH4 (0xAD) Timer 4 High Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0	
RD		T4[15-8]							
WR		T4[15-8]							

T3[15-0] and T4[15-0] function differently when being read or written. When written in auto-reload mode, its reload value register is written, and in free-run mode, the counter value is written immediately. When read, the return value is always the present counter value. There is no snapshot buffer in the read operation, so software should always read the high byte then the low byte.

5.12 System Timer – T5

T5 is a 24-Bit simple timer. It can select four different clock sources and can be used for extended sleep mode wake up. The clock sources include IOSC and SOSC32KHz. T5 can be configured either as free-run mode or auto-reload mode. Timer 5 does not depend on the SYSCLK; therefore, it continues to count under STOP or SLEEP mode if the clock source is present. The following diagram shows the block diagram of Timer 5.

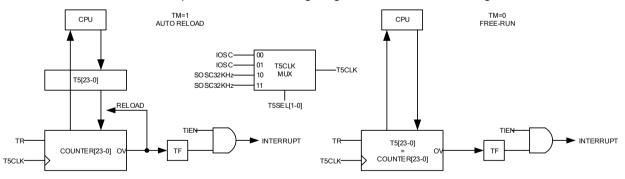


Figure 5-9 Timer 5 block diagram

T5CON (0xA068) Timer 5 Control and Status Register

	7	6	5	4	3	2	1	0
RD	TF5	T5SEL[1]	T5SEL[0]	TM5	TR5	-	-	T5IEN
WR	TF5	T5SEL[1]	T5SEL[0]	TM5	TR5	-	-	T5IEN
	F5 5SEL[1-0]	Timer 5 Overflow Interrupt Flag bit TF5 is set by hardware when overflow condition occurs. TF5 must be cleared by software. Timer 5 Clock Selection bits T5SEL[1-0] = 00, IOSC T5SEL[1-0] = 01, IOSC T5SEL[1-0] = 10, SOSC32KHz						eared by



	T5SEL[1-0] = 11, SOSC32KHz
TM5	Timer 5 Mode Control bit. TM5=1 sets timer 5 as auto reload, and TM5=0 sets timer
	5 as free-run.
TR5	Timer 5 Run Control bit. Set to enable Timer 5, and clear to stop Timer 5.
T5IEN	Timer 5 Interrupt Enable bit.
	T5IEN=0 disables the Timer 5 overflow interrupt.
	T5IEN=1 enables the Timer 5 overflow interrupt.

TL5 (0xA069) Timer5 Low Byte Register 0 R/W 00000000

			0						
	7	6	5	4	3	2	1	0	
RD	T5[7-0]								
WR		T5[7-0]							

TH5 (0xA06A) Timer5 Medium Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0	
RD	T5[15-8]								
WR		T5[15-8]]							

TT5 (0xA063) Timer5 High Byte Register 0 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		T5[23-16]								
WR		T5[23-16]								

T5[23-0] functions differently when being read or written. When written in auto-reload mode, its reload value register is written, and in free-run mode, the counter value is written immediately. When read, the return value is always the present counter value. There is no snapshot buffer in the read operation, so software should always read the high byte then the low byte.

5.13 Multiplication and Division Unit (MDU)

MDU provides acceleration on unsigned integer operations of 16-bit multiplications, 32-bit division, and shifting and normalizing operations. The following table shows the execution characteristics of these operations. The MDU does not contain the operation completion status flag. Therefore, the most efficient utilization of MDU uses NOP delay for the required clock time of the MDU operation types. The number of clock cycles required for each operation is shown in the following table and it is counted from the last write of the writing sequence.

Operations	Result	Reminder	# of Clock Cycle
32-bit division by 16-bit	32-bit	16-bit	17
16-bit division by 16-bit	16-bit	16-bit	9
16-bit multiplication by 16-bit	32-bit	-	10
32-bit normalization	-	-	3 – 20
32-bit shift left/right	-	-	3 – 18

The MDU is accessed through MD0 to MD5 which contains the operands and the results, and the operation is controlled by ARCON register.

	7	6	5	4	3	2	1	0	
RD	MDEF	MDOV	SLR	SC4	SC3	SC2	SC1	SC0	
WR	MDEF	MDOV SLR SC4 SC3 SC2 SC1							
N		MDU Error Flag bit. Set by hardware to indicate MDx being written before the previous operation completes. MDEF is automatically cleared after reading ARCON. MDU Overflow Flag bit. MDOV is set by hardware if the dividend is zero or the result of multiplication is greater than 0x0000FFFFh							
ç	SLR		Direction Col ft to the left.	ntrol bit. SLR	= 1 indicates	a shift to the i	right and SLR	=0 indicates	

ARCON (0xFF) MDU Control R/W 0000000



SC4-0

Shift Count Control and Result bit. If SC0-4 is written with 00000, the normalization operation is performed by MDU. When the normalization is completed, SC4-0 contains the number of shifts performed during the normalization. If SC4-0 is written with a non-zero value, then the shift operation is performed by MDU with the number of shifts specified by SC4-0 value.

MD0 (0xF9) MDU Data Register 0 R/W 00000000

	7	6	5	4	3	2	1	0	
RD	MD0[7-0]								
WR		MD0[7-0]							

MD1 (0xFA) MDU Data Register 1 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		MD1[7-0]								
WR		MD1[7-0]								

MD2 (0xFB) MDU Data Register 2 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		MD2[7-0]								
WR		MD2[7-0]								

MD3 (0xFC) MDU Data Register 3 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		MD3[7-0]								
WR		MD3[7-0]								

MD4 (0xFD) MDU Data Register 4 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		MD4[7-0]								
WR		MD4[7-0]								

MD5 (0xFE) MDU Data Register 5 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		MD5[7-0]								
WR		MD5[7-0]								

MDU operation consists of three phases.

1. Loading MD0 to MD5 data registers in an appropriate order depending on the operation.

2. Execution of the operations.

3. Reading results from MD0 to MD5 registers.

The following list shows the MDU read and write sequences. Each operation has its unique writing sequence and reading sequence of MD0 to MD5 registers, therefore, a precise access sequence is required.

5.13.1 Division – 32-bit divide by 16-bit or 16-bit divide by 16-bit

Follow the following write-sequence. The first write of MD0 resets the MDU and initiates the MDU error flag mechanism. The last write incites calculation of MDU.

Write MD0 with Dividend LSB byte

Write MD1 with Dividend LSB+1 byte

Write MD2 with Dividend LSB+2 byte (ignore this step for 16-bit divide by 16-bit)

Write MD3 with Dividend MSB byte (ignore this step for 16-bit divide by 16-bit)

Write MD4 with Divisor LSB byte



Write MD5 with Divisor MSB byte

Then follow the following read-sequence. The last read prompts MDU for the next operations.

Read MD0 with Quotient LSB byte

Read MD1 with Quotient LSB+1 byte

Read MD2 with Quotient LSB+2 byte (ignore this step for 16-bit divide by 16-bit)

Read MD3 with Quotient MSB byte (ignore this step for 16-bit divide by 16-bit)

Read MD4 with Remainder LSB byte

Read MD5 with Remainder MSB byte

Read ARCON to determine error or overflow condition

Please note that if the sequence is violated, the calculation may be interrupted and result in errors.

5.13.2Multiplication – 16-bit multiply by 16-bit

Follow the following write sequence.

Write MD0 with Multiplicand LSB byte

Write MD4 with Multiplier LSB byte

Write MD1 with Multiplicand MSB byte

Write MD5 with Multiplier MSB byte

Then follow the following read sequence.

Read MD0 with Product LSB byte

Read MD1 with Product LSB+1 byte

Read MD2 with Product LSB+2 byte

Read MD3 with Product MSB byte

Read ARCON to determine error or overflow condition

5.13.3Normalization – 32-bit

Normalization is obtained with integer variables stored in MD0 to MD3. After normalization, all leading zeroes are removed by shift left operations. To start the normalization operation, SC4-0 in ARCON is first written with 00000. After completion of the normalization, SC4-0 is updated with the number of leading zeroes and the normalized result is restored on MD0 to MD3. The number of the shift of the normalization can be used as exponents. The following write sequence should be followed. The last write to ARCON initiates the normalization operations by MDU.

Write MD0 with Operand LSB byte

Write MD1 with Operand LSB+1 byte

Write MD2 with Operand LSB+2 byte

Write MD3 with Operand MSB byte

Write ARCON with SC4-0 = 00000

Then follow the following read sequence.

Read MD0 with Result LSB byte

Read MD1 with Result LSB+1 byte

Read MD2 with Result LSB+2 byte

Read MD3 with Result MSB byte

Read SC[4-0] from ARCON for normalization count or error flag

5.13.4Shift - 32-bit

Shift is done with integer variables stored in MD0 to MD3. To start the shift operation, SC4-0 in ARCON is first written with shift count and SLR with shift direction. After completion of the Shift, the result is stored back to



MD0 to MD3. The following write sequence should be followed. The last write to ARCON initiates the normalization operations by MDU.

Write MD0 with Operand LSB byte

Write MD1 with Operand LSB+1 byte

Write MD2 with Operand LSB+2 byte

Write MD3 with Operand MSB byte

Write ARCON with SC4-0 = Shift count and SLR with shift direction

Then follow the following read sequence.

Read MD0 with Result LSB byte

Read MD1 with Result LSB+1 byte

Read MD2 with Result LSB+2 byte

Read MD3 with Result MSB byte

Read ARCON's for error flag

5.13.5MDU Flag

The error flag (MDEF) of MDU indicates improperly performed operations. The error mechanism starts at the first MD0 write and finishes with the last read of MD result register. MDEF is set if current operation is interrupted or restarted by improper write of MD register before the operation completes. MDEF is cleared if the operations and proper write/read sequences successfully complete. The overflow flag (MDOV) of MDU indicates an error of operations. MDOV is set if

The divisor is zero

Multiplication overflows

Normalization operation is performed on already normalized variables (MD3.7 =1)

5.14 Serial Port – UART0

UART0 is full duplex and fully compatible with the standard 8052 UART. The receive path of the UART0 is double-buffered that can commence reception of a second byte before previously received byte is read from the receive register. Writing to SBUF0 loads the transmit register while reading SBUF0, reads a physically separate receive register. The UART0 can operate in four modes: one synchronous (Mode 0) and three asynchronous modes (Mode 1, 2, and 3). Mode 2 and Mode 3 share a special provision for multi-processor communications. This feature is enabled by setting SM2 in SCON0 register. The master processor first sends out an address byte, which identifies the slave. An address byte differs from a data byte in the 9th bit: 1 defines an address byte, whereas 0 defines a data byte. When SM2 is set to 1, no slave can be interrupted by a data byte. The addressed slave clears its SM2 bit and prepares to receive the following incoming data bytes. The slaves that are not addressed leave their SM2 set and ignore the incoming data. The UART0-related registers are SBUF0, SCON0, PCON, IE, and IP.

	7	6	5	4	3	2	1	0
RD	SM0	SM1	SM2	REN	TB8	RB8	TIF	RIF
WR	SM0	SM1	SM2	REN	TB8	RB8	TIF	RIF
SI	M0, SM1	UAR	T Operation N	Node				

SCON0 (0x98) UART0 Configuration Register

MODE	SM0	SM1	Description
0	0	0	Synchronous Shift Register Mode Baud rate = SYSCLK/12
1	0	1	8-Bit UART Mode Baud rate = Timer 1 or Timer 2 overflow rate. This is selected in T2CON registers.
2	1	0	9-Bit UART Mode, fixed baud rate Baud rate = SYSCLK/64 (PCON.SMOD0 = 0) or SYSCLK/32 (PCON.SMOD0 = 1)



	MODE	SM0	SM1	Description				
	3	1	1	9-Bit UART Mode, variable baud rate Baud rate = Timer 1 or Timer 2 overflow rate. This is selected in TCON registers.				
SM2	Set to enab	le a mu	ltiprocess	or communication as a slave device.				
REN	Set REN=1 to enable UART PMM switch back function. REN=0 disables this function. In PMM mode, if REN=1, then any transition on RX of UART triggers the exit of PMM mode into normal mode.							
	The transmit-value of 9th bit in 9-bit UART mode (mode 2 and mode 3). Set or cleared by CPU depending on the function of the 9th bit as a parity check bit or a multi-processor.							
	The receive cleared by			n 9-bit UART mode (mode 2 and mode 3). Set or				
	Transmit Interrupt Flag bit. Set by hardware after completion of a serial transmission and must be cleared by software. The interrupt enable bit is located in IE (0xA8) and the interrupt priority is located in IP (0xB8).							
RIF	Receive Int	errupt F ared by	lag bit. Se software.	et by hardware after completion of a serial reception and The interrupt enable bit is located in IE (0xA8) and the				

SBUF0 (0x99) UART0 Data Buffer Register

	7	6	5	4	3	2	1	0		
RD		RB[7-0]								
WR		TB[7-0]								

SBUF0 is used for both transmission and reception. Writing a data byte into SBUF0 puts this data in UART0's transmit buffer and starts a transmission. Reading a byte from SBUF means data being read from the UART0's receive buffer.

5.14.1 Mode 0

Mode 0 is a simple synchronous shift register mode. TXD0 outputs the shift clock, which is fixed at CPUCLK/12. RXD0 is a bidirectional I/O port that serves as a data-shifting port. To utilize this mode, TXD0 pin must be enabled as an output pin, while RXD0 needs to be configured as an open-drain type of I/O port. The shift data changes at the rising edge of the shift clock and is valid at the falling edge of the shift clock. The transmission starts when a new byte is written in SBUF0 as TI is cleared to 0. When the byte is transmitted, TI is set and the UARTO waits for the next byte to be transmitted. The reception is initiated by setting REN=1 and RI cleared to 0. When a byte is received, RI is set by UART0.

5.14.2Mode 1

8-bit UART mode. RXD0 is the serial input and TXD0 is the serial output. To utilize this mode, the corresponding RXD0 and TXD0 pin configuration should also be set correctly. 10-bit data (including a Start bit, 8 data bit, and a Stop bit) are transferred. For UARTO, the baud rate is set by Timer 1 or Timer 2 overflow rate. The control is determined by SMOD0.PCON, and RCLK.T2CON, TCLK.T2CON. When SMOD0.PCON is 1, Timer 1 overflow is selected, and SMOD0.PCON is 0, Timer 1 overflow rate divided by 2 is selected. And if RCLK.T2CON, or TCLK.T2CON is set, the Timer 2 overflow rate is selected and overwrites the SMOD0 setting.

5.14.3 Mode 2

9-bit UART mode. RXD0 is the serial input and TXD0 is the serial output. To utilize this mode, the corresponding RXD0 and TXD0 pins should be configured correctly. 11-bit data including a Start bit (always 0), 8 data bits, a programmable 9th bit, and a Stop bit (always 1) are transferred. The 9th bit can be configured as a parity bit configured by software through TB8 in SCON0. The received 9th bit can be read from TB8. The software determines the correctness of the parity check. The baud rate in Mode 2 is fixed at 1/32 or 1/64 of CPU clock. This is controlled by SMOD0 in PCON register.

5.14.4 Mode 3

Like Mode 2 (9-bit UART mode). RXD0 is the serial input and TXD0 is the serial output. To utilize this mode, the corresponding RXD0 and TXD0 pins should also be configured properly. 11-bit data including a Start bit (always 0), 8 data bits, a programmable 9th bit, and a Stop bit (always 1) are transferred. The 9th bit can serve as a parity bit configured by software through TB8 in SCON0. The received 9th bit can be read from TB8. The software



determines the correctness of the parity check. The mechanism of the baud rate control in Mode 3 is like that in Mode 1, which is determined by Timer 1 or Timer 2 overflow and is set by SMOD0, and T2CON.

5.15 I²C Master

The I²C master controller provides the interface to I²C slave devices. It can be programmed to operate with arbitration and clock synchronization to allow it to operate in multi-master configurations. The master uses SCL and SDA pins. The controller contains a built-in 8-bit timer to allow various I²C bus speeds. The maximum I²C master bus speed is limited to SYSCLK/12.

I2CMTP (0xF7) I²C Master Time Period R/W 00000000

	7	6	5	4	3	2	1	0		
RD		I2CMTP[7-0]								
WR		I2CMTP[7-0]								

This register set the frequency of I²C bus clock. If I2CMTP[7-0] is equal to or larger than 0x01, SCL_FREQ = SYSCLK_FREQ/8/(1 + I2CMTP). If I2CMTP[7-0] = 0x00, SCL_FREQ = SYSCLK_FREQ /12.

I2CMSA (0xF4) I²C Master Slave Address R/W 00000000

	<u> </u>									
	7	6	5	4	3	2	1	0		
RD		SA[6-0] RS								
WR	SA[6-0] RS									
S	SA[6-0] Slave Address. SA[6-0] defines the slave address the I ² C master uses to communicate.							0		
R	RS Receive/Send Bit. RS determines if the following operation is to RECEIVE (RS=1) or									

Receive/Send Bit. RS determines if the following operation is to RECEIVE (RS=1) or SEND (RS=0).

I2CMBUF (0xF6) I²C Master Data Buffer Register R/W 0000000

	7	6	5	4	3	2	1	0		
RD		RD[7-0]								
WR		TD[7-0]								

I2CMBUF functions as a transmit-data register when written and as a receive-data register when read. When written, TDis sent to the bus by the next SEND or BURST SEND operations. TD[7] is sent first. When read, RD contains the 8-bit data received from the bus upon the last RECEIVE or BURST RECEIVE operation.

I2CMCR (0xF5) I²C Master Control and Status Register R/W 0000000

	7	6	5	4	3	2	1	0
RD	-	BUSBUSY	IDLE	ARBLOST	DATAACK	ADDRACK	ERROR	BUSY
WR	CLEAR	INFILEN	-	HS	ACK	STOP	START	RUN

The I2CMCR register is used for setting control when it is written, and as a status signal when read.

-	
CLEAR	Reset I ² C Master State Machine
	Set CLEAR=1 will reset the state machine. CLEAR is self-cleared when reset is
	completed.
BUSBUSY	This bit indicates that the external I ² C bus is busy and access to the bus is not
	possible. This bit is set/reset by START and STOP conditions.
INFILEN	Input Noise Filter Enable. When IFILEN is set, pulses shorter than 50 nsec on inputs
	of SDA and SCL are filtered out.
IDLE	This bit indicates that I ² C master is in the IDLE mode.
ARBLOST	This bit is automatically set when the last operation I ² C master controller loses the
	bus arbitration.
ERROR	This bit indicates that an error occurs in the last operation. The errors include slave
	address is not acknowledged, or transmitted data is not acknowledged, or the
	master controller loses arbitration.
BUSY	This bit indicates that I ² C master is receiving or transmitting data, and other status
	bits are not valid.



ADDRERR

DATAERR

acknowledged. This bit is automatically set when the last operation transmitted data is not acknowledged.

This bit is automatically set when the last operation slave address transmitted is not

START, STOP, RUN and HS, RS, ACK bits are used to drive I²C Master to initiate and terminate a transaction. The Start bit generates START, or REPEAT START protocol. The Stop bit determines if the cycle stops at the end of the data cycle or continues to burst. To generate a single read cycle, the designated address is written in SA, RS is set to 1, and bits ACK=0, STOP=1, START=1, RUN=1 are set in I2CMCR to perform the operation and then STOP. When the operation is completed (or aborted due to errors), I²C master generates an interrupt. The ACK bit must be set to 1. This causes the controller to send an ACK automatically after each byte transaction. The ACK bit must be reset when set to 0 when the master operates in receive mode and not to receive further data from the slave devices.

The following table lists the permitted control bits combinations in master IDLE mode.

HS	RS	ACK	STOP	START	RUN	Operations
0	0	-	0	1	1	START condition followed by SEND. Master remains in TRANSMITTER mode
0	0	-	1	1	1	START condition followed by SEND and STOP
0	1	0	0	1	1	START condition followed by RECEIVE operation with negative ACK. Master remains in RECEIVER mode
0	1	0	1	1	1	START condition followed by RECEIVE and STOP
0	1	1	0	1	1	START condition followed by RECEIVE. Master remains in RECEIVER mode
0	1	1	1	1	1	Illegal command
1	0	0	0	0	1	Master Code sending and switching to HS mode

The following table lists the permitted control bits combinations in master TRANSMITTER mode.

HS	RS	ACK	STOP	START	RUN	Operations
0	-	-	0	0	1	SEND operation. Master remains in TRANSMITTER mode
0	-	-	1	0	0	STOP condition
0	-	-	1	0	1	SEND followed by STOP condition
0	0	-	0	1	1	REPEAT START condition followed by SEND. Master remains in TRANSMITTER mode
0	1	-	1	1	1	REPEAT START condition followed by SEND and STOP condition
0	1	0	0	1	1	REPEAT START condition followed by RECEIVE operation with negative ACK. Master remains in TRANSMITTER mode
0	1	0	1	1	1	REPEAT START condition followed by SEND and STOP condition.
0	1	1	0	1	1	REPEAT START condition followed by RECEIVE. Master remains in RECEIVER mode.
0	1	1	1	1	1	Illegal command

The following table lists the permitted control bits combinations in master RECEIVER mode.

HS	RS	ACK	STOP	START	RUN	Operations
0	-	0	0	0	1	RECEIVE operation with negative ACK. Master remains in RECEIVE mode
0	-	-	1	0	0	STOP condition
0	-	0	1	0	1	RECEIVE followed by STOP condition
0	-	1	0	0	1	RECEIVE operation. Master remains in RECEIVER mode



HS	RS	ACK	STOP	START	RUN	Operations
0	-	1	1	0	1	Illegal command
0	1	0	0	1	1	REPEAT START condition followed by RECEIVE operation with negative ACK. Master remains in RECEIVER mode
0	1	0	1	1	1	REPEAT START condition followed by RECEIVE and STOP conditions
0	1	0	1	1	1	REPEAT START condition followed by RECEIVE. Master remains in RECEIVER mode
0	0	-	0	1	1	REPEAT START condition followed by SEND. Master remains in TRANSMITTER mode.
0	0	-	1	1	1	REPEAT START condition followed by SEND and STOP conditions

All other control-bit combinations not included in three tables above are NOP. In Master RECEIVER mode, STOP should be generated only after data negative ACK executed by Master or address negative ACK executed by slave. Negative ACK means SDA is pulled low when the acknowledge clock pulse is generated.

I2CMTO (0xC3) I2CTime Out Control Register R/W 00000000

	7	6	5	4	3	2	1	0		
RD	I2CMTOF		I2CMTO[6-0]							
WR	I2CMTOEN		I2CMTO[6-0]							
Ľ	2CMTOEN 2CMTOF 2CMTO[6-0]	I2CM This issue I2CM The T	d. Time Out Se	ag n a timeout oc etting t to (I2CMTO[CM CLEAR c			

5.16 Checksum/CRC Accelerator

To enhance the performance, a hardware Checksum/CRC Accelerator is included and closely coupled with CPU. This provides the most used checksum and CRC operation for 8/16/24/32-bit data width. For 8-bit data, one SYSCLK cycle is used. For 16-bit data, two SYSCLK cycles are used. For 32-bit data, four SYSCLK cycles are used.

	<u> </u>			<u> </u>				
	7	6	5	4	3	2	1	0
RD	DWIDT	FH[1-0]	REVERSE	NOCARRY	SEED	-	-	BUSY
WR	DWIDT	FH[1-0]	REVERSE	NOCARRY	SEED	C	RCMODE[2-0	D]
	NIDTH[1-0]	00 – 01 – 10 – 11 – Reve REV REV REV The bit, a REV alwa	set the input erse Input MS ERSE=0 is for ERSE=1 is for reverse order nd REVERSI ERSE=0 doe ys holds MSE		e nce erations. eration. he data width DATA[0] holds itput result an always holds	s MSB, and C d SEED orde LSB.	CDATA[31] h	olds LSB.
		DV	VIDTH	REVER	SE=0		REVERSE=	1
			0 C	RCIN[7-0] = 0	CDATA[7-0]	CRCIN	N[7-0] = CCDA	ATA[0-7]

CCCFG (0xA078) Checksum/CRC Accelerator Configuration Register R/W (0x00)



	DWIDTH	REVERSE=0	REVERSE=1			
	1	CRCIN[15-0] = CCDATA[15-0]	CRCIN[15-0] = CCDATA[0-15]			
	2	CRCIN[23-0] = CCDATA[23-0]	CRCIN[23-0] = CCDATA[0-23]			
	3	CRCIN[31-0] = CCDATA[31-0]	CRCIN[31-0] = CCDATA[0-31]			
NOCARRY	NOCARRY=0 uses the previous carry result for the new result. NOCARRY=1 discard previous carry result.					
SEED Seed Entry SEED=1 results in writing into CCDATA as the SEED value. SEED=0 for normal data inputs. The MSB/LSB ordering of SEED entry from CCDATA is not affected by RE\						
CRCMODE[2-0]	000 - Accele 001 - 8-bit C 010 - 32-bit 0 011 - CRC-1 X16+X15+ 100 - CRC-1 X16+X12+ 101 - CRC-3 X32+X26+ 110 - Reserve	Checksum 6 (IBM 0x8005) X2+1 6 (CCITT 0x1021) X5+1 52 (ANSI 802.3 0x104C11DB7) C23+X22+X16+X12+X11+X10+X8-				

The first step for the programmer is to set the CRCMODE[2-0] for the Checksum or CRC operation and then write "111" to CRCMODE[2-0] to reset the Checksum/CRC states and restore the default seed value (for checksum, seed value=0x00 or 0x00000000, for CRC seed value = 0xFFFF or 0xFFFFFFF).

BUSY

CRC Status

BUSY=1 indicates the results is not yet completed. Since only up to two cycles are used to calculate the Checksum or CRC, there is no need to check BUSY status before the next data entry and reading the results.

CCDATA registers are the data I/O port for Checksum/CRC Accelerator. For 8-bit data width only CCDATA[7-0] should be used. For data width wider than 8-bit, high byte should always be written first, and writing the low byte (CCDATA0) completes the data entry and starts the calculations. When SEED=1, the data written goes to CS or CRC seed value. The SEED value entry bit ordering is not affected by REVERSE setting. The result of accelerator can be directly read out from CCDATA registers also not affected by REVERSE setting.

CCDATA0 (0xA07C) Checksum/CRC Data Register 0 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		CCDATA[7-0]								
WR		CCDATA[7-0]								

CCDATA1 (0xA07D) Checksum/CRC Data Register 1 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		CCDATA[15-0]								
WR		CCDATA[15-0]								

CCDATA2 (0xA07E) Checksum/CRC Data Register 2 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		CCDATA[23-16]								
WR		CCDATA[23-16]								



CCDATA3 (0xA07F) Checksum/CRC Data Register 3 R/W 00000000

	7	6	5	4	3	2	1	0		
RD		CCDATA[31-24]								
WR		CCDATA[31-24]								

5.17 Break Point and Debug Controller

The CPU core also includes a Break Point Controller for software debugging purposes and handling exceptions. Program Counter break point triggers at PC address matching, and there are seven PC matching settings available. Single Step break point triggers at interaction return from an interrupt routine.

Upon the matching of break point conditions, the Break Point Controller issues BKP Interrupt for handling the break points. The BKP Interrupt vector is located at 0x7080. Upon entering the BKP ISR (Break Point Interrupt Service Routine), all interrupts and counters (WDT, T0, T1, and T2) are disabled. To allow further interrupts and continuing counting, the BKP ISR must be enabled. At exiting, the BKP ISR setting must be restored to resume normal operations.

BPINTF (0xA0E0) Break Point Interrupt Flag Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	STEP_IF	-	-	-	-	-	PC2IF	PC1IF
WR	STEP_IF	-	-	-	-	-	PC2IF	PC1IF

This register is for reading the Break Points interrupt flags.

STEP_IF

This bit is set when the Break Point conditions are met by a new instruction fetching from an interrupt routine. This bit must be cleared by software.

PC2IF – PC1IF

These bits are set when Break Point conditions are met by PC2 – PC1 address. These bits must be cleared by software.

BPINTE (0xA0E1) Break Point Interrupt Enable Register R/W (0x00) TB Protected

	7	6	5	4	3	2	1	0
RD	STEP_IE	-	-	-	-	-	PC2IE	PC1IE
WR	STEP_IE	-	-	-	-	-	PC2IE	PC1IE

This register controls the enabling of individual Break Points interrupt.

STEP_IE Set this bit to enable Single Step event break point interrupt.

PC2IE – PC1IE Set these bits to enable PC2 to PC1 address match break point interrupts.

BPINTC (0xA0E2) Break Point Interrupt Control Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	-	-	-	-	-	-	-	-
WR	-	-	-	-	-	-	-	-

This register is reserved for other applications.

BPCTRL (0xA0E3) DBG and BKP ISR Control and Status Register R/W (0xFC)

	7	6	5	4	3	2	1	0
RD	DBGINTEN	DBGWDTEN	DBGT2EN	DBGT1EN	DBGT0EN	-	-	DBGGST
WR	DBGINTEN	DBGWDTEN	DBGT2EN	DBGT1EN	DBGT0EN	-	-	DBGGST

When entering the DBG or BKP ISR (Interrupt Service Routine), all interrupts and timers are disabled. The enabled bits are cleared by hardware reset in this register. As the interrupts and timers are disabled, the ISR can process debugging requirements in a suspended state. If a specific timer should be kept active, it must be enabled by ISR after ISR entry. Before the exit of DBG and BKP ISR, the control bits should be enabled to allow the timers to resume operating. This register should be modified only in Debug ISR.

DBGINTEN

Set this bit to enable all interrupts (except WDT interrupt). This bit is cleared automatically at the entry of DBG and BKP ISR. Set this bit to allow ISR to be further



	interrupted by other interrupts. This is sometimes necessary if DBG or BKP ISR needs to use UART or I ² C, for example.
DBGWDEN	Set this bit to allow WDT counting during the DBG and BKP ISR. This bit should always be set before exiting the ISR.
DBGT2EN	Set this bit to allow T2 counting during the DBG and BKP ISR. This bit should always be set before exiting the ISR. This bit only controls the counting but not T2 interrupt.
DBGT1EN	Set this bit to allow T1 counting during the DBG and BKP ISR. This bit should always be set before exiting the ISR. This bit only controls the counting but not T1 interrupt.
DBGT0EN	Set this bit to allow T0 counting during the DBG and BKP ISR. This bit should always be set before exiting the ISR. This bit only controls the counting but not T0 interrupt.
DBGST	This bit indicates the DBG and BKP ISR status. It is set to 1 when entering DBG and BKP ISR. It should be cleared when exiting the DBG and BKP ISR. Checking this bit allows other interrupt routines to determine whether it is a sub-service of the DBG and BKP ISR.

PC1AL (0xA0F0) Program Counter Break Point 1 Low Address Register R/W (0x00)

	7	7 6 5 4 3 2 1 0								
RD	PC1AL[7-0]									
WR		PC1AL[7-0]								

This register defines the PC low address for PC match break point 1.

PC1AH (0xA0F1) Program Counter Break Point 1 High Address Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	PC1AH[7-0]							
WR				PC1A	H[7-0]			

This register defines the PC high address for PC match break point 1.

PC1AT (0xA0F2) Program Counter Break Point 1 Top Address Register R/W (0x00)

	7	7 6 5 4 3 2 1 0							
RD	PC1AT[7-0]								
WR		PC1AT[7-0]							

This register defines the PC top address for PC match break point 1. PC1AT:PC1HT:PC1LT together form a 24 bit compare value of break point 1 for Program Counter.

PC2AL (0xA0F4) Program Counter Break Point 2 Low Address Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	PC2AL[7-0]							
WR				PC2A	L[7-0]			

This register defines the PC low address for PC match break point 2.

PC2AH (0xA0F5) Program Counter Break Point 2 High Address Register R/W (0x00)

	7	7 6 5 4 3 2 1 0							
RD	PC2AH[7-0]								
WR		PC2AH[7-0]							

This register defines the PC high address for PC match break point 2.

PC2AT (0xA0F6) Program Counter Break Point 2 Top Address Register R/W (0x00)

	7	7 6 5 4 3 2 1 0								
RD	PC2AT[7-0]									
WR		PC2AT[7-0]								

This register defines the PC top address for PC match break point 2. PC2AT:PC2HT:PC2LT together form a 24-bit



compare value of PC break point 2 for Program Counter.

Host or program can obtain the status of the break point controller through the current break point address and next PC address register. DBPCID[23-0] contains the PC address of just executed instruction when the break point occurs. DBNXPC[23-0] contains the next PC address to be executed when the breakpoint occurs, therefore, it is usually exactly the same value as the break pointer setting.

DBPCIDL (0xA098) Debug Program Counter Address Low Register RO (0x00)

					. ,			
7	6	5	4	3	2	1	0	
			DBPC	ID[7-0]				
				-				
) 0H (0xA099) [Debug Progra	am Counter	Address Higl	n Register R	O (0x00)			
7	6	5	4	3	2	1	0	
			DBPCI	D[15-8]				
				-				
DT (0xA09A) I	Debug Progra	am Counter	Address Top	Register R	O (0x00)			
7	6	5	4	3	2	1	0	
			DBPCI	D[23-16]				
				-				
XL (0xA09B)	Debug Prog	ram Counter	Next Addres	s Low Regi	ster RO (0x00))		
7	6	5	4	3	2	1	0	
			DBPCI	NX[7-0]				
				-				
XH (0xA09C)	Debug Prog	ram Counter	Next Addres	ss High Reg	ister RO (0x0	0)		
7	6	5	4	3	2	1	0	
			DBPCN	IX[15-8]				
				-				
XT (0xA09D)	Debug Prog	ram Counter	Next Addres	s Top Regis	ster RO (0x00)		
7	6	5	4	3	2	1	0	
			DBPCN	X[23-16]				
				-				
TRL (0xA09E) Single Step	Control Ena	ble Register	R/W (0x00)				
7	6	5	4	3	2	1	0	
			STEPC	TRL[7-0]	1			
	DH (0xA099) I 7 DT (0xA09A) I 7 XL (0xA09A) I 7 XL (0xA09B) 7 XH (0xA09C) 7 XT (0xA09C) 7 XT (0xA09D) 7	DH (0xA099) Debug Progra 7 6 DT (0xA09A) Debug Progra 7 6 XL (0xA09B) Debug Progra 7 6 XL (0xA09B) Debug Progra 7 6 XL (0xA09B) Debug Progra 7 6 XH (0xA09C) Debug Progra 7 6 XT (0xA09D) Debug Progra 7 6 XT (0xA09D) Debug Progra 7 6 Image: Construct of the state of the sta	PH (0xA099) Debug Program Counter 7 6 7 6 9T (0xA09A) Debug Program Counter 7 6 7 7 6 5 7 7 6 5	DBPC DH (0xA099) Debug Program Counter Address Higl 7 6 5 4 DBPCI DT (0xA09A) Debug Program Counter Address Top 7 6 5 4 DBPCI XL (0xA09B) Debug Program Counter Next Address 7 6 5 4 DBPCI XI (0xA09C) Debug Program Counter Next Address 7 6 5 4 DBPCI XI (0xA09C) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN XI (0xA09D) Debug Program Counter Next Address 7 6 5 4 DBPCN	DBPCID[7-0] 	DBPCID[7-0] DBPCID[7-0] - DBPCID[7-0] - DBPCID[7-0] - DBPCID[7-0] - DBPCID[17-0] 7 6 5 4 3 2 DBPCID[15-8] - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) 7 6 7 6 5 4 3 2 DBPCID[23-16] - XL (0xA09B) Debug Program Counter Next Address Low Register RO (0x00 7 6 5 4 3 2 DBPCNX[7-0] - XH (0xA09C) Debug Program Counter Next Address High Register RO (0x00 7 6 5 4 3 2 DBPCNX[15-8] - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00 7 6 5 4 3 2 <td colspa<="" td=""><td>DBPCID[7-0] DBPCID[7-0] DBPCID[7-0] OH (0xA099) Debug Program Counter Address High Register RO (0x00) 7 6 5 4 3 2 1 DBPCID[15-8] - - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XL (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XH (0xA09C) Debug Program Counter Next Address High Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - T 6 5 4 3 2 1 DBPCNX[15-8] - T 6 5 4 3 2 1 DBPCNX[23-</td></td>	<td>DBPCID[7-0] DBPCID[7-0] DBPCID[7-0] OH (0xA099) Debug Program Counter Address High Register RO (0x00) 7 6 5 4 3 2 1 DBPCID[15-8] - - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XL (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XH (0xA09C) Debug Program Counter Next Address High Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - T 6 5 4 3 2 1 DBPCNX[15-8] - T 6 5 4 3 2 1 DBPCNX[23-</td>	DBPCID[7-0] DBPCID[7-0] DBPCID[7-0] OH (0xA099) Debug Program Counter Address High Register RO (0x00) 7 6 5 4 3 2 1 DBPCID[15-8] - - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09A) Debug Program Counter Address Top Register RO (0x00) - - - - DT (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XL (0xA09B) Debug Program Counter Next Address Low Register RO (0x00) - - - - XH (0xA09C) Debug Program Counter Next Address High Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - XT (0xA09D) Debug Program Counter Next Address Top Register RO (0x00) - - - - T 6 5 4 3 2 1 DBPCNX[15-8] - T 6 5 4 3 2 1 DBPCNX[23-

To enable single step debugging, STEPCTRL must be written with value 0x96.

5.18 Debug I²C Port

WR

The I²C Slave 2 (I2CS2) can be configured as the debug and ISP port. This is achieved by assigning a predefined debug ID for the I²C Slave address. When a host issues an I²C access to this special address, a DBG interrupt is generated. DBG Interrupt has the highest priority. The DBG interrupt vector is located at 0x70C0. DBG ISR is used to communicate with the host and is usually strongly associated with BKP ISR.

STEPCTRL[7-0]



SI2CDBGID (0xA09F) Slave I²C Debug ID Register R/W (0x36) TB Protected

	7	6	5	4	3	2	1	0	
RD	DBGSI2C2EN			S	2CDBGID[6:	0]			
WR	DBGSI2C2EN		SI2CDBGID[6:0]						
D	BGSI2C2EN		DBGSI2C2EN=1 enables I2CS2 as debug port. When I2CS2 receives an access of I ² C address matching SI2CDBGID[6:0], a debug interrupt is generated.						

SI2CDBGID[6:0]

Slave I²C ID address for debug function.

5.19 Data SRAM ECC Handling

The data SRAM (IRAM and XRAM) is configured as 2048 x 13-bit. An 8:5 ECC encoder and decoder are implemented to check the SRAM data. ECC check is through hardware and performed automatically. It can correct 1-bit error in each byte and detect 2-bit error in each byte. All generation and checking are done in hardware. It is strongly recommended all SRAM data should be initialized at power-on or after reset if ECC is enabled to avoid initial ECC error. If ECC encounters either an uncorrectable error, hardware will latch the address and triggers an interrupt. Software needs to examine the severity of data corruption and determine appropriate actions. Please also note, switching between ECC and non-ECC mode, all the data in SRAM will be corrupted, and thus, require re-initialization. It is strongly suggested keeping ECC enabled for best reliability as well as noise immunity.

DECCCFG (0xA02D) Data ECC Configuration Register R/W (0x80) TB Protected
--

	7	6	5	4	3	2	1	0	
RD	DECCEN	-	- DECCIEN2 DECCIEN1 DECCIF2 DECCIF1						
WR	DECCEN	-	- DECCIEN2 DECCIEN1 DECCIF2 DECCIF1						
D D D	ECCEN ECCIEN2 ECCIEN1 ECCIF2 ECCIF1	Data Data DEC erro softv Data DEC DEC	a ECC Correct a ECC Uncorre CIF2 is set to r. DECCIF2 is ware. a ECC Correct CIF1 is set to	ectable Error I able Error Inte ectable Error I 1 by hardwar set independe able Error Inte 1 by hardwar dependent of	errupt Enable nterrupt Flag e when readin ent of DECCII errupt Flag e when readin	ng SRAM end EN2. DECCIF ng SRAM end	2 needs to be	e cleared by ectable error.	

If a correctable error is encountered, the data will be automatically corrected. To prevent further corruption, software upon DECIF1 interrupt should rewrite the data into the SRAM.

DECCADL (0xA02E) Data ECC Configuration and Address Register Low RO (0x00)

	7	6	5	4	3	2	1	0
RD				DECC	AD[7-0]			
WR					-			

DECCADH (0xA02F) Data ECC Configuration and Address Register High R/W (0x00)

	7	6	5	4	3	2	1	0			
RD	DECCAD[15-8]										
WR	-										

DECCAD[15-0] records the address of ECC fault when data SRAM ECC error occurs. It is read-only and reflects the error address that causes DECCIF to be set. If DECCIF is set and not cleared, DECCAD will not be updated if further error is detected.

5.20 Program ECC Handling

The program code stored in e-Flash has built-in ECC checking. The e-Flash is in 16-bit width, and when read by CPU program space accesses, the lower LSB 8-bit is read for instruction and the upper MSB 8-bit contains the ECC value of the LSB 8-bit. The ECC is nibble based, [15-12] is ECC for data [7-4], and [11-8] is ECC for data [3-0]. Four bits ECC for four bits data allows one bit error correction and two bits error detection. This means for an 8-



bit code stored, 2-bit error correction is possible, and this greatly increases the reliability of the overall program robustness.

During program fetch and execution, ECC is performed simultaneously by hardware. If any ECC correctable error is detected, the value fetched is corrected, and optionally a PECCIEN1 interrupt can be generated. If any ECC non-correctable error is detected, two options can be configured, either a PECCIEN2 interrupt can be generated, or software reset can be generated. In both PECCIEN interrupt, the address of the error encountered is latched in PECCADL[15-0].

PECCCFG (0xA00D) Program ECC Configuration Register R/W (0x80) TB Protected

	7	6	5	4	3	2	1	0
RD	-	-	PECCIEN2	PECCIEN1	-	-	PECCIF2	PECCIF1
WR	-	-	PECCIEN2	PECCIEN1	-	-	PECCIF2	PECCIF1
P P	ECCIEN2 ECCIEN1 ECCIF2 ECCIF1	Prog Prog PEC uncc be cl Prog	ram ECC Co ram ECC Un CIF2 is set to prrectable erro eared by soft ram ECC Co	rrectable Erro correctable El 1 by hardwal or. PECCIF2 is ware. rrectable Erro	rror Interrupt F r Interrupt En rror Interrupt F re when progr s set indepen r Interrupt Fla re when progr	able Flag ram fetching fi dent of PECC g	IEN2. PECCI	F2 needs to
PECCIF1 is set to 1 by hardware when program fetching from e-Flash encounte correctable error. PECCIF1 is set independent of PECCIEN1 and PECCIF1 nee be cleared by software.								

PECCADL (0xA00E) Program ECC Fault Address Register Low RO (0x00)

	7	6 5		4	3	2	1	0			
RD		PECCAD[7-0]									
WR					-						

PECCADLH(0xA00F) Program ECC Fault Address Register High R/W (0x00)

	7	6	5	4	3	2	1	0			
RD	PECCAD[15-8]										
WR	-										

PECCAD[15-0] records the address of ECC fault when Flash ECC error occurs. It is read-only and reflects the last error address.

5.21 Memory and Logic BIST Test

BSTCMD (0xA016) SRAM Built-In and Logic Self Test R/W (0x00) TB Protected

	7	6 5 4		4	3	2	1	0
RD		MODI	E[3-0]		BST	-	FAIL	FINISH
WR		MODI	E[3-0]			BSTCN	/ID[3-0]	
Μ	ODE[3-0]	0000 0001 0010 0011 0100 0101 0111 1000 1001 1010) – Reserved – Reserved	ode IST BIST	·			



	1101 – Reserved 1110 – Reserved
	1111 – Reserved MODE[3-0] is cleared only by POR and RSTN. Software can read this setting along with the Pass/Fail status to determine which BIST was performed and its result even after a software reset.
BST	BIST Status
	BST is set to 1 by hardware when BIST in ongoing.
FAIL	BIST Test Fail Flag
	FAIL is set to 1 by hardware when BIST error has occurred. FAIL is cleared to 0 by hardware when a new BIST command is issued.
FINISH	BIST Completion Flag
	FINISH is set to 1 by hardware when BIST controller finishes the test. FINISH is cleared to 0 by hardware when a new BIST command is issued.
BSTCMD[3-0]	Memory BIST Command
	Writing BSTCMD[3-0] with value 4b'0101 causes the BIST controller to perform BIST. Writing BSTCMD[3-0] with value 4b'1010 causes the BIST controller to perform BIST, and after BIST is completed, it automatically generates a software reset.
	Writing BSTCMD[3-0] with value 4b'0000 causes FAIL and FINISH bits to be cleared to 0.
	Any other value will either have no effect or abort any ongoing BIST.

After the BSTCMD is issued, CPU is paused until BIST is completed. And any BIST operations will result in the state of CPU in undefined states, and the content of the SRAM undefined. Therefore, it is highly recommended that a software reset or initiation should be performed after any BIST operation. Please also note that MODE[3-0], FINISH, FAIL bits are not cleared by software resets.

TSTMON (0xA014) Test Monitor Flag R/W (0x00) TB Protected

	7	6	5	4	3	2	1	0			
RD		TSTMON[7-0]									
WR		TSTMON[7-0]									

TSTMON register stores temporary status and is initialized by power-on reset only.

5.22 System Clock Monitoring

SYSCLK in normal running mode is monitored by SOSC32KHz (32KHz). If SYSCLK is not present in normal mode for four SOSC32KHz cycles, a hardware reset is triggered.

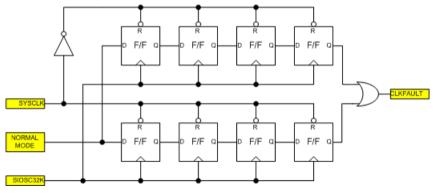


Figure 5-10 System Clock Monitor diagram

The clock monitoring is default turned off after reset.

5.23 Reset

There are several reset sources and includes both software resets and hardware resets. Software resets include command reset, WDT reset and ECC error reset. Hardware resets include power-on reset (low voltage detect on VDDC), LVD reset (low voltage detect on VDD), SYSCLK monitor reset, and external RSTN reset. Software reset only restores some registers to default values, and hardware reset restores all registers to their default values.



External RSTN reset is filtered so that low going glitches on RSTN with less than 4msec duration are ignored. All other hardware resets, once conditions are met, will be extended by 4 msec when exiting reset. The reset scheme described above is shown in the following diagram.

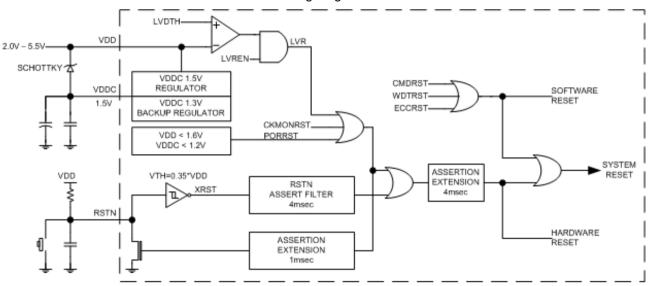


Figure 5-11 Reset block diagram

RSTCMD (0xA017) Reset Command Register R/W 0x00 TB Protected

	<u> </u>											
	7	6	5	4	3	2	1	0				
RD	RSTCKM	RSTECC	-	-	CKMRF	ECCRF	WDTRF	CMDRF				
WR	RSTCKM	RSTECC	-	CLRF	RSTCMD[3-0]							
R	STCKM	Rese	et Enable for	Clock Monitor	r Fault							
R	STECC	RENCKM=1 enables reset after clock fault detection. RSTCKM is cleared to 0 after any reset. Default RSTCKM is 0. CC Reset Enable for Uncorrectable Code Fetch ECC Error RSTECC=1 enables reset at e-Flash code fetch ECC error. Default RSTECC is 0.										
С	CLRF Clear Reset Flag											
	KMRF	Writi clear Cloc CKM	 Writing 1 to CLRF will clear CKMRF, ECCRF, WDTRF, and CMDRF. It is self-cleared. Clock Monitor Fault Reset Flag CKMRF is set to 1 by hardware when a clock fault reset has occurred. CKMRF is not cleared by reset except power-on reset. 									
E	CCRF	ECC	ECC Error Reset Flag ECCRF is set to 1 by hardware when an ECC error reset has occurred. ECCRF is cleared to 0 when writing CLRF=0. ECCRF is not cleared by reset except power-on									
W	/DTRF		Reset Flag	1 by hardware	e when WTRF	, WT1RF, or	WT2RF is set					
R	STCMD[3-0]	Softv Writi softv	WDTRF is set to 1 by hardware when WTRF, WT1RF, or WT2RF is set. Software Reset Command Writing RSTCMD[3-0] with consecutive 4b'0101, 4b'1010 sequences will cause a software reset. Any other value will clear the sequence state. These bits are write- only and self-cleared.									

Note: Bit 7 RSTCKM and bit 6 RSTECC can't be read.



6. Flash Controller

The flash controller connects the CPU to the on-chip embedded FLASH memory. The FLASH memory functions as the program storage as well as non-volatile data storage. The program access of FLASH does not require any special attention. When an ECC error during program fetch occurs, it causes ECC interrupt or reset.

When FLASH is used as data storage, the software issues commands to the FLASH controller through the XFR registers. And when the FLASH controller processes these commands, CPU is held idle until the command is completed. There is a time-out mechanism for holding CPU in idle to prevent operations hang up.

From FLASH controller point of view, the embedded Flash is always in 16-bit width with no distinction between ECC and data information. For code storage through FLASH controller, ECC byte (upper MSB 8-bit) must be calculated by software. During the read command, ECC is detected but not corrected, the raw content is loaded into FLSHDAT[15-0]. If an ECC error is detected, FAIL status is set after the read command execution.

The e-Flash contains 64 pages (also referred to as Sector), and each page is 512x16. It also contains two IFB (Information Blocks) pages. In Flash operation, the erase command only operates on a page base.

	, , ,				0	,				
	7	6		5	4	3		2	1	0
RD	WRVFY	BUSY	F	AIL	CMD4	CMI	D3	CMD2	CMD1	CMD0
WR		CYC[2-0]			CMD4	CMI	D3	CMD2	CMD1	CMD0
В	VRVFY BUSY FAIL	com becc Flas the Con any exec	npares omes sh con Flash nmano reaso cution	s it with w 0. It is re nmand is Read, W d Executi on. It is re after iss	hich shoul set to 1 by in process (rite, or Sec on Result. commende uing a com	d be writte hardware sing. This ctor Erase It is set if ed that the mand to	en to the e when a bit indica e and oth the prev e prograr the Flash	flash. If th nother ISP ates that FI er comma ious comm m should v n controller	reads back th ere is a misma command is ash Controlle nds are not va nand executio erify the comr . It is not clea	atch, this bit executed. r is executing alid. n fails due to mand red by
reading, but it will be cleared when a new command is issued. Possible causes of FAIL include address out of range, address falling into the protected region, and ECC error for read.CYC[2-0]Flash Command Time Out CYC[2-0] defines command time out cycle count. The cycle period is defined by ISPCLK, which is SYSCLK/256/(ISPCLKF[7-0]+1). The number of cycles is tabulated as follows.CYC[2-0]WriteErase										
		0	0	0	55			5435		
			0	0	1				5953	
			0	1	0		60		6452	
			0	1			65 69		6897	
					1					
			1	0	0		75		7408	
			1	0	1		80		7906	
			1	1	0		85		8404	
			1	0	0		89		8889	
С	CMD4 – CMD() Flas The	sh Cor se bit ne follo	mmand s define d		for the F	lash cont	roller. The	valid commai xecuted but re	
		C	MD4	CMD3	CMD2	CMD1	CMD0		Command	
			1	0	0	0	0	Main Me	emory Read	
			0	1	0	0	0	Main Me	emory Sector	Erase
			~	<u> </u>	4	0	-		14/ 1/	

0

0

0

0

1

Main Memory Write



CMD4	CMD3	CMD2	CMD1	CMD0	Command
0	0	0	1	0	IFB Read
0	0	0	0	1	IFB Write
0	0	0	1	1	IFB Sector Erase
1	0	0	1	0	-

IFB1 contains manufacture data and user OTP, and therefore, IFB write commands are limited to IFB1 (0x0040-0x01FF) and IFB2. IFB Sector Erase is limited to IFB2.

For READ operations, FLSHDATH is the raw data, which is ECC code and FLSHDATL is ECC corrected data. If there is an ECC error, the FAIL status will be set, and corresponding ECC flags, PECCIF1 or PECCIF2 will be set according to the error condition.

FLSHDATL (0xA020) Flash Controller Data Register R/W (0x00)

	7	6	5	4	3	2	1	0				
RD		Flash Read Data Register DATA[7-0]										
WR		Flash Write Data Register DATA[7-0]										

FLSHDATH (0xA021) Flash Controller Data Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		Flash Read Data Register DATA[15-8]								
WR		Flash Write Data Register DATA[15-8]								

FLSHADL (0xA022) Flash Controller Low Address Data Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		Flash Address Low Byte Register ADDR[7-0]								
WR		Flash Address Low Byte Register ADDR[7-0]								

FLSHADH (0xA023) Flash Controller High Address Data Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		Flash Address High Byte Register ADDR[15-8]								
WR			Flash Add	lress High By	te Register Al	DDR[15-8]				

FLSHECC (0xA024) Flash ECC Accelerator Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		ECC[7-0]							
WR		DATA[7-0]							

FLSHECC aids the calculation of ECC value of an arbitrary 8-bit data. The data is written to FLSHECC, and its corresponding ECC value can be read out from ECC.

ISPCLKF (0xA026) Flash Command Clock Scaler R/W (0x25)

	7	6	5	4	3	2	1	0		
RD		ISPCLKF[7-0]								
WR		ISPCLKF[7-0]								

ISPCLKF[7-0] configures the clock time base for generation of Flash erase and write timing. ISPCLK = SYSCLK * (ISPCLKF[7-0]+1)/256. For correct timing, ISPCLK should be set to approximately at 2MHz.

FLSHPRT0 (0xA030) Flash Controller Zone Protection Register 0 R/W (0xFF)

	7	6	5	4	3	2	1	0			
RD		FLSHPRT[7-0]									
WR		FLSHPRT[7-0]									



LSHPF	RT1 (0xA031)	Flash Contro	oller Zone Pr	rotection Reg	gister 1 R/W	(0xFF)		
	7	6	5	4	3	2	1	0
RD				FLSHP	RT[15-8]			
WR				FLSHPF	RT[15-8]			
LSHPF	RT2 (0xA032)	Flash Contro	oller Zone Pı	rotection Reg	gister 2 R/W	(0xFF)		
	7	6	5	4	3	2	1	0
RD				FLSHPR	T[23-16]			
WR				FLSHPR	T[23-16]			
LSHPF	RT3 (0xA033)	Flash Control	oller Zone Pr	rotection Reg	gister 3 R/W	(0xFF)		
	7	6	5	4	3	2	1	0
RD				FLSHPR	T[31-24]			
WR				FLSHPR	T[31-24]			
LSHPF	RT4 (0xA034)	Flash Contr	oller Zone Pi	otection Reg	jister 4 R/W	(0xFF)		
	7	6	5	4	3	2	1	0
RD				FLSHPR	T[39-32]			
WR				FLSHPR	T[39-32]			
LSHPF	RT5 (0xA035)	Flash Contr	oller Zone Pi	otection Reg	gister 5 R/W	(0xFF)		
	7			4		2	1	
				FLSHPR	T[47-40]			
WR				FLSHPR	T[47-40]			
LSHPF	RT6 (0xA036)	Flash Contro	oller Zone Pi	rotection Reg	gister 6 R/W	(0xFF)		
	7			4		2	1	
				FLSHPR	T[55-48]			
WR				FLSHPR	T[55-48]			
LSHPF	RT7 (0xA037)	Flash Contro	oller Zone Pi	rotection Reg	jister 7 R/W	(0xFF)		
	7	6	5	4	3	2	1	0
RD				FLSHPR	T[63-56]			
WR				FLSHPR	T[63-56]			

TESHER I partitions the total code space of 64K into 64 uniform 1K zones for protection. If the corresponding bit in the FLSHPRT is 0, the zone protection is on. All bits in FLSHPRT are set to 1 by any reset. A "1" state corresponds to unprotected state. A bit can only be written to "0" by software and cannot be set to "1". When a bit is "0", the protection is on and disallows erasure or modifications. For content reliability, the user program should turn off the corresponding access after initialization as soon as possible.

FLSHPRT[31] FLSHPRT[30]	Flash Zone Protect 31 This bit protects area 0x7C00 – 0x7FFF Flash Zone Protect 30
	This bit protects area 0x7800 – 0x7BFF
FLSHPRT[4]	Flash Zone Protect 4
	This bit protects area 0x1000 – 0x13FF
FLSHPRT[3]	Flash Zone Protect 3
	This bit protects area 0x0C00 – 0x0FFF
FLSHPRT[2]	Flash Zone Protect 2
	This bit protects area 0x0800 – 0x0BFF
FLSHPRT[1]	Flash Zone Protect 1



FLSHPRT[0]

This bit protects area 0x0400 – 0x07FF Flash Zone Protect 0 This bit protects area 0x0000 – 0x03FF

Since there is only 32K code Flash, only FLSHPRT[31-0] is used.

FLSHPRTC (0xA027) Flash Controller Code Protection Register R/W 0x(00) TB Protected

	7	6	5	4	3	2	1	0	
RD		-							
WR		FLSHPRTC[7-0]							

This register further protects the code space (0x0000 - 0xFFFF). The protection is on after any reset. Software write of "55" into this register turns off protection. However, protection is maintained on until a wait time (approximately 300msec) has expired. The 300msec delay prevents any false action due to power or interface transient. Any write other than "55" will turn on the protection immediately. STAT indicates the protection, and STAT=1 indicates the protection is off, and STAT=0 indicates the protection is on.

To modify or erase the flash (not including IFB) both FLSHPRT and FLSHPRTC conditions need to be satisfied at the same time. IFB1's manufacturing data is always protected while user data can only be written "0". IFB2 are user application data and not protected.



7. <u>I²C Slave Controller 1 (I2CS1)</u>

The I²C Slave Controller 1 is a regular I²C Slave controller with enhanced functions such as clock-stretching and programmable hold time. These enhancements provide significant improvement in compatibilities. I2CS1 shares the SCL/SDA pins with the I2CM1. I2CS1 can also be configured to respond to two I²C addresses – I2CADR1 and I2CADR3. These two addresses can be enabled separately.

In receive mode, the controller detects a valid matching address and issues an ADDRMI interrupt. At the same time, the data bit on SDA line is shifted into the receive buffer. The RCBI interrupt is generated whenever a complete byte is received and is ready to be read from I2CSDAT. If for any reason, the software does not respond to RCBI interrupt in time (i.e., RCBI is not cleared), and a new byte is received, the controller either forces a NACK response on I²C (if CLKSTREN bit is not set) or by pulling and holding SDA low (if CLKSTREN bit is set) to stretch the SCL low duration to force the master into a wait state. In clock stretching mode, SCL is released when the software responds to RCBI interrupt and clears RCBI flag.

In transmit mode, the controller detects a valid matching address and issues an ADDRMI interrupt. At the same time, the data preloaded in the transmit data register through I2CSDAT is transferred to the transmit shift register and is serially shifted out onto SDA line. When this occurs, the controller generates a TXBI interrupt to inform the software that a new byte can be written into I2CSDAT. When the shift register is empty and ready for the next transmit, the slave controller checks if the new byte is written to the I2CSDAT. If TXBI is not cleared, it indicates a lack of new data and the slave controller holds SCL line low to stretch the current clock cycle if CLKSTREN is set. If the clock stretching is not enabled, the slave controller takes the old byte into the shift register and replies with NACK, and thus, causing data corruption. On the other hand, if the master returns the NACK after the byte transfer, this indicates the end of data to the I²C slave. In this case, the I²C slave releases the data line to allow the master to generate a STOP or REPEAT START.

The I²C slave controller also implements the input noise spike filter, and this is enabled by INFILEN bit in the I2CSCON register. The filter is implemented using digital circuit. When INFILEN is set, the spikes less than 1/2 SYSCLK period on the input of SDA and SCL lines are filtered out. If INFILEN is low, no input filtering is done. The following registers are related to I²C Slave Controller. The I²C slave controller uses SYSCLK to sample the SCL and SDA signals, therefore, the maximum allowable I²C bus speed is limited to SYSCLK/8 with conforming data setup and hold times. If setup and hold time cannot be guaranteed, then it is recommended the bus speed is limited to 1/40 SYSCLK.

	7	6	5	4	3	2	1	0			
RD	EADRWK	EADDRMI	ESTOPI	ERPSTARTI	ETXBI	ERCBI	CLKSTREN	EACKWK			
WR	EADRWK	EADDRMI	DDRMI ESTOPI ERPSTARTI ETXBI ERCBI CLKSTREN EACKWK								
E	ADRWK	Enat	Enable Address matched wakeup from SLEEP mode.								
E,	ADDRMI		RMI Interrupt								
				ADDRMI inter ² C slave recei			upt. This interr	rupt is			
F	STOPI	-	PI Interrupt E		ves a materin	ly address.					
<u> </u>	01011			STOPI interru	pt as the I ² C s	slave interrup	t.				
E	RPSTARTI	RPT			•	•	FARTI interrup	ot as the I ² C			
E.	ТХВІ		l Interrupt En	able bit							
-				w TXBI interru	pt as the I ² C	slave interrup	ot.				
E	RCBI		I Interrupt En								
				w RCBI interru	upt as the I ² C	slave interrup	ot.				
С	LKSTREN		k Stretching I		· · · ·						
				clock stretchii e defined in l ²			troller. Clock	stretching is			
							data written i				
							ching, and the				
		be loaded to transmit shift register. The programmer must write the same data again to the transmit buffer.									
E	ACKWK	1: Enable clock stretching during system wakeup from sleep and wait until system									
		wakeup completed and asks controller to send ACK to master.									
		0: Controller sends NACK when address is matched. Input Noise Filter Enable bit.									
IN	IFILEN	inpu		Enable bit.							

I2CSCON1A (0xEB) I2CS1 Configuration Register A R/W (0x00)



Set this bit to enable the input noise filter of SDA and SCL lines. When the filter is
enabled, it filters out the spike of less than 50nsec.STARTStart Condition.
This bit is set when the slave controller detects a START condition on the SCL and
SDA lines. This bit is not particularly useful as the start of transaction can be
indicated by address match interrupt. This read-only bit is cleared when STOP
condition is detected.

I2CSCON1B (0xAB) I2CS1 Configuration Register B R/W (0x00)

	7	6	5	4	3	2	1	0
RD	-	SADR3M	XMT	START	SDAFI	LT[1-0]	GDFL	T[1-0]
WR	I2CSRST	-	-	-	SDAFI	LT[1-0]	GDFL	T[1-0]
12	CSRST	Set t	lave Reset b his bit causes ed by hardwa	the Slave Co	ontroller to res	set all internal	state machine	e. It is self-
SARD3M Slave Address Match Flag bit. This bit is meaningful only when ADDRMI is set. SARD3M=0 indicates the received I ² C address matches with I2CSADR1. SARD3M=1 indicates the received I ² C address matches with I2CSADR3. This bit is cleared when ADDRMI is cleared.							1.	
XI	MT	This bit is set by the controller when the I^2C slave is in transmit operation; this bit is cleared when the I^2C slave controller is in receive operation.						
S	TART	This SDA indic	lines. This bi	t is not particuess match inte	ularly useful a	s the start of t	condition on th transaction ca cleared when	n be
SDAFLT[1-0] Delay for SDA input to satisfy SDA to SCL hold time 00 - 20ns RC filter delay 01 - 15ns RC filter delay 10 - 10ns RC filter delay 11 - 5ns RC filter delay								
GDFLT [1:0] Glitch filter for SCL and SDA input 00 - 20ns RC filter delay 01 - 15ns RC filter delay 10 - 10ns RC filter delay 11 - 5ns RC filter delay								

I2CSST1 (0xEC) I2CSA1 Status Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	ADRWKF	ADDRMI	STOPI	RPSTARTI	TXBI	RCBI	FIRSTBT	NACK	
WR	CLRWKF	CLRADMI	CLRSTOPI	CLRRPSTI	-	-	-	CLRNACK	
С	DRWKF LRWKF DDRMI	Address Matched Wakeup Flag Clear Address Matched Wakeup Flag (ADRWKF) Slave Address Matched Interrupt Flag bit This bit is set when the received address matches the address defined in I2CSADR1. If EADDMI is set, this generates an interrupt. This bit must be cleared by software.							
S	ΤΟΡΙ	This	bit is set whe	errupt Flag bi n the slave co t must be clea	ontroller detec		ondition on the	e SCL and	
R	PTSARTI	Repo This	eat Start Cond bit is set whe	dition Interrup In the slave co In this bit mu	t Flag bit ontroller detec	ts a REPEAT	START conc	lition on the	
T	XBI	Transmit Buffer Interrupt Flag This bit is set when the slave controller is ready to accept a new byte for transmit. This bit is cleared when new data is written into I2CSDAT register.							
R	CBI	Rece	eiver Buffer In	iterrupt Flag b	bit		-		



	This bit is set when the slave controller puts new data in the I2CSDAT and ready for software-reading. This bit is cleared after the software reads I2CSDAT.
FIRSTBT	This bit is set to indicate the data in the data register as the first byte received after address match. This bit is cleared after the second byte is received. The bit is read only and generated by the slave controller.
NACK	NACK Condition bit
	This bit is set when the host responds with NACK in the byte transaction. This bit is only meaningful for slave-transmit operation. If the master returns with NACK on the byte transaction, the slave does not upload new data into the shift register. And the slave transmits the old data again as the next transfer, and this re-transmission continues if NACK is repeated until the transmission is successful and returned with ACK. This bit is cleared when a new ACK is detected, or it can be cleared by software.

I2CSADR1 (0xED) I2CS1 Slave Address Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	I2CSEN1		I2CADDR[6-0]							
WR	I2CSEN1		ADDR1[6-0]							
12	CSEN1 CADDR[6-0] DDR1[6-0]	Rece	his bit to enal eived slave l ² (slave addres	C address	ve controller a	and ADDR1[6	6-0] for addres	ss matching.		

I2CSDAT1 (0xEE) I2CS1 Data Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		I ² C Slave Receive Data Register									
WR			I ² C	Slave Transr	nit Data Regi	ster					

I2CSADR3 (0x9E) I2CS1 2nd Slave Address Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	I2CSEN2	2	ADDR2[6-0]							
WR	I2CSEN	1	ADDR2[6-0]							
I2CSEN2 Set this bit to enable the I ² C slave controller and ADDR2[6-0] for address Please note that this can coexist with ADDR1.							s matching.			

ADDR2[6-0]

7-bit slave address 2.



8. <u>I²C Slave Controller 2 (I2CS2)</u>

The I²C Slave Controller 2 has dual functions – as a debug port for communication with host or as a regular I²C slave port. Both functions can coexist. I²C Slave 2 controller also supports the clock stretching functions.

The debug accessed by the host is through I²C slave address defined by SI2CSDBGID register and enabled by DBGSI2C2EN=1. When I2CS2 received this address match, a DBG interrupt is generated. This is described in the Debug and ISP sections. If DBGSI2C2EN=0, then I2CS2 functions as a regular I²C slave. The address of the slave is set by I2CSADR2 register. The MSB in I2CSADDR2 is the enable bit for the I²C slave controller and I2CSADR2[6-0] specifies the actual slave address.

In receive mode, the controller detects a valid matching address and issues an ADDRMI interrupt. At the same time, the data bit on SDA line is shifted into receive buffer. The RCBI interrupt is generated whenever a complete byte is received and is ready to be read from I2CSDAT. If for any reason, the software does not respond to RCBI interrupt in time (i.e., RCBI is not cleared), and a new byte is received, the controller either forces an NACK response on I²C (if CLKSTREN bit is not set) or by pulling and holding SDA low (if CLKSTREN bit is set) to stretch the SCL low duration to force the master into a wait state. In clock stretching mode, SCL is released when the software responds to RCBI interrupt and clears RCBI flag.

In transmit mode, the controller detects a valid matching address and issues an ADDRMI interrupt. At the same time, the data preloaded in the transmit data register through I2CSDAT is transferred to the transmit shift register and is serially shifted out onto SDA line. When this occurs, the controller generates a TXBI interrupt to inform the software that a new byte can be written into I2CSDAT. When the shift register is empty and ready for the next transmit, the slave controller checks if the new byte is written to the I2CSDAT. If TXBI is not cleared, it indicates lack of new data and the slave controller holds SCL line low to stretch the current clock cycle if CLKSTREN is set. If the clock stretching is not enabled, the slave controller takes the old byte into the shift register and replies with NACK, and thus, causes data corruption. On the other hand, if the master returns the NACK after the byte transfer, this indicates the end of data to the I²C slave. In this case, the I²C slave releases the data line to allow the master to generate a STOP or REPEAT START.

The I²C slave controller also implements the input noise spike filter, and this is enabled by INFILEN bit in the I2CSCON register. The filter is implemented using digital circuit. When INFILEN is set, the spikes less than 1/2 SYSCLK period on the input of SDA and SCL lines are filtered out. If INFILEN is low, no input filtering is done. The following registers are related to I²C Slave Controller. Also, the I²C slave controller uses SYSCLK to sample the SCL and SDA signals, and therefore, the maximum allowable I²C bus speed is limited to SYSCLK/8 with conforming data setup and hold times. If setup and hold time cannot be guaranteed, then it is recommended the bus speed is limited to 1/40 SYSCLK.

2CSCON2 (0XDB) 12CS2 Configuration Register R/W (0X00)											
	7	6	5	4	3	2	1	0			
RD	-	-	-	-	-	-	-	XMT			
WR	I2CSRST	EADDRMI	ESTOPI	ERPSTARTI	ETXBI	ERCBI	CLKSTREN	INFILEN			
12	I2CSRST I ² C Slave Reset bit										
_	Setting this bit causes the Slave Controller to reset all internal state machines. Clea this bit for normal operations. Setting this bit clears the I2CSADR2 (I ² C slave address x).										
E	ADDRMI	Set t	ADDRMI Interrupt Enable bit Set this bit to set ADDRMI interrupt as the I ² C slave interrupt. This interrupt is generated when I ² C slave receives a matching address.								
E	STOPI		PI Interrupt E	nable bit STOPI interru	pt as the I ² C s	slave interrup	t.				
El	RPSTARTI			upt Enable Bit RPSTARTI int		I ² C slave inte	errupt.				
E	ТХВІ		Interrupt En				pt as the I ² C s	lave			
EI	RCBI		I Interrupt En	able bit. Set t	his bit to allow	RCBI interru	upt as the I ² C	slave			
C	LKSTREN	Cloc conti If the	k Stretching I roller. Clock s clock stretch	stretching is an ning option is a	n optional feat enabled (for s	ture defined in lave I ² C), the	hing function on I ² C specifica data written in tching, and the	tion. nto transmit			

I2CSCON2 (0xDB) I2CS2 Configuration Register R/W (0x00)



	be loaded to transmit shift register. The programmer must write the same data again to the transmit buffer.
. <i></i>	
XMT	This bit is set by the controller when the I ² C slave is in transmit operation; this bit is
	clear when the I ² C slave controller is in receive operation.
INFILEN	Input Noise Filter Enable bit
	Set this bit to enable the input noise filter of SDA and SCL lines. When the filter is enabled, it filters out the spike of less than 50nsec.

I2CSST2 (0xDC) I2CS2 Status Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	FIRSTBT	ADDRMI	STOPI	RPSTARTI	ТХВІ	RCBI	START	NACK		
WR	-	ADDRMI	STOPI	RPSTARTI	HOLDT[3]	HOLDT[2]	HOLDT[1]	HOLDT[0]		
	IRSTBT	addr bit is Slave This I2CS	This bit is set to indicate the data in the data register as the first byte received after address match. This bit is cleared after the first byte of the transaction is read. The bit is read only and generated by the slave controller. Slave Address Match Interrupt Flag bit This bit is set when the received address matches the address defined in I2CSADR2. If EADDMI is set, this generates an interrupt. This bit must be cleared by software.							
S	STOPI	Stop This	Condition Int bit is set whe	errupt Flag bi n the slave co t must be clea	ontroller detec		ndition on the	SCL and		
	RPTSARTI	This SCL	Repeat Start Condition Interrupt Flag bit This bit is set when the slave controller detects a REPEAT START condition on the SCL and SDA lines. This bit must be cleared by software.							
Т	XBI	This This	bit is cleared	n the slave co when a new o	data is written			r transmit.		
R	CBI	This	bit is set whe	terrupt Flag b n the slave cong. This bit is	ontroller puts a					
S	START	This SDA indic	lines. This bi ated by addre	n the slave co t is not particu ess match inte ted.	larly useful a	s the start of t	ransaction ca	n be		
N	IACK	condition is detected. NACK Condition. This bit is set when the host responds with NACK in the byte transaction. This bit is only meaningful for slave-transmit operation. If the master returns with NACK on the byte transaction, the slave does not upload new data into the shift register. And the slave transmits the old data again as the next transfer, and this re-transmission continues if NACK is repeated until the transmission is successful and is returned with ACK. This bit is cleared when a new ACK is detected, or it can be cleared by software.						ACK on the er. And the mission s returned		
Н	IOLDT[3-0]	Thes betw time, must	se four bits de een SDA to S so the condi be met. For	fine the hold to SCL. The l^2C stion of "TEPP example, if the l be set to ≥ 3	specification r CLK*(HOLDT e peripheral c	equires for mi $[3:0]+3) \ge 30^{\circ}$	inimum of 300 Onsec hold tir	nsec hold ne" equation		

I2CSADR2 (0xDD) I2CS2 Slave Address Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	I2CSEN									
WR	I2CSEN		ADDR[6-0]							
	CSENT DDR[6-0]		his bit to enal slave addres	ble the l ² C sla s.	ve controller.					





I2CSDAT2 (0xDE) I2CS2 Data Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		I ² C Slave Receive Data Register									
WR		I ² C Slave Transmit Data Register									



9. EUART2 with LIN Controller (EUART2)

LIN-capable 16550-like EUART2 is an enhanced UART controller (EUART) with separate transmit and receive FIFO. Both transmit and receive FIFO are 15-bytes deep and can be parameterized for interrupt triggering. The addition of FIFO significantly reduces the CPU load to handle high-speed serial interface. Transmit FIFO and receive FIFO have respective interrupt trigger levels that can be set based on optimal CPU performance adjustment. The EUART2 also has a dedicated 16-bit Baud Rate generator, and thus, provides accurate baud rate under wide range of system clock frequency. The EUART2 also provides LIN extensions that incorporate message handling and baud-rate synchronization. The block diagram of EUART2 is shown in the following.

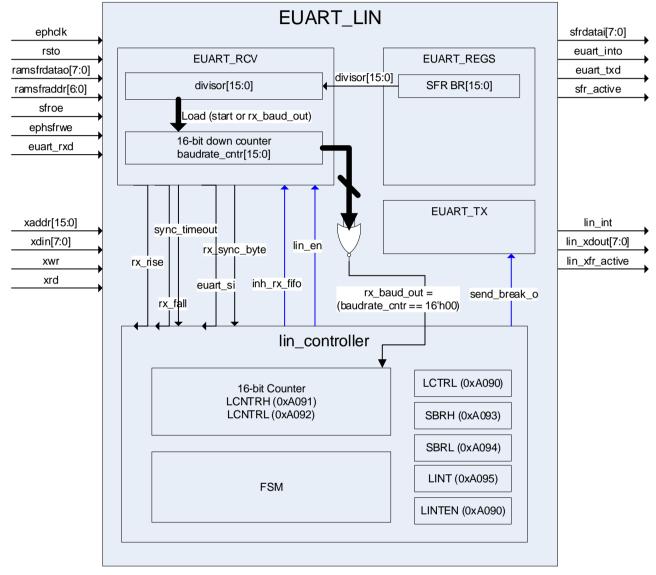


Figure 9-1 EUART2 with LIN Controller block diagram

The following registers are used for configurations of and interface with EUART2.

SCON2 (0xC2) UART2 Configuration Register 00000000, R/W

	7	6	5	4	3	2	1	0	
RD	EUARTEN	SB	WLS[1]	WLS[0]	BREAK	OP	PERR	SP	
WR	EUARTEN	SB	WLS[1]	WLS[0]	BREAK	OP	PE	SP	
EUARTEN Transmit and Receive Enable bit Set to enable EUART2 transmit and receive functions: To transmit messages in th TX FIFO and to store received messages in the RX FIFO. SB Stop Bit Control Set to enable 2 Stop bits, and clear to enable 1 Stop bit.									



WLS[1-0]	The number of bits of a data byte. This does not include the parity bit when parity is enabled. 00 - 5 bits 01 - 6 bits 10 - 7 bits 11 - 8 bits
BREAK	Break Condition Control Bit Set to initiate a break condition on the UART interface by holding UART output at low until BREAK bit is cleared.
OP	Odd/Even Parity Control Bit
PE/PERR	Parity Enable / Parity Error status
SP	Set to enable parity and clear to disable parity checking functions. If read, PERR=1 indicates a parity error in the current data of RX FIFO. Parity Set Control Bit
	When SP is set, the parity bit is always transmitted as 1.

SFIFO2 (0xA5) UART2 FIFO Status/Control Register 00000000 R/W

	7	6	5	4	3	2	1	0	
RD		RFL	[3-0]			TFL	[3-0]		
WR		RFL	Г[3-0]			TFLT	[3-0]		
	FL[3-0] FLT[3-0]	FIFC	ent Receive F) byte count. eive FIFO trigg n RFL[3-0] is g	ger threshold	. This is write-				
			RFLT[3-0]		D	escription			
			0000	RX FIFO trigger level = 0					
			0001	RX FIFO trigger level = 1					
			0010	RX FIFO t	rigger level = 2	2			
			0011	RX FIFO ti	rigger level = 3	3			
			0100	RX FIFO t	rigger level = ·	4			
			0101	RX FIFO trigger level = 5					
			0110	RX FIFO trigger level = 6					
			0111 RX FIFO trigger level = 7						
			1000	RX FIFO t	rigger level = a	8			
			1001	RX FIFO trigger level = 9 RX FIFO trigger level = 10					
			1010						
			1011	RX FIFO t	rigger level =	11			
			1100	RX FIFO t	rigger level =	12			
			1101	RX FIFO trigger level = 13					
			1110	RX FIFO t	rigger level =	14			
			1111	Reset Rec	eive State Ma	chine and Cle	ear RX FIFO		
TF	FL[3-0]		ent Transmit F D byte count.	FIFO level. TI	his is read-onl	y and indicate	es the current	transmit	
TF	FLT[3-0]		ismit FIFO trig n TFL[3-0] is l			-only. TRA int	terrupt will be	generated	
			TFLT[3-0]		D	escription			
			0000	Reset Trar	nsmit State Ma	achine and Cl	ear TX FIFO		
				1					

0001

TX FIFO trigger level = 1

TX FIFO trigger level = 2



TFLT[3-0]	Description
0011	TX FIFO trigger level = 3
0100	TX FIFO trigger level = 4
0101	TX FIFO trigger level = 5
0110	TX FIFO trigger level = 6
0111	TX FIFO trigger level = 7
1000	TX FIFO trigger level = 8
1001	TX FIFO trigger level = 9
1010	TX FIFO trigger level = 10
1011	TX FIFO trigger level = 11
1100	TX FIFO trigger level = 12
1101	TX FIFO trigger level = 13
1110	TX FIFO trigger level = 14
1111	TX FIFO trigger level = 15

Receive and transmit FIFO can be reset by clearing FIFO operation. This is done by setting BR[11-0]=0 and EUARTEN=0. This also clears RFO, RFU and TFO interrupt flags without writing the interrupt register. The LIN counter LCNTR is also cleared.

	7	6	5	4	3	2	1	0			
RD	INTEN	TRA	RDA	RFO	RFU	TFO	FERR	TI			
WR	INTEN	TRAEN	RDAEN	RFOEN	RFUEN	TFOEN	FERREN	TIEN			
IN	NTEN		rupt Enable b								
				RT2 interrupt.		ole interrupt.	The fault is 0.				
T	RA/TRAEN			ready to be fill							
				n transmit FIF				eshold. Write			
		abse		rupt. The hag		iny cleared wi					
R	DA/RDAEN			eady to be rea	ad.						
				ardware whe							
				rupt. RDA will							
				* 16 * Baud F received byte			offware that th	here are still			
				d when RFL <			e bit (The inte	errupt is			
			disabled simultaneously.)								
R	FO/RFOEN	Rece	eive FIFO Ove	erflow Enable	bit						
			This bit is set when the overflow condition of received FIFO occurs. Write "1" to enable interrupt. The flag can be cleared by software by writing "0" on the bit (The								
								he bit (The			
R	FU/RFUEN		•	ed simultaneo derflow Enabl		IFO reset act	ion.				
				n the underflo		of received FI	-O occurs. W	rite "1" to			
				he flag can b							
			•	ed simultaneo	• • •	IFO reset act	ion.				
TI	FO/TFOEN			erflow Interru				<i></i>			
				n the overflov							
				The flag can b ad simultaneo				le bit (The			
FI	interrupt is disabled simultaneously.), or by FIFO reset action. FERR/FERREN Framing Error Enable bit										
			•	n the framing	error occurs	as the byte is	received. Wr	te "1" to			
				he flag must		software by	writing "0" on	the bit (The			
-				ed simultaneo		- - - - -					
I	I/TIEN	i ran	sinit wessage		-			E4 -6400			



This bit is set when all messages in the TX FIFO are transmitted, and the TX FIFO becomes empty. Write "1" to enable interrupt. The flag must be cleared by software by writing "0" on the bit (The interrupt is disabled simultaneously.).

SBUF2 (0xA6) UART2 Data Buffer Register 0x00 R/W

	7 6 5 4 3 2 1 0									
RD	EUART2 Receive Data Register									
WR		EUART2 Transmit Data Register								

This register is the virtual data buffer register for both receive and transmit FIFO. When being read, it reads out the top byte of the RX FIFO; when being written, it writes into the top byte of the TX FIFO.

EUART2 can be configured to add LIN capability. The major enhancement of LIN includes master/slave configurations, auto baud-rate synchronization, and frame-based protocol with header. Under LIN extension mode, all EUART2 registers and functions are still effective and operational. LIN is a single-wire bus and it requires external components to combine RX and TX signals externally. LIN is frame-based and consists of message protocols with master/slave configurations. The following diagram shows the basic composition of a header message sent by the master. It starts with BREAK, SYNC byte, ID bytes, DATA bytes, and CRC bytes.

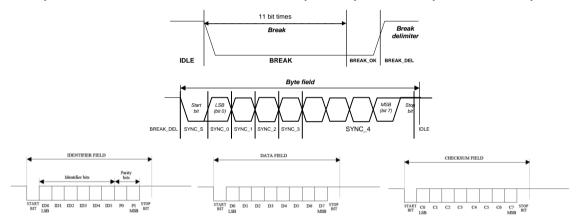


Figure 9-2 LIN frame structure

A LIN frame structure is shown as below and the frame time matches the number of bits sent and has a fixed timing.

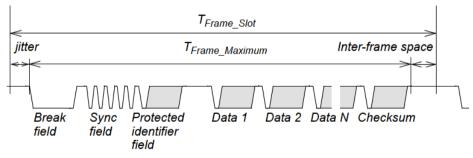


Figure 9-3 LIN frame timing

LIN bus protocol is based on frame. Each frame is partitioned into several parts as shown above. For master to initiate a frame, the software follows the following procedure.

Initiate a SBK command. (SW needs to check if the bus is in idle state, and there is no pending transmit data).

Write "55" into TFIFO.

Write "PID" into TFIFO.

Wait for SBK to complete interrupts and then write the following transmit data if applicable. (This is optional).

The following diagram shows Finite State Machine (FSM) of the LIN extension and is followed by registers within EUART2.



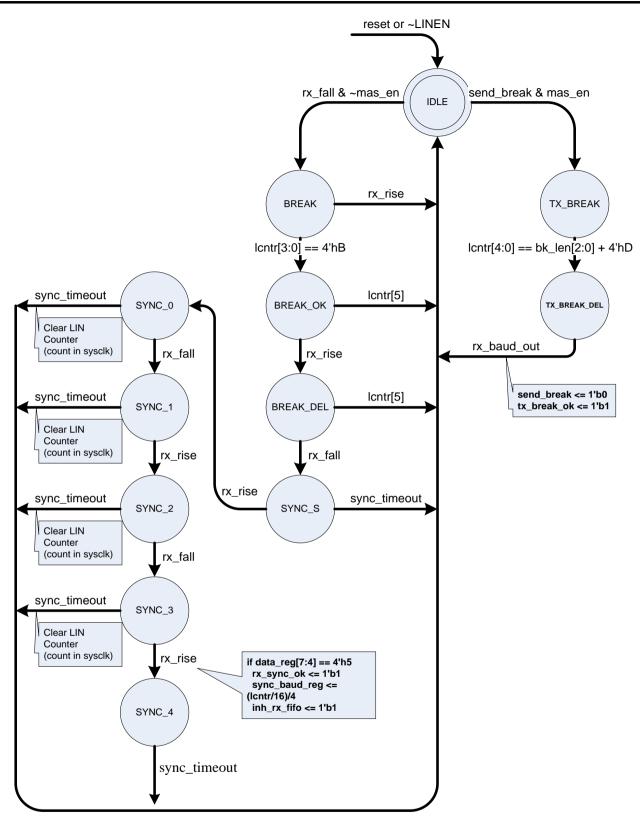


Figure 9-4 Finite State Machine of the LIN extension



7 6 5 4 3 2 1 0 LINEN RD MASEN ASU MASU SBK BL[2:0] WR LINEN MASEN ASU MASU SBK BL[2:0] LIN Enable (1: Enable / 0: Disable) LINEN LIN header detection / transmission is functional when LINEN = 1. % Before enabling LIN functions, the EUART2 registers must be set correctly : 0xB0 is recommended for SCON2. MASEN Master Enable bit (1: Master / 0: Slave) LIN operating mode selection. This bit is changeable only when LINEN = 0 (must clear LINEN before changing MASEN). ASU Auto-Sync Update Enable (1: Enable / 0: Disable), Write Only If ASU is 1, the LIN controller will automatically overwrite BR[15-0] with SBR[15-0] and issue an ASUI interrupt when receiving a valid SYNC field. If ASU is 0, the LIN controller will only notice the synchronized baud rate in SBRI15-0] by issuing a RSI interrupt. ASU should not be set under UART mode. ASU capability is based on the message containing BREAK and SYNC field in the beginning. When ASU=1, the auto sync update is performed on every receiving frame and is updated frame by frame. When ASU is set to 1, LININTEN[SYNCMD] should also be set to 1. MASU Message Auto Sync Update Enable MASU is meaningful only if ASU=0. MASU=1 will enable the auto sync update on the next received frame only. It is self-cleared when the sync update is completed. The software must set MASU again if another auto sync operation is desired. When MASU is set to 1, LININTEN[SYNCMD] should also be set to 1. SBK Send Break (1: Send / 0: No send request) LINEN and MASEN should be set before setting SBK. When LINEN and MASEN are both 1, set SBK to send a bit sequence of 13+BL[2:0] consecutive dominant bits and 1 recessive bit (Break Delimiter). Once SBK is set, this bit represents the "Send Break" status and CANNOT be cleared by writing to "0"; instead, clearing LINEN cancels the "Send Break" action. In normal cases, SBK is cleared automatically when the transmission of Break Delimiter is completed. BL[2:0] Break Length Setting Break Length = 13 + BL[2:0]. Default BL[2:0] is 3'b000.

LINCTRL (0xA090) LIN Status/Control Register 0x00 R/W

LINCNTRH (0xA091) LIN Timer Register High (0xFF) R/W

	7	6	5	4	3	2	1	0		
RD	LCNTR15-8]									
WR		LINTMR[15-8]								

LINCNTRL (0xA092) LIN Time Register Low (0xFF) R/W

	7	6	5	4	3	2	1	0		
RD	LCNTR[7-0]									
WR	LINTMR[7-0]									

LCNTR[15-0] is read only and is an internal 16-bit counter clocked by the baud rate clock. LINTMR[15-0] is write only and is the timer limit for LCNTR[15-0]. If MASEN=1 as LIN master mode, this timer is used to generate Frame time base. The internal counter LCNTR[15-0] is cleared whenever a "SEND BREAK" command is executed, and when the counter reaches LINTMR [15-0] (LCNTR[15-0] >= LINTMR[15-0]), a LCNTRO interrupt is generated. Thus, the software can write a Frame Time value into LINTMR and use interrupts to initiate frames. If MASEN=0 as LIN slave mode, this timer is used for determining the accumulated bus idle time. The internal counter is cleared whenever a RX transition occurs. When the internal counter reaches LINTMR[15-0], a LCNTRO interrupt is generated. The software can use this interrupt to enter sleep mode by writing the required bus idling time into LINTMR[15-0].



LINSBRH (0xA093) EUART/LIN Baud Rate Register High byte (0x00) RO

	7	6	5	4	3	2	1	0			
RD		SBR[15-8]									
WR		BR[15-8]									

LINSBRL (0xA094) EUART/LIN Baud Rate Register Low byte (0x00) RO

	7	6	5	4	3	2	1	0		
RD		SBR[7:0]								
WR		BR[7-0]								
S	BR[15-0] The acquired Baud Rate under LIN protocol. This is read-only.									

SBR[15-0] is the acquired baud rate from last receiving valid sync byte. SBR is meaningful only in LIN-Slave mode.

BR[15-0]

The Baud Rate Setting of EUART/LIN. This is write-only. BR[15-0] cannot be 0. BUAD RATE = SYSCLK/BR[15-0].

When a slave receives a BREAK followed by a valid SYNC field, a RSI interrupt is generated and the acquired baud rate from SYNC field is stored in SBR[15-0]. The acquired baud rate is BAUD RATE = SYSCLK/SBR[15-0]. The software can just update this acquired value into BR[15-0] to achieve synchronization with the master. If Auto-Sync Update (ASU) register bit is enabled under LIN slave mode, LIN controller will automatically perform the update of BR[15-0] with SBR[15-0] and issue another ASUI interrupt when receiving a valid SYNC field.

	7	6	5	4	3	2	1	0		
RD	RXST	BITERR	LSTAT	LIDLE	ASUI	SBKI	RSI	LCNTRO		
WR	-	BITERR	BECLRX	BECLRR	ASUI	SBKI	RSI	LCNTRO		
R	XST		eive Status							
					a START bit	s detected. It	is cleared wh	ien STOP		
Б			ition is detect	ed.						
D	ITERR		rror Flag	hardwara wh	en the receive	d hit door no	t match with t	ronomit hit if		
					ates an interru					
		softw		e enter gener				Saby		
L	STAT	LIN E	Bus Status bit	(1: Recessiv	e / 0: Domina	nt), Read only	/.			
		LST/	AT = 1 indicat	es that the LI	N bus (RX pir) is in recessi	ive state.			
В	ECLRX		rror Force Cle							
					set by hardw			ately		
					nd clears TX :					
L	IDLE				and not trans		ing LIN head	er or data		
B	ECLRR				1 when LINE	$\mathbf{N} = 0.$				
D		Bit Error Force Clear RECEIVE Enable If BECLRX=1, when BITERR is set by hardware, hardware also immediately								
					clears RX stat			atory		
А	SUI				Interrupt (1: S					
					rate synchror					
					h SBR[15-0] b	y hardware. I	t must be clea	ared by		
~			ng "1" on the b							
S	BKI				ot bit (1: Set /	,		:		
		the b		en Send Brea	ak is complete	d. It must be	cleared by wr	iting "1" in		
R	SI			npletion Inter	rupt bit (1: Se	t / 0: Clear)				
	-			•	nc byte is rece	,	g a Break. It r	nust be		
		clear	ed by writing	"1" to the bit.			-			
L	CNTRO				bit (1: Set / 0:	,				
		Thie	flag is set wh	on the LIN co	unter reaches		wat ha alaara			

LININT (0xA095) LIN Interrupt Flag Register (0x00) R/W





			ŭ							
	7	6	5	4	3	2	1	0		
RD	LINTEN	BERIE	SYNCMD	SYNCVD	ASUIE	SBKIE	RSIE	LCNTRIE		
WR	LINTEN	BERIE	SYNCMD	EUARTOPL	ASUIE	SBKIE	RSIE	LCNTRIE		
	INTEN	LIN Interrupt Enable (1: Enable / 0: Disable) Set to enable all LIN interrupts. LINT flags should be checked before setting or modifying. Bit Error Interrupt Enable (1: Enable / 0: Disable)								
	YNCMD	SYN devi SYN fram SYN be s 1. W 2. B SYS	 Synchronization Mode Selection SYNCMD=0 will only allow automatic synchronization of baud rate within +/- 6% deviations. SYNCMD=1 will automatically re-synchronize with the newly received message frame and update the baud rate register with the newly acquired baud rate. SYNCMD should be set to 1 when either ASU or MASU is 1. The new baud rate can be successfully received and must meet the following conditions: 1. Within +/- 50% of the current baud rate setting 2. Break length is less than 32 current baud rate bit times and less than 253952 SYSCLK 							
S	YNCVD	SYN		/alid Status ted by the harc tion is success		YNCMD=1. S	SYNCVD is se	et to 1 if the		
E	UARTOPL		RT/LIN output RTOPL=1 w	ut polarity ill reverse the t	ransmit outpu	t polarity				
A	SUIE	Auto-Sync Update Interrupt Enable (1: Enable / 0: Disable)								
S	BKIE	Send Break Completion Interrupt Enable (1: Enable / 0: Disable)								
R	SIE	Rec	eive Sync Co	mpletion Interr	upt Enable (1	: Enable / 0: I	Disable)			
L	CNTRIE	LIN	Counter Ove	rflow Interrupt E	Enable (1: En	able / 0: Disa	ble)			

LININTEN (0xA096) LIN Interrupt Enable Register (0x00) R/W

LINTCON (0xA0B0) LIN Time Out configuration R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	RXDTO[0]	LINRXFEN	RXTOWKE	TXTOWKE	RXDD_F	TXDD_F	RXDDEN	TXDDEN		
WR	RXDTO[0]	LINRXFEN	RXTOWKE	TXTOWKE	RXDD_F	TXDD_F	RXDDEN	TXDDEN		
	RXDTO[0] RXD Dominant Time Out Timer [0] This is combined with RXDTOH and RXDTOL to form RXDTO[16-0] UNRXFEN LIN Break State Exit when RXD dominant fault occurs.									
LINRXFEN LIN Break State Exit when RXD dominant fault occurs. LINRXFEN=1 configures the automatic BREAK state exit under RXD dominant fau conditions. LINRXFEN=0 disable this automatic exit (Does not affect other break exit conditions.). Software must take care of the LIN state machine.										
R	XTOWKE	RXD	Dominant Ti	meout Wakeu	ıp Enable					
T	XTOWKE	TXD	Dominant Tir	meout Wakeu	p Enable					
R	XDD_F			ault Interrupt F 1 by hardwar	•	e cleared by s	software.			
T)	XDD_F		RXDD_F is set to 1 by hardware and must be cleared by software. TXD Dominant Fault Interrupt Flag TXDD_F is set to 1 by hardware and must be cleared by software.							
	XDDEN	RXD Dominant Fault Interrupt Enable								
				ult Interrupt E						

TXDTOL (0xA0B1) LIN TXD Dominant Time Out LOW Registers R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	TXDTO[7:0]								
WR		TXDTO[7:0]							



	H (0xA0B2) L 7	6	5	4	3	2	1	0
RD		J	J	TXDTC	-	£		0
WR	TXDTO[15:8] XDTO TXD Dominant Time Out (TXDTO +1) * IOSCCLK							
	L (0xA0B3) L			•	,			
	7	6	5	4	3	2	1	0
RD				RXDT	O[8:1]			
WR				RXDT	O[8:1]			
XDTO	H (0xA0B4) L	IN RXD Dom	inant Time O	out HIGH Reg	isters R/W ((0x00)		
	7	6	5	4	3	2	1	0
RD				RXDT	D[16:9]			
WR				RXDT	D[16:9]			
R	XDTO	RXD	Dominant Tir	ne Out (RXD	ΓO[16:0] +1) [·]	* IOSCCLK		
SDCL	R (0xA0B5) B	us Stuck Do	minant Clear	Width Regis	ters R/W (0x	:00)		
	7	6	5	4	3	2	1	0
RD				BSDCL	.R [7:0]			
WR		BSDCLR [7:0]						
B	SDCLR	Bus	Stuck Domina	ant Clear Time	e (BSDCLR +	1) * SOSC32I	КНz	
SDAC	T (0xA0B6) B	us Stuck Do	minant Activ	e Width Reg	sters R/W (0	x00)		r
	7	6	5	4	3	2	1	0
RD	BSDACT [7:0]							
	BSDACT [7:0]							
WR			Stuck Domine	ant Active Tim	e (BSDCLR +	+1) * SOSC32	:KHz	
	SDACT	Bus			,			
B	SDACT (C (0xa0b7) e				nfiguration F	R/W (0x00)		1
B					nfiguration F 3	R/W (0x00) 2	1	0
B	(C (0xA0B7) E	Bus Stuck De	ominant Faul	t Wakeup co				0
B	C (0xA0B7) E 7	Bus Stuck De	ominant Faul 5	t Wakeup co 4		2	.T[3:0]	0
B B B B B B B B R D W R	CC (0xA0B7) E 7 BSDW_F	Bus Stuck Do 6 BFW_F BFW_F LIN	b minant Faul 5 BSDWEN BSDWEN Wakeup Interr	t Wakeup co 4 BFWEN BFWEN upt Flag	3	2 WKFL WKFL	T[3:0] T[3:0]	0
B B B B B B B	CC (0xA0B7) E 7 BSDW_F BSDW_F FW_F	Bus Stuck Do 6 BFW_F BFW_F LIN V BFW	BSDWEN BSDWEN BSDWEN Wakeup Interr /_F is set to 1	t Wakeup co 4 BFWEN BFWEN upt Flag by hardware	3 and must be	2 WKFL WKFL	T[3:0] T[3:0]	0
B B B B B B	CC (0xA0B7) E 7 BSDW_F BSDW_F	Bus Stuck Do 6 BFW_F BFW_F LIN BFW LIN	b minant Faul 5 BSDWEN BSDWEN Wakeup Interr	t Wakeup co 4 BFWEN BFWEN upt Flag by hardware keup Interrup	3 and must be	2 WKFL WKFL	T[3:0] T[3:0]	0

Due to the implementation of Bit Error detection, if hardware detection of bit error is not used, BECLRX, BECLRR and BERIE should be set low, and ignore BITERR status.

If bit error detection is done by the hardware and at the completion of a message transmission (TI/TIEN Transmit Message Completion Interrupt Flag), software needs to check BITERR, and clear BITERR, BECLRX, BECLRR and BERIE. To start a new transmission, the software should first need to clear BITERR, enable BECLRX, BECLRR, and BERIE, and then write data into FIFO.



10. Serial Peripheral Interface (SPI)

The Serial Peripheral Interface (SPI) is an enhanced synchronous serial hardware, which is compatible with Motorola's SPI specifications. The SPI Controller includes 4-bytes FIFO for both transmit and receive. SPI Interface uses Master-Out-Slave-In (MOSI), Master-In-Slave-Out (MISO), Serial Clock (SCK) and Slave Select (SSN) for interface. SSN is low active and only meaningful in slave mode. Due to oversampling, the maximum SPI clock rate is limited to SYSCLK/4 for both slave and master configurations.

	7	6	5	4	3	2	1	0		
RD	SPIE	SPEN	MSTR	CPOL	CPHA	SCKE	SICKFLT	SSNFLT		
WR	SPIE	SPEN	MSTR	CPOL	CPHA	SCKE	SICKFLT	SSNFLT		
S	PIE	SPI i	SPI interface Interrupt Enable bit.							
S	PEN	SPI i	SPI interface Enable bit.							
Μ	STR	SPI Master/Slave Switch (set as a master; clear as a slave)								
CPOL		SPI interface Polarity bit: Set to configure the SCK to stay HIGH while the SPI interface is idling and clear to keep it LOW.								
С	PHA	Clock Phase Control bit: If CPOL=0, set to shift output data at ri and clear to shift output data at falling edge of SCK. If CPOL=1, data at falling edge of SCK and clear to shift output data at risin			DL=1, set to s	hift output				
SCKE		Clock Selection bit in Master Mode: Set to use rising edge of SCK to sample the input data. Clear to use falling edge of SCK to sample the input data.								
S	SNFLT	Enable noise filter function on signal SSN								
SICKFLT Enable noise filter function on sign				ignals SDI an	d SCK					

SPICR (0xA1) SPI Configuration Register R/W (0b001000xx)

In Slave mode, the sampling phase is determined by the combinations of CPOL and CPHA setting and is shown in the following table.

CPOL	СРНА	(Slave mode) SCK edge used for sampling input data	Data shift out
0	0	Rising edge	Falling edge
0	1	Falling edge	Rising edge
1	0	Falling edge	Rising edge
1	1	Rising edge	Falling edge

SPIMR (0xA2) SPI Mode Control Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	ICNT1	ICNT0	FCLR	-		SPR[2-0]		DIR
WR	ICNT1	ICNT0	FCLR	-		SPR[2-0]		DIR

ICNT1, ICNT0	FIFO Byte Count Threshold.					
	This sets the FIFO threshold for generating SPI interrupts.					
	00 – the interrupt is generated after 1 byte is sent or received;					
	01 –the interrupt is generated after 2 bytes are sent or received;					
	10 –the interrupt is generated after 3 bytes are sent or received;					
	11 –the interrupt is generated after 4 bytes are sent or received.					
FCLR	FIFO Clear/Reset					
	Set to clear and reset transmit and receive FIFO					
SPR[2-0]	SPI Clock Rate Setting. This is used to control the SCK clock rate of SPI interface.					
	000 - SCK = SYSCLK/4;					
	001 - SCK = SYSCLK/6;					
	010 - SCK = SYSCLK/8;					
	011 – SCK = SYSCLK/16;					
	100 - SCK = SYSCLK/32;					
	101 – SCK = SYSCLK/64;					
	110 – SCK = SYSCLK/128;					
	111 – SCK = SYSCLK/256.					
DIR	Transfer Format					



DIR=1 uses MSB-first format. DIR=0 uses LSB-first format.

SPIST (0xA3) SPI Status Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	SSPIF	ROVR	TOVR	TUDR	RFULL	REMPT	TFULL	TEMPT		
WR	SSPIF	ROVR	TOVR	TUDR	-	-	-	-		
	SPIF OVR	SPI Interrupt Flag bit. Set by hardware to indicate the completion of data transfer. Clear by assigning this bit to 0 or disabling SPI. Receive FIFO-overrun Error Flag bit. When Receiver FIFO Full Status occurs and SPI receives new data, ROVR is set and generates an interrupt. Clear by assigning								
т	OVR	this bit to 0 or disabling SPI. Transmit FIFO-overrun Error Flag bit. When Transfers FIFO Full Status occurs new data is written, TOVR is set and generates an interrupt. Clear by assigning bit to 0 or disabling SPI.								
Τι	JDR	Tran data	smit Under-ru	in Error Flag I occur, TUDR	bit. When Trai is set and ge					
RI	FULL	Rece	eive FIFO Ful	Status bit. Se	et when receiv	ver FIFO is fu	II. Read only.			
	EMPT		Receive FIFO Empty Status bit. Set when receiver FIFO is empty. Read only.							
			Transmitter FIFO Full Status bit. Set when transfer FIFO is full. Read only.							
TE	EMPT	Transmitter FIF0 Empty Status bit. Set when transfer FIFO is empty. Read only.								

SPIDATA (0xA4) SPI Data Register R/W (0xXX)

	7	6	5	4	3	2	1	0			
RD	SPI Receive Data Register										
WR		SPI Transmit Data Register									

10.1 SPI Master Timing Illustration

10.1.1CPOL=0 CPHA=0

SPI MODE TIMING, MASTER MODE

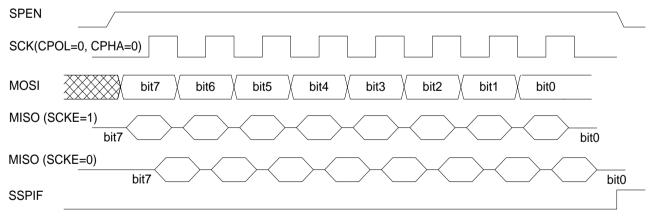


Figure 10-1 SPI Master Timing with CPOL=0, CPHA=0



10.1.2CPOL=0 CPHA=1

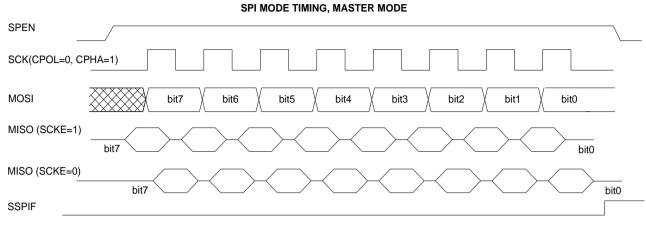


Figure 10-2 SPI Master Timing with CPOL=0, CPHA=1

10.1.3CPOL=1 CPHA=0

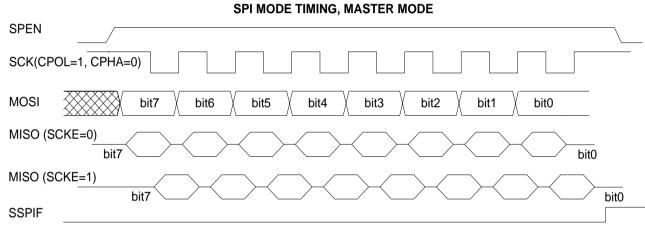
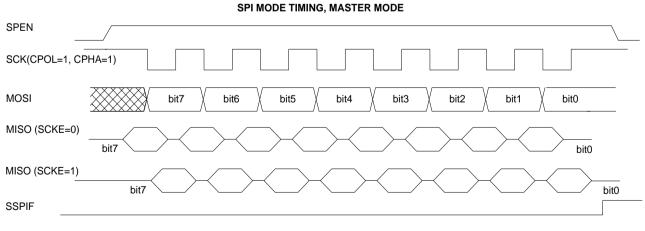


Figure 10-3 SPI Master Timing with CPOL=1, CPHA=0

10.1.4CPOL=1 CPHA=1







10.2 SPI Slave Timing Illustration

10.2.1CPOL=0 CPHA=0

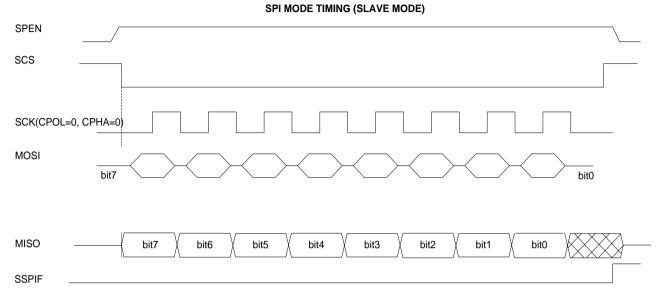


Figure 10-5 SPI Slave Timing with CPOL=0, CPHA=0

10.2.2CPOL=0 CPHA=1

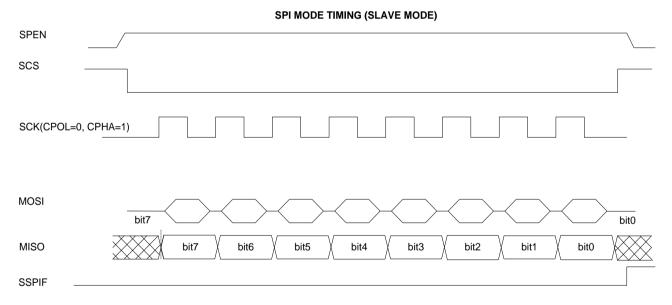


Figure 10-6 SPI Slave Timing with CPOL=0, CPHA=1



10.2.3CPOL=1 CPHA=0

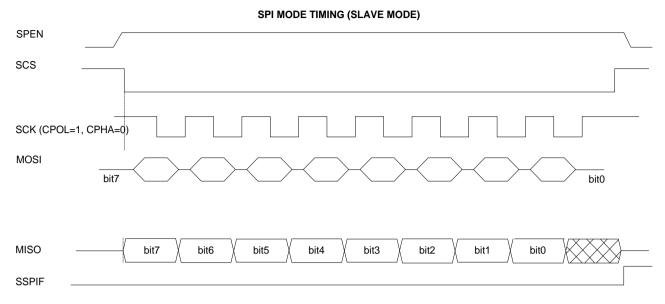
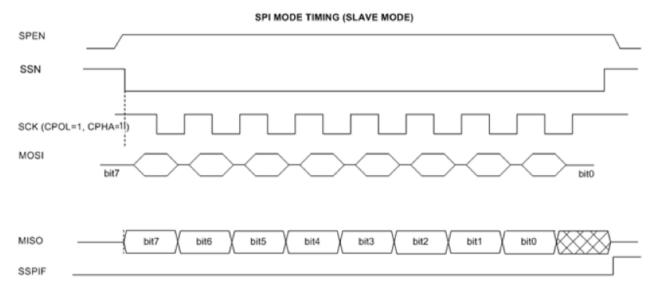


Figure 10-7 SPI Slave Timing with CPOL=1. CPHA=0



10.2.4CPOL=1 CPHA=1



This section describes the pin functions and configurations. Almost all signal pins are multi-functional with default setting as a GPIO port pin. Therefore, each signal pin requires two registers to configure the I/O capability and the function selection. The following describes the control and contents of these registers, and the register names and pin names are referenced by their default GPIO port name. The standardized I/O design allows flexible configuration of the digital I/O function such as open-drain, open-source, pull-up, pull-down, bus-holder capabilities. In addition to digital I/O function, the standardized I/O also provides analog I/O capability that can be selected when the GPIO pin is shared with analog peripheral purposes such as analog OPAMP.



11. Timer with Compare/Capture and Quadrature Encoder

The Timer/Capture unit is based on a 16-bit counter with a pre-scalable SYSCLK as a counting clock. The count starts from 0 and reloads when reaching TC (terminal count). TC is met when the count equals the period value. Along with the counting, the count value is compared with COMP and when it matches, a CC condition is met. Note that both PERIOD and COMP registers are double buffered, and therefore, any new value is updated after the current period ends. TC and CC can be used for triggering an interrupt and are also routed to GPIO. The output pulse width of TC and CC is programmable. For CC, it can also be configured as a PWM output. There are two data registers for capture events. The capture event can be from external signals from GPIO with edge selection option, from QE block, or triggered by software. The software can also select if it is necessary to reset the counter or not. This option gives a simpler calculation of consecutive capture events without any offset. The following block diagram shows the TCC implementation.

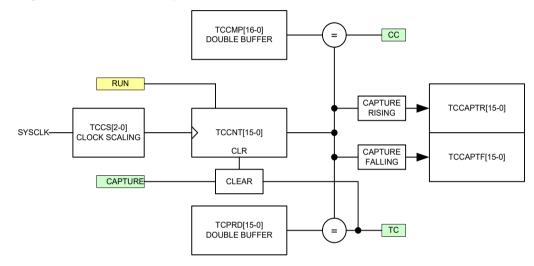


Figure 11-1 TCC implementations diagram

TCCFG1 (0xA050) TCC Configu	ration Register 1 R/W (0x00)
-----------------------------	------------------------------

	7	6	5	4	3	2	1	0		
RD	TCEN		TCCS[2-0]		CCSEL[1-0]		TCSEL	RUNST		
WR	TCEN		TCCS[2-0]		CCSE	EL[1-0]	TCSEL	RUN		
	TCEN TC Enable TC = 0 disables TC. In the disabled state, TCCNT, and TCCPTR/TCC cleared to 0. TC and CC are also set to low. TC = 1 enables TC. RUN bit also needs to set to 1 to start the counter the counter is in pause mode if RUN=0. TCCS[2-0] TC Clock Scaling 000 SYSCLK 001 SYSCLK/2 010 SYSCLK/8 020 SYSCLK/8									
С	CSEL[1-0]	100 SYSCLK/16 101 SYSCLK/32 110 SYSCLK/64 111 SYSCLK/128 CC Output Pulse Select 00 00 PW = 16 TCCLK 01 PW = 64 TCCLK 10 PWM Waveform (CC = low when TCCNT < CMP, CC = high when the term of the term of the term of								
T	CSEL	 >= CMP). 11 PWM Toggle waveform (CC toggles when TCCNT = CMP). TC Output Pulse Select 0 PW = 16 TCCLK 1 PW = 64 TCCLK 								



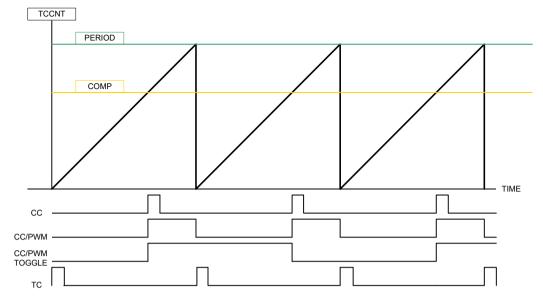


Figure 11-2 TCC timing diagram

RUNST

RUN

Set by hardware to indicate running TC counter. RUNST=1 indicates running. Run or Pause TC Counter Writing "0" to RUN will pause the TC counting. Writing "1" to RUN will resume the TC counting.

TCCFG2 (0xA051) TC Configuration Register 1 R/W (0x00)

Run Status

	7	6	5	4	3	2	1	0				
RD	-	IDXST	PHAST	PHBST	TCPOL	CCPOL	TCF	CCF				
WR	RSTTC	-	-	-	TCPOL	CCPOL	TCF	CCF				
ID Pi Pi T(C(STTC PAST HAST HBST CPOL CPOL CF	coun must PHA PHB TC o CC o Term TCF	ng 1 to RSTT ter is cleared be set by so c Input real-tin input real-tim input real-tim utput polarity output polarity output polarity inal Count In is set to "1" b	, TC counter i ftware. me status ne status ne status terrupt Flag y hardware w	he TC counter is put in STOF	^o mode. To re	esume countin	ıg, RUN bit				
software by writing "0". CCF Compare Match Interrupt Flag CCF is set to "1" by hardware when a compar by software by writing "0".						re match occ	urs. CCF mus	t be cleared				

TCCFG3 (0xA052) TC Configuration Register 3 R/W (0x00)

	7	6	5	4	3	2	1	0			
RD	IENTC	IENCC	QECEN	CPTCLR	XCREN	XCFEN	-	-			
WR	IENTC	IENCC	IENCC QECEN CPTCLR XCREN XCFEN SWCPTR SWCPT								
IE Q	INTC INCC ECEN PTCLR	CC I QE (QEC Enat If CF	ole Clear Cou PTCLR=1, the	le le ne QE output nter after Cap TCCNT is cle	event as the o oture eared to 0 afte he identical in	er each captu		allows			



	If CPTCLR=0, the capture event does not affect the TCCNT counting.
XCREN	External Rising Edge Capture Enable
	XCREN=1 uses external input rising edge as a capture event.
XCFEN	External Falling Edge Capture Enable
	XCFEN=1 uses external input rising edge as a capture event.
SWCPTR	Software Capture R
	Writing "1" to SWCPTR will generate a capture event and capture the count value
	into CAPTR register. This bit is cleared by hardware.
SWCPTF	Software Capture F
	Writing "1" to SWCPTF will generate a capture event and capture the count value
	into CAPTF register. This bit is cleared by hardware.

All capture sources are not mutually exclusive, i.e., allow several capture sources to coexist.

TCPRDL (0xA054) TC Period Register Low Double Buffer R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	TCCNT[7-0]									
WR		TCPRD[7-0]								

TCPRDH (0xA055) TC Period Register High Double Buffer R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		TCCNT15-8]								
WR		TCPRD[15-8]								

Note: Writing of PERIOD register must be done high byte first, and then low byte. The writing takes effect at low byte writing. When reading the TCPRD register, it returns the current count value TCCNT[15-0].

TCCMPL (0xA056) TC Compare Register Low Double Buffer R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		TCCMP[7-0]								
WR		TCCMP[7-0]								

TCCMPH (0xA057) TC Compare Register High Double Buffer R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	TCCMP15-8]								
WR		TCCMP[15-8]							

Note: Writing of COMPARE register must be done high byte first, and then low byte. The writing takes effect at low byte writing.

TCCPTRL (0xA060) TC Capture Register R Low R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		TCCPTR[7-0]								
WR		-								

TCCPTRH (0xA061) TC Capture Register R High R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		TCCPTR15-8]								
WR		-								

TCCPTFL (0xA062) TC Capture Register F Low R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		TCCPTF[7-0]									
WR		-									



TCCPTFH (0xA063) TC Capture Register F High R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	TCCPTF[15-8]									
WR		-								

The quadrature encoder is clocked by a scaled SYSCLK and has three external inputs through GPIO multifunctions. The three inputs include two signals of 90 degrees phase difference, PHA and PHB, and an index indicating the terminal of the encoder. QE can function as an independent function block and can be configured to couple with TCC and use TCC to calculate the speed information of the encoder. Using TCC to capture TCC count value using the Index input of QE or the terminal count of QE, the speed of QE input can be calculated. The QE unit implementation is shown in the following block diagram.

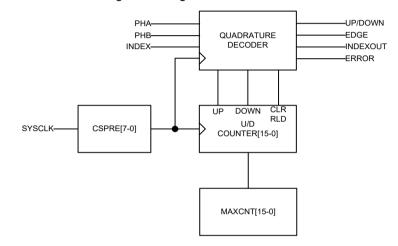


Figure 11-3 QE implementation diagram

QE Counter is in signed integer format. The MSB (bit 15) indicates the sign, and reload action causes the counter to load a default value 0x8000. The corresponding maximum count register only has 15 valid bits, and MSB bit is not used. The reload action is triggered either by an external INDEX event or the terminal count condition when the counter absolute value equals to MAXCNT value.

QECFG1 (0xA070) TCC Configuration Register 1 R/W (0x00)

	7	6	5	4	3	2	1	0
RD	QEMO	QEMODE[1-0] QE		S[1-0]	SWAP		DBCS[2-0]	
WR	QEMO	QEMODE[1-0] QECS[1-		S[1-0]	SWAP		DBCS[2-0]	

MODE[1-0]

- QE Mode 00 – Disable QE
- 01 1X mode
- 10 2X mode 11 – 4X mode
 - 1 47 mode

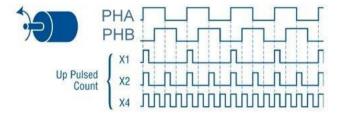


Figure 11-4 Timing diagram of PHA/PHB with X1/X2/X4 modes

QECS[1-0]

QE Clock Scaling 00 SYSCLK/4 01 SYSCLK/16



	10	SYSCLK/64
	11	SYSCLK/256
SWAP	Swap P	HA and PHB
DBCS[2-0]	De-Bou	nce Clock Scaling
	000	Disable de-bounce
	001	SYSCLK/2
	010	SYSCLK/4
	011	SYSCLK/8
	100	SYSCLK/16
	1/32	SYSCLK/32
	1/64	SYSCLK/64
	1/128	SYSCLK/128
	1/256	SYSCLK/256
	Do hour	non time in three DPCS pari

De-bounce time is three DBCS periods.

QECFG2 (0xA071) QE Configuration Register 2 R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	DIR	ERRF	RLDM[1-0]	-	TCF	IDXF	DIRF	CNTF		
WR	-	ERRF	RLDM[1-0]	-	TCF	IDXF	DIRF	CNTF		
EI	IR RRF LDM[1-0]	Direction Status Indicate UP/DOWN direction Phase Error Flab ERRF is set to 1 by hardware if PHA and PHB change value at the same time. ERRF must be cleared by software. QE Counter Reload Mode RLDM[1-0] = 00 No Reload, QECNT will count up/down cycling through 0x0000 or 0xFFFF RLDM[1-0] = 01 Reload using Index event. Reload QECNT=0 when Index==1 && UP Reload QECNT=QEMAX when Index==1 && DOWN RLDM[1-0] = 10 Reload using TC event. Reload QECNT=0 when QECNT==QEMAX && UP Reload QECNT=0 when QECNT==0 && DOWN RLDM[1-0] = 11 Reload using both Index and TC events								
т	CF	TC E TCF	Event Interrup	t Flag dware when a			curred. TCF n	eeds to be		
ID	DXF	Inde: IDXF	cleared by software by writing "0". Index Event Interrupt Flag IDXF is set by hardware when an Index event interrupt has occurred. IDXF needs to be cleared by software by writing "0".							
D	IRF	Direction Change Event Interrupt Flag DIRF is set by hardware when a Direction change event interrupt has occurred. DIRF needs to be cleared by software by writing "0".								
C	NTF	DIRF needs to be cleared by software by writing "0". Count Change Event Interrupt Flag CNTF is set by hardware when a QE count change event interrupt has occurred. CNTF needs to be cleared by software by writing "0".								

QECFG3 (0xA072) QE Configuration Register 3 R/W (0x00)

	7	6	5	4	3	2	1	0
RD	IENTC	IENIDX	IENDIR	IENCNT	IENERR	IDXEN	IDXM[1-0]	
WR	IENTC	IENIDX	IENDIR	IENCNT	IENERR	IDXEN	IDXM[1-0]	
IENTC Inter			rupt Enable fo	or TC				

Interrupt Enable for TC

TC condition for QE is defined as the following conditions.

1. QECNT=QEMAX when UP

2. QECNT=0 when DOWN



IENIDX	Interrupt Enable for Index event
IENDIR	Interrupt Enable for Direction change
IENCNT	Interrupt Enable for any QECNT change
IDXEN	Index Input Enable
	IDXEN=0 gates out the external INDEX input and is gated to 0.
	IDXEN=1 allows external INDEX.
IDXM[1-0]	Index Match Selection, this is applicable only for X2 and X4 modes.
	00 = not gated
	01 = PHA gating
	10 = PHB gating
	11 = PHA and PHB gating

QECNTL (0xA074) QE Counter Low R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		QECNT[7-0]								
WR				QECNT	'INI[7-0]					

QECNTH (0xA075) QE Counter High R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		QECNT[15-8]									
WR		QECNTINI[15-8]									

Reading QECNT will return the current QE counter value. Writing QECNT will set the current count value. Writing QECNT is allowed only when QE is in the disabled state.

QEMAXL (0xA076) QE Counter Low R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		QEMAX[7-0]							
WR		QEMAX[7-0]							

QEMAXH (0xA077) QE Counter High R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		QEMAX[15-8]								
WR		QEMAX[15-8]								

QEMAX holds the maximum count of the QE counter. When the QEMAX count is reached, a TC event is triggered, and QE counter is reloaded.



12. PWM Controller

PWM controller provides programmable 6 channels 8-bit PWM center-aligned duty cycle outputs. The counting clock of PWM is programmable and the base frequency of the PWM is just the counting clock divided by 512 due to center-alignment. The duty cycle setting is always double buffered and minimum/maximum duty cycle is 0 and 255/256 respectively. PWM outputs are multiplexed with GPIO ports.

PWMCFG1 (0xA080) PWM Clock Scaling Setting Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD	PWMEN		CS[6-0]							
WR	PWMEN		CS[6-0]							
	PWMEN CS[6-0]	PWN force PWN PWN The PWN	ed to 0. /IEN=1 allows /I Counting Cl counting cloc /ICLK = SYSC uming SYSCL	the counter, normal runni lock Scaling k is SYSCLK/ CLK/512/(CS[ing operation /4/(CS[6-0]+1) 6-0]+1) or CS	of PWM contr or PWM bas [6-0] = SYSC	all channel ou roller. e frequency F LK/512/PWM anges are fror	PWMCLK as CLK – 1		

PWMCFG2 (0xA081) PWM Interrupt Enable and Flag Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	-	-	ZINTEN	CINTEN	-	-	ZINTF	CINTF	
WR	-	- ZINTEN CINTEN ZINTF CINTF							
	NTEN	ZINT Cent CINT	er Interrupt E	PWM Contro nable	Ū	te an interrupt te interrupt wl			
ZI	NTF	Zero Interrupt Flag ZINTF is set to 1 by hardware to indicate a Zero interrupt has occurred. ZINTF must be cleared by software.							
C	INTF	Center Interrupt Flag CINTF is set to 1 by hardware to indicate a Center interrupt has occurred. CINTF must be cleared by software.							

PWMCFG3 (0xA082) PWM Configuration 3 Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	PRSEN	-	POL[5-0]					
WR	PRSEN	-	POL[5-0]					
	RSEN OL[5-0]	PRS can l insta rema Char	be an effectiv ntaneous dut ains the same nnel Polarity (able a pseudo e way to redu y cycle will be Control	random sequ ce EMI for ou	tput. When P le by cycle bu	t the average	

There are 6 independent PWMDTY registers to define the duty cycle. If PWMDTY = 0x00, the output is 0. If PWMDTY = 0xFF, the output duty cycle is 255/256. PWMDTY is always double buffered and is loaded to duty cycle comparator when the current counting cycle is completed.



PWM0D	TY (0xA088)	PWM0 Duty	Register R/W	/ (0x00)							
	7	6	5	4	3	2	1	0			
RD				PWM0E	DTY[7-0]						
WR				PWM0E	DTY[7-0]						
PWM1D	TY (0xA089)	PWM1 Duty	Register R/W	/ (0x00)							
	7	6	5	4	3	2	1	0			
RD				PWM1D	DTY[7-0]						
WR				PWM1D	DTY[7-0]						
PWM2D	DTY (0xA08A) PWM2 Duty Register R/W (0x00)										
	7	6	5	4	3	2	1	0			
RD	PWM2DTY[7-0]										
WR	PWM2DTY[7-0]										
PWM3D	TY (0xA08B)	PWM3 Duty	Register R/V	V (0x00)							
	7	6	5	4	3	2	1	0			
RD				PWM3D)TY[7-0]						
WR				PWM3D)TY[7-0]						
PWM4D	TY (0xA08C)	PWM4 Duty	Register R/V	V (0x00)							
	7	6	5	4	3	2	1	0			
RD				PWM4D	DTY[7-0]						
WR	PWM4DTY[7-0]										
PWM5D	VM5DTY (0xA08D) PWM5 Duty Register R/W (0x00)										
	7	6	5	4	3	2	1	0			
RD	PWM5DTY[7-0]										
WR				PWM5D	DTY[7-0]						



13. Buzzer and Melody Controller

The buzzer and melody controller can be used to generate a simple buzzer sound or a single tone melody. It contains a two note Ping-Pong buffers, each with programmable tone frequency, and duration/pause timer. The tone frequency is derived from SYSCLK divided by either 32 or 64, and the tone frequency is generated with resolution of 12-bit to support precision tone generation with wide octave span. The duration/pause timers can be programmed in 1ms/2ms/4ms/8ms steps. The two notes can be played sequentially once or can be played as Ping-Pong styles for melody. A POW (Power On Width) timer is also included with same time steps, and can be used to generate external power control of the buzzer element. POW timer is started when either note A or B is started.

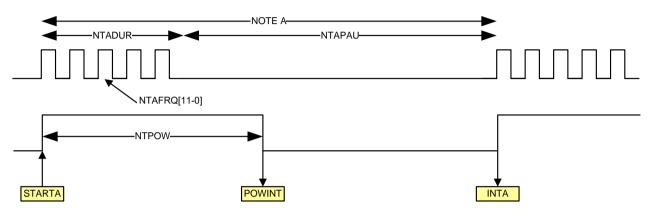


Figure 13-1 Buzzer and Melody output timing diagram

NTAFRQL (0xA040) Note A Frequency Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		NTAFRQ[7-0]							
WR		NTAFRQ[7-0]							

NTAFRQH (0xA041) Note A Frequency Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	-	-	-	-	NTAFRQ[11-8]				
WR	-	-	-	-	NTAFRQ[11-8]				

Tone frequency is SYSCLK/(32 or 64)/(NTAFRQ[11-0]+1).

NTADUR (0xA042) Note A Duration Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		NTADUR[7-0]								
WR		NTADUR[7-0]								

Tone duration is TU * NTADUR[7-0]

NTAPAU (0xA043) Note A Pause Register Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		NTAPAU[7-0]							
WR		NTAPAU[7-0]							

Tone pause is TU * NTAPAU[7-0]

NTBFRQL (0xA044) Note B Frequency Register R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		NTAFRQ[7-0]								
WR		NTAFRQ[7-0]								



NTBFRQH (0xA045) Note B Frequency Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD		-		-	3 2 1 0 NTBFRQ[11-8] NTBFRQ[11-8] NTBFRQ[11-8] NTBFRQ[11-8]				
WR		-		- NTBFRQ[11-8]					

NTBDUR (0xA046) Note B Duration Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		NTBDUR[7-0]									
WR		NTBDUR[7-0]									

NTBPAU (0xA047) Note B Pause Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		NTBPAU[7-0]									
WR		NTBPAU[7-0]									

NTPOW (0xA049) Note Power On Window Register R/W (0x00)

	7	6	5	4	3	2	1	0			
RD		NTPOW [7-0]									
WR		NTPOW [7-0]									

NTPOW defines a timer after either STARTA or STARTB. It uses the same time unit as duration and pause. When the timer expires, it generates an interrupt by setting INTFP bit.

NOTETU (0xA04A) Note Time Unit Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	TU[1-0]		-	TBASE	-	-	INTEPOW	INTFP
WR	TU[1-0]		-	TBASE	-	-	INTEPOW	INTFP

TU[1-0]

TBASE

INTEPOW

Time Unit TU[1-0] defines the time unit for duration and pause, and POW timer. 00 = 1msec 01 = 2msec 10 = 4msec 11 = 8msec Tone Base Frequency Select TBASE=0 uses SYSCLK/32 as base. TBASE=1 uses SYSCLK/64 as base. POW Timer Interrupt Enable

INTFP POW Interrupt Flag

INTFP is set by hardware when POW timer expires. It must be cleared by software.

BZCFG (0xA048) Buzzer Configure Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	BZEN	BZPOL	INTENB	INTENA	INTFB	INTFA	BUSYB	BUSYA
WR	BZEN	BZPOL	INTENB	INTENA	INTFB	INTFA	STARTB	STARTA
В	ZEN ZPOL ITENB	BZE BZC BZO If BZ If BZ Note INTE	N=0 disables UT Polarity S POL=1, BZO POL=0, BZO B End Intern	the buzzer co the buzzer co etting UT is inverted UT has norma upt Enable es the note B	ntroller. 1. al polarity.	The interrupt	is triggered w	/hen note B



INTENA	Note A End Interrupt Enable
	INTENA =1 enables the note A end interrupt. The interrupt is triggered when note A playing is completed.
INTFB	Note B End Interrupt Flag
	INTFB is set to 1 by hardware if INTENB=1 and Note B playing ends. INTFB needs
	to be cleared by software writing 0.
INTFA	Note A End Interrupt Flag
	INTFA is set to 1 by hardware if INTENA=1 and Note A playing ends. INTFA needs
	to be cleared by software writing 0.
BUSYB	Note B is playing busy Status
	BUSYB is set to 1 by hardware when the output is active playing note B.
STARTB	Note B Start Command
	Writing STARTB=1 initiates a session output on the buzzer. Writing 0 to STARTB has no effect.
	STARTB is self-cleared when the note is completed.
BUSYA	Note A is playing busy Status
	BUSYA is set to 1 by hardware when the output is active playing note A.
STARTA	Note A Start Command
	Writing STARTA=1 initiates a session output on the buzzer. Writing 0 to STARTA has no effect.
	STARTA is self-cleared when the note is completed.

*** Note: If STARTA and STARTB are set to 1 at the same time, Note A is played first followed by Note B. Software can do this for a simple two-notes melody.

14. Core Regulator and Low Voltage Detection

An on-chip serial regulator converts VDD into VDDC for internal circuit supply voltage. Typical value for VDDC is 1.5V at normal mode. In sleep mode, a backup regulator with a typical value of 1.4V supplies VDDC. The VDDC can be trimmed and calibrated, and the trim value for 1.5V is stored in IFB by the manufacturing test.

REGTRM (0xA000) Regulator Trim Register R/W (0x80) TB protected

	7	6	5	4	3	2	1	0	
RD		REGTRM[7-0]							
WR				REGT	RM[7-0]				

14.1 Supply Low Voltage Detection (LVD)

The supply Low Voltage Detection (LVD) circuit detects VDD < VTH condition and can be used to generate an interrupt or reset condition. LVD defaults to a disabled state to save power. An enabled LVD circuit consumes about 100uA to 200uA. The LVDTHD[6-0] sets the compare threshold according to the following equation while LVDTHV is the detection voltage.

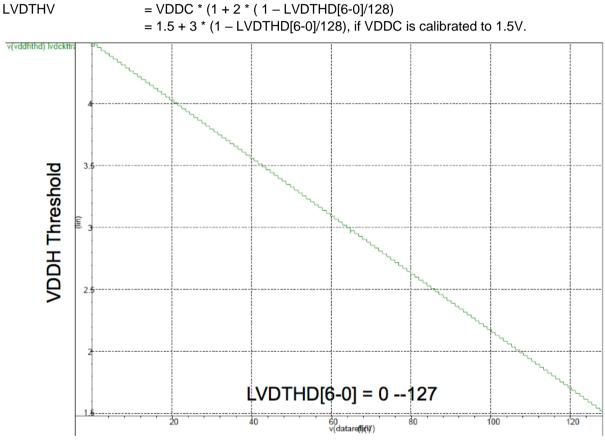


Figure 14-1 LVD Threshold VX LVDTHD[6-0]

LVDCFG (0xA010) Supply Low Voltage Detection Configuration Register R/W 00001000 TB Protected except bit 0 LVTIF

	7	6	5	4	3	2	1	0
RD	LVDEN	LVREN	LVTEN	LVDFLTEN	RSTNFLTEN	-	-	LVTIF
WR	LVDEN	LVREN	LVTEN	LVDFLTEN	RSTNFLTEN	-	-	LVTIF
	/DEN /REN	LVD Enable bit. Set to turn on supply voltage detection circuits. LVR Enable bit. LVREN = 1 allows low voltage detection condition to cause a s reset.						use a system
L١	/TEN	LVT inter		/TEN = 1 allo	ws low voltage	detection co	ndition to ge	nerate an
L١	/DFLTEN	LVD	Filter Enable					



	LVDFLTEN = 1 enables a noise filter on the supply detection circuits. The filter is set at around 30usec.
RSTNFLTEN	RSTN Filter Enable
	RSTNFLTEN = 1 enables a noise filter on the RSTN circuits. The filter is set at
	around 30usec. The filter is default on.
LVTIF	Low Voltage Detect Interrupt Flag
	LVTIF is set by hardware when LVD detection occurs and must be cleared by software.

LVDTHD (0xA011) Supply Low Voltage Detection Threshold Register R/W X1111111 TB Protected

	7	6	5	4	3	2	1	0
RD	-	LVDTHD6	LVDTHD5	LVDTHD4	LVDTHD3	LVDTHD2	LVDTHD1	LVDTHD0
WR	-	LVDTHD6	LVDTHD5	LVDTHD4	LVDTHD3	LVDTHD2	LVDTHD1	LVDTHD0

LVDTHD = 0x00 will set the detection threshold at its minimum, and LVDTHD = 0x7F will set the detection threshold at its maximum.

LVDHYS (0xA012) Supply Low Voltage Detection Threshold Hysteresis Register R/W 00000000 TB Protected

	7	6	5	4	3	2	1	0
RD	LVDHYEN	LVDHYS6	LVDHYS5	LVDHYS4	LVDHYS3	LVDHYS2	LVDHYS1	LVDHYS0
WR	LVDHYEN	LVDHYS6	LVDHYS5	LVDHYS4	LVDHYS3	LVDHYS2	LVDHYS1	LVDHYS0

To ensure a solid Low Voltage detection, a digitally controlled hysteresis is used. If LVDHYEN=1, LVD is asserted as a new threshold defined by LVDHYS[6-0] instead of LVDTHD[6-0]. In typical applications, LVDHYS[6-0] should be set to be smaller than LVDTHD[6-0], such that the recovery voltage is higher than the detection voltage.



15. IOSC and SOSC

15.1 IOSC 16MHz

An on-chip 16MHz Oscillator with low-temperature coefficient provides the system clock to the CPU and other logic. IOSC uses VDDC as the power supply and can be calibrated and trimmed. The accuracy of the frequency is +/- 2% within the operating conditions. This oscillator is stopped and enters into stand-by mode when CPU is in STOP/SLEEP mode and resumes oscillation when CPU wakes up.

	7	6	5	4	3	2	1	0		
RD		SSC	[3-0]		SSA	SSA[1-0]		ITRM[1-0]		
WR		SSC	[1-0]	ITRM[1-0]						
S	SC[3-0]	SSC[3-0] defines the spread spectrum sweep rate. If SSC[3-0] = 0000, then the spread spectrum is disabled.								
S	SA[1-0]	is ch SSA SSA SSA								
IT	RM[1-0]	ITRN	1[1-0] is the c	oarse trimmir	g of the IOSC).				

IOSCITRM (0xA001) IOSC Coarse Trim Register R/W 0x01 TB Protected

IOSCVTRM (0xA002) IOSC Fine Trim Register R/W 0x80 TB Protected

	7	6	5	4	3	2	1	0	
RD		IOSCVTRM[7-0]							
WR				IOSCVT	RM[7-0]				

This register provides fine trimming of the IOSC frequency. The higher the value of IOSCVTRM, the lower the frequency is.

The manufacturer trim value is stored in IFB and is trimmed to 16MHz. The user program provides the freedom to set the IOSC at a preferred frequency if the program is able to calibrate the frequency. Once set, the IOSC frequency has accuracy deviation within +/- 2% over the operation conditions. The following lists the range of the typical IOSC frequency for each trimming setting.

ITRM[1-0]=00, F_IOSC = 16.0MHz - 14.0MHz - 12.0MHz (VTRM[7-0]= 00 - 80 - FF) ITRM[1-0]=01, F_IOSC = 18.5MHz - 16.5MHz - 14.0MHz (VTRM[7-0]= 00 - 80 - FF) ITRM[1-0]=10, F_IOSC = 21.5MHz - 18.5MHz - 16.0MHz (VTRM[7-0]= 00 - 80 - FF) ITRM[1-0]=11, F_IOSC = 24.0MHz - 20.5MHz - 17.5MHz (VTRM[7-0]= 00 - 80 - FF)

15.2 SOSC 128KHz

An ultra-low power slow oscillator of 128KHz is also included. SOSC consumes less than 0.5uA from VDDC and is always enabled. The system uses SOSC32KHz = SOSC/4 = 32KHz for system clock, and for wake-up timer T5, and WDT2/WDT3. SOSC is not very accurate and varies chip to chip, but it is relatively stable toward variations of power supply and temperature. Therefore, software can use IOSC to calibrate SOSC through SOCTRM[4-0].

SOSCTRM (0xA007) SOSC Trim Register R/W (0x10) TB Protected

	7	6	5	4	3	2	1	0	
RD	-	-	-	SOSCTRM[4-0]					
WR	-	-	-	SOSCTRM[4-0]					



16. Touch Key Controller II

For a different EMI environment, a second touch-key controller is implemented. This touch key controller is based on switched capacitance. The block diagram is shown in the following. P0.0 is used to connect an external reference capacitor (typically 0.01uF). The sense capacitor is connected through the ANIO selection of the IOCELL. The software will issue a start command to start the detection. The CREF is first zeroed by turning on a switch to VSS and then released. CKEY starts repetitive cycles of being charged to VREF and dumps the charges onto CREF. At the same time the sequencer keeps counting the cycles. When CREF is charged to ³/₄ VREF, the detection is completed, and the number of cycles is stored in COUNT register. Then an interrupt is issued, and software can read out the COUNT for processing. The interrupt vector is shared with Touch Controller I. The touch key controller II operates on IOSC or reduced frequencies of IOSC.

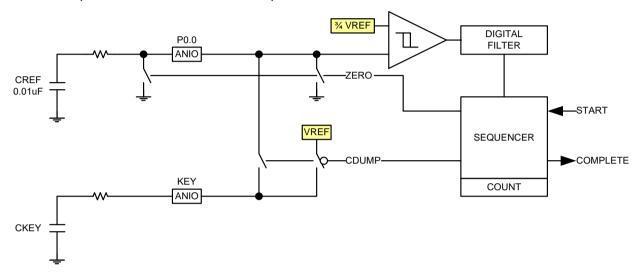


Figure 16-1 Touch Key Controller II diagram

TK2CFGA (0xA008) Touch Key Controller II Configuration Register R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	TKCIIEN	PSREN	REFSEL	VTHSEL	CDTIME[3-0]				
WR	TKCIIEN	PSREN	REFSEL	VTHSEL	CDTIME[3-0]				
P	KCIIEN SREN EFSEL	Touch Key Controller II Enable Pseudo Random Mode Enable VREF Selection VREF=0 uses VDDC as the reference. VDDC should always be used. VREF=1 uses VDD as the reference.							
V	THSEL	Comparator Threshold VTH=0 uses ¾ VREF as the threshold. VTH=1 uses ½ VREF as the threshold.							
CDTIME[3-0] Charge and Dump Base Time Setting CDTIME[3-0] determines the base time for charge and dump of is SYSCLK period * (CDTIME[3-0]+1).				mp duration. T	The duration				

TK2CFGB (0xA009) Touch Key Controller II Configuration Register A R/W (0x00)

	7	6	5	4	3	2	1	0	
RD	IOEN	ZERO[2-0]			CFIL[3-0]				
WR	IOEN		ZERO[2-0]			CFIL	_[3-0]		
	DEN ERO[2-0]	This CRE The	controls ZER F is cleared t internal switc	o 0V Duration	YSCLK IOCE i. is turned on f	or (4+128*(ZE	2mA@3V) turr ERO[2-0]+1) +		
С	FIL[3-0]	Comparator Filter Delay							

The analog output of the comparator is filtered by CFIL[3-0]. The filter output is asserted when preceding CFIL[3-0] samples (sampled by SYSCLK) are all ones.

TK2CMD (0xA00A) Touch Key Controller II Command and Interrupt Register R/W (0x00)

	7	6	5	4	3	2	1	0
RD	TKCINTEN	TKCCN	T[17-16]	ASHIFT	RPT[1-0]		INTF	BUSY
WR	TKCINTEN	-		ASHIFT	RPT	[1-0]	INTF	START
T A	KCINTEN KCCNTII[17-1 SHIFT PT[1-0]	6] Touc Auto Repo RPT accu 00 = 01 = 10 =	Touch Key Contro Touch Key Contro Automatic Shift for Repeat Conversio RPT[2-0] defines t accumulated with 00 = 1 01 = 2 10 = 4 11 = 8		MSB nt count of the c	conversion cyc	cles. The TKC	CNTII is
11	NTF		rupt Flag ⁻ is set by har	dware and m	ust be cleared	d by software.		
	SUSY TART	Busy Start Set S	v Status Conversion	initiate the co	onversion seq	·		when

TK2CNTL (0xA00B) Touch Key Controller II Count Register L R/W (0x00)

	7	6	5	4	3	2	1	0
RD		-						
WR	TK2CNT[7-0]							

TK2CNTH (0xA00C) Touch Key Controller II Count Register H R/W (0x00)

	7	6	5	4	3	2	1	0
RD								
WR	TK2CNT[15-7]							

TKCCNTII is cleared when each START command is issued. And it contains the charge conversion cycle count when the conversion is done.



17. Touch Key Control III

TK3 is an enhanced TK2 implementation with differential dual slope operations. The capacitance to time conversion goes through two phase of charge transfer: One is charging up and the other one is discharging down using two thresholds equally spaced from ½ VDDC. Each charge transfer is obtained by subtraction of charge on internal reference capacitance and key capacitance. The difference of charge/discharge counting behavior is used to determine the key capacitance change in the ratio of internal capacitance. Better noise immunity from power, ground noise and common-mode noise is achieved by dual slope operation. Also better S/N can also be achieved because only differential charge is used for transfer, and the internal capacitance exhibits better temperature and environmental stability which makes the conversion result less sensitive to the changes of temperature and environment.

CREF, the integration capacitor of the charge transfer, is connected to P04 through ANIO multiplexer and CKEY is connected to other GPIO through multiplexer. A replica signal of CKEY is provided through a buffer and routed out as SHIELD through GPIO. The shield signal can be used to cancel mutual capacitance effect from neighboring signal trace of the detected key and provides better noise immunity against moisture or water.

The total count of charging period is recorded as TKHDT[15-0] and total count of discharge count period is recorded as TKLDT[15-0]. To detect a key press capacitance change, the value of TKHDT[15-0] or TKLDT[15-0] can be processed by software and compared with an average non-pressed count. For high frequency noise rejection, the hardware includes a pseudo-random sequence that randomizes the charge and discharge timing. To further enhance the S/N ratio, the conversion can be set to accumulate up to 16 times by hardware and this effectively increases the resolution to 20-bit by trading off the conversion time. A slow moving average of the duty count value is stored in TKBASE[15-0] and software can use this for baseline calculation to automatically compensate for the environment change.

	7	6	5	4	3	2	1	0			
RD	TK3EN		TKCS[2-0]		SHIELDEN	TKIEN	TKLPM	AUTO			
WR	TK3EN		TKCS[2-0]		SHIELDEN	TKIEN	TKLPM	AUTO			
Т	K3EN	TK3	Enable			•					
		TK3EN=0 disables the TK3 circuits and clears all states.									
		TK3I	TK3EN=1 for TK3 normal operations								
Т	KCS[2-0]		Clock Select								
			S[2-0]=000	SYSCLK/2							
			S[2-0]=001	SYSCLK/4							
			S[2-0]=010	SYSCLK/6							
			S[2-0]=011	SYSCLK/8							
			S[2-0]=100	SYSCLK/10							
			TKCS[2-0]=101 SYSCLK/16 TKCS[2-0]=110 SYSCLK/32								
			S[2-0]=110 S[2-0]=111	SYSCLK/32 SOSC/2							
					on modo quito		vical SOSC/2				
S	HIELDEN		SOSC/2 should be used for sleep mode auto wakeup. Typical SOSC/2 is 64KHz. Shield Output Buffer Enable								
0					ld signal buffe	r The buffer	consumes ab	out 200uA			
			n enabled.					0412004/1			
Т	KIEN	TK3	Interrupt Ena	ble							
		TKIE	N=1 enables	the TK3 inter	rrupt. TK3 inte	errupt is gener	rated when a	counting			
					ng the repeat						
				llso generated	d when TKIEN	I=1 and AUT	D=1 after auto	-detection			
			threshold is met. When TK3 interrupt is generated, TKIF is also set to 1 by hardware.								
-					ed, TKIF is als	o set to 1 by I	hardware.				
I	KLPM	-	Low Power N		rationa						
			TKLPM=0 for normal mode operations TKLPM=1 puts the comparator into ultra-low power mode and should be used in								
		auto wakeup power saving mode. In this mode, TKCLK should use SOSC/2 slow									
		clock.									
А	UTO		Wake Up Mo	ode							

TK3CFGA (0xA018) TK3 Configuration Register A R/W (0x00)



AUTO=1 enables auto detect mode. In auto mode, the current duty count register value is compared with baseline plus threshold (either absolute or relative). If duty count value is higher, an interrupt and wakeup are generated.

AUTO=0 enables normal detect mode. In normal mode, writing START with "1" initiates a conversion sequence, and when the duty count is obtained, an interrupt is generated.

TK3CFGB (0xA019) TK3 Configuration Register B R/W (0x00)

	7	6	5 5 4 3 2 1								
RD	RPT	[1-0]	INI[1-0]	ASTDLY[1-0]		LFN	F[1-0]			
WR	RPT	[1-0]	INI[1-0] ASTDLY[1-0] LFNF[1-0]								
RI	PT[1-0]	00 = 01 = 10 =	Repeat Sequence Count 00 = No Repeat 01 = 4 times 10 = 8 times 11 = 16 times								
IN	ll[1-0]	INI[1	Initial Settling Delay INI[1-0] defines the number of TKCLK period for initial settling of CREF. The delay is (INI[1-0] + 1) *4*TKCLK.								
A	STDLY[1-0]	Auto STD each	Auto Mode Start Delay STDLY[1-0] inserts an inter-sequence idle time of (ASTDLY[1-0]+1) * 256 TKCLK at each sequence start. This delay allows the stabilization time from normal mode to sleep mode.								
LF	FNF[1-0]	Low 00 = Injec In th	Low Frequency Noise Filter Setting 00 = disables LFNF Injection noise longer than LFNF[1-0]*8 time is ignored. In the presence of such noise, the cycle count still continues. The end result is that the sum of DUTYL and DUTYH will not equal to cycle count.								

TK3CFGC (0xA01A) TK3 Configuration Registers C R/W (0x00)

	7	6	5	4	3	2	1	0
RD	SLOV	V[1-0]		CYCLE[2-0]		BASEINI	THDSEL	AUTOLFEN
WR	SLOV	V[1-0]		CYCLE[2-0]		BASEINI	THDSEL	AUTOLFEN
	_OW[1-0] YCLE[2-0]	00 = 01 = 10 = 11 = The regis Cycl 000 001 010 011 100 101	Baseline Slow Moving Average setting 00 = 32 average 01 = 64 average 10 = 128 average 11 = 256 average The duty value is averaged by SLOW[1-0] conversion and updated to BASE register through moving average. Cycle Count of each conversion sequence 000 = 1024 001 = 2048 010 = 4096 011 = 8192 100 = 12288 101 = 16384 110 = 32768					
Tł	ASEINI HDSEL	The cycle count is each sequence cycle count. And it is repeated if RPT i Conversion always ends with the defined cycle count. Baseline Initial Value If BASEINI=1, the first DTYL count after entering auto mode is loaded to register as its initial value to start moving average. If BASEINI=0, the value written in BASELINE before entering auto mode the initial value to start moving average. Threshold Value Setting					BASELINE	

AUTOLFEN



THDSEL=0 uses TKTHD[15-0] as the threshold to compare with TKLDT[15-0] to generate the interrupt and wakeup. THDSEL=1 uses TKTHD[15-0] + TKBASE[15-0] as the threshold to compare with TKLDT[15-0] to generate the interrupt and wakeup. Low Frequency Noise Filtering in Auto mode

If AUTOLFEN=0, low frequency noise filtering in Auto mode is disabled. If AUTOLFEN=1, low frequency noise filtering in auto mode is enabled. The low noise filtering status flag is still valid regardless of AUTOLFEN setting. Software can determine whether to discard the current conversion result by checking LFNF flag.

TK3CFGD (0xA01B) TK3 Configuration Registers D R/W (0x00)

	7	6	5	4	3	2	1	0		
RD		CCHG[2-0]		ASTDLYEN	PSRDEN	LFNF	TKIF	BUSY		
WR		CCHG[2-0]		ASTDLYEN	PSRDEN	LFNF	TKIF	START		
С	CHG[2-0]	Inter	nal Reference	e Capacitance	e Select					
			= 10pF							
		001 = 20 pF								
			= 30pF							
			= 40pF							
			= 50pF							
			101 = 60pF 110 = 70pF							
			110 = 70 pc 111 = 80 pc							
A	STDLYEN		Auto Start Delay Enable							
	-		•	ables ASTDL	Y[1-0] delay s	tart for auto n	node.			
				ables ASTDL						
P	SRDEN	Pseu	Pseudo Random Sequence Enable							
			PSRDEN=1 enables the random sequence in conversion.							
				les the rando	•	n conversion.				
LI	FNF			oise Detectior						
				needs to be o			cted in the pre	esent		
т	KIF		Interrupt Flag			by soltware.				
					a TK3 interrup	t occurred by	either conver	sion		
							KIF needs to b			
			y software.							
В	USY		version Status							
				BUSY is set to 1 by hardware and that indicates the conversion sequences are still running.						
S	TART	Start	Conversion							
	Writing "1" into when conversic mode.									

TK3HDTYL (0xA01C) TK3 High Duty Count Register L RO (0x00)

	7	6	5	4	3	2	1	0
RD		TK3HDTY[7-0]						
WR		-						

TK3HDTYH(0xA01D) TK3 High Duty Count Register H RO (0x00)

	7	6	5	4	3	2	1	0
RD		TK3HDTY[15-8]						
WR	-							



TK3LDTYL (0xA01E) TK3 Low Duty Count Register L RO (0x00) 5 2 7 6 4 3 1 0 RD TK3LDTY[7-0] WR TK3LDTYH(0xA01F) TK3 Low Duty Count Register H RO (0x00) 2 1 0 7 6 5 4 3 RD TK3LDTY[15-8] WR TK3BASEL (0xA028) TK3 Baseline Register L R/W (0x00) 6 5 3 2 7 4 1 0 RD TK3BASE[7-0] WR TK3BASE[7-0] TK3BASEH (0xA029) TK3 Baseline Register H R/W (0x00) 5 3 2 7 6 4 1 0 RD TK3BASE[15-8] WR TK3BASE[15-8] TK3THDL (0xA02A) TK3 Threshold Register L R/W (0x00) 7 6 5 3 2 1 0 4 RD TK3THD[7-0] WR TK3THD[7-0] TK3THDH (0xA02B) TK3 Threshold Register H R/W (0x00) 5 7 6 4 3 2 1 0 RD TK3THD[15-8] WR TK3THD[15-8] TK3PUD (0xA02C) TK3 DC Pull-Up/Pull-Down Control Register H R/W (0x00) 7 6 5 4 3 2 1 0 PUDIEN PUDREN PUD[3-0] RD --WR PUIDEN PUDREN PUD[3-0] --TK3PUD is to configure a constant DC pull-up/pull-down on CREF to allow high capacitance touch-key detection. A

DC pull-up/pull-down can compensate for the equivalent resistance caused by a high capacitance key. Thus, connecting a switching current source or resistor can maintain touch key detection sensitivity.

PUDIEN	Pull-up/Pull-down DC Current Enable
PUDREN	Pull-up/Pull-down DC Resistor Enable
PUD[3-0]	Pull-up/Pull-down Selection
	For DC current, PUD[3-0] enables 8uA/4uA/2uA/1uA current source.
	For Resistor, PUD[3-0] enables 5K/10K/20K/40K resistor.



18. GPIO and Pin Interrupt

Each IO pin has a configurable IO buffer that can meet various interface requirements. The GPIO pins can be configured as external interrupt input pins or wake-up pins. Each port has edge detection logic and latch for rising and falling edge detections. During hardware reset and later-on time, the IO buffer is in a high impedance state with all drives disabled.

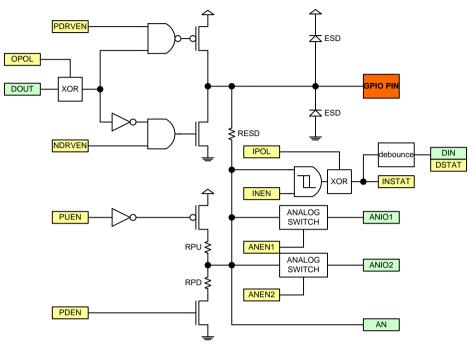


Figure 18-1 GPIO Multi-Function Selection and Pin Interrupt

$100000 (0 \times 100 - 0 \times 100 0 \times 130 - 0 \times 130$) IO Buffor Output Confi	auration Pogistors P/W (0x00)
IOCFGO (0xA100 – 0xA10F, 0xA130 – 0xA13F) io builer output com	guialion Registers R/W (UXUU)

	7	6	5	4	3	2	1	0
RD	HIDRV	PDRVEN	NDRVEN	OPOL	ANEN2	ANEN1	PUEN	PDEN
WR	HIDRV	PDRVEN	NDRVEN	OPOL	ANEN2	ANEN1	PUEN	PDEN
HI	HIDRV High-Speed Drive Enable HIDRV=1 enables high-speed drive. This reduces output rise and fall time with stronger drive during transient. HIDRV=0 configures the output buffer with slower edge transitions. HIDRV=0 sho be used for EMI sensitive applications. Both HIDRV=1 or HIDRV=0 have the same DC drive capabilities.							
PI	DRVEN	Outp		ver enabled. S			IOS of the out	tput driver.
N	DRVEN		ut NMOS driv BLE is the do		et this bit to er	nable the NM	OS of the outp	out driver.
0	POL		out Polarity Co out buffer data	ontrol a polarity cont	rol			
AI	NEN2	Anal	og MUX 2 en	ables control.			pin to the inte	rnal analog
AI	ANEN1 Analog MUX 1 enables control. Set this bit to connect the pin to the internal analog peripheral ANIO1. DISABLE is the default value.					rnal analog		
Pl	PUEN Pull up resistor control. Set this bit to enable pull-up resistor connection to the pin. The pull-up resistor is approximately 6K Ohm. DISABLE is the default value.							
PI	PDEN Pull down resistor control. Set this bit to enable pull-down resistor connection to the pull-down resistor control. Set this bit to enable pull-down resistor connection to the pull-down resistor is approximately 6K Ohm. DISABLE is the default value.							



IOCFGI	OCFGI (0xA110 – 0xA11F, 0xA140 – 0xA14F) IO Buffer Input Configuration Registers R/W (0x00)								
	7	6	5	4	3	2	1	0	
RD	PI1EN	PI0EN	RIF	FIF	INEN	IPOL	DSTAT	INSTAT	
WR	PI1EN	PI0EN	RIEN	FIEN	INEN	IPOL	DBN	I [1-0]	
P R	IEN	Pin I Risin RIF i occu enab Risin Fallir FIF i	Pin Interrupt 1 Enable Pin Interrupt 0 Enable Rising Edge Pin Interrupt Flag RIF is set to 1 by hardware after either a PI1 or PI0 rising edge interrupt has occurred. RIF must be cleared by software writing RIEN with "0". RIEN needs to be enabled if the next rising edge interrupt is required. Rising Edge Pin Interrupt Enable Falling Edge Pin Interrupt Flag FIF is set to 1 by hardware after either a PI1 or PI0 falling edge interrupt has accurred. EIE must be cleared by software writing EIEN with "0". FIEN needs to be						
	IEN IEN	enab Fallir Input INEN INEN Iogic If inp buffe	occurred. FIF must be cleared by software writing FIEN with "0". FIEN needs to be enabled if the next falling edge interrupt is required. Falling Edge Pin Interrupt Enable Input Buffer Enable INEN=1 enables the input buffer. INEN=0 disables the input buffer. In the disabled state, the output of input buffer is logic 0. If input is floating or not solid 0 and 1 voltage level, DC current may flow in the input buffer. Disabling input buffer can remove DC leakage of input buffer due to this						
	reason. IPOL Input Polarity IPOL=1 reverses the input logic. IPOL=0 is for normal logic polarity.								
D	INSTAT Real Time Status of Input Buffer. INSTAT is read only. DBN[1-0] De-Bounce Time Setting 00 – OFF 01 – 4 SOSC32KHz (130usec) 10 – 16 SOSC32KHz (530usec) 11 – 64 SOSC32KHz (2msec) DSTAT Real Time Status after De-bounce. DBNST bit is read only. The de-bounced input is used for generating interrupt, as well as all other multifunction inputs including PORT registers. The non-de-bounced input can only be read through INSTAT bit.								

MFCFGxx (0xA120 - 0x A12F, 0xA150 - 0xA15F) Port Multi-Function Configuration Registers R/W (0x00)

	7	6	5	4	3	2	1	0
RD	MFCFG[7-0]							
WR	MFCFG[7-0]							

Please see PIN OUT section for the description of each port multi-function selection.



19. Information Block IFB

There are two IFB blocks and each one contains 512 x 16 bit information. The address 0x000h to 0x03Fh in first IFB is used to store manufacturer information. Address 0x040 is for wait time of boot code, and 0x041 to 0x043 are used for boot code. The first IFB can be erased only in Writer Mode and can be written using Flash Controller for address beyond 0x40. This is to protect any alteration of the manufacturer and calibration data. The 2nd IFB is open for erase/write for user access. The following table shows the contents of the first IFB for the manufacturer data. Please note that these are in lower LSB bytes. The upper MSB byte contains its corresponding ECC code.

Address	Туре	Description
00 – 01	М	IFB Version
02 – 07	М	Product Name
08 - 09	М	Package and Product Code
0A – 0B	М	Product Version and Revision
0C	М	Flash Memory Size
0D	М	SRAM Size
0E – 0F	М	Customer Specific Code
10	М	CP1 Information
11	М	CP2 Information
12	М	CP3 Version
13	М	CP3 BIN
14	М	FT Version
15	М	FT BIN
16 - 1B	М	Last Test Date
1C – 1D	М	Boot Code Version
1E	М	Boot Code Segment
1F	М	Checksum for 0x00 – 0x1E
20	М	REGTRM value for 1.55V
21	М	IOSC ITRM value for 16MHz 5V
22	М	IOSC VTRM value for 16MHz 5V
23	М	LVDTHD value for detection of 4.0V
24	М	LVDTHD value for detection of 3.0V
25	М	IOSC ITRM value for 16MHz 3.3V
26	М	IOSC VTRM value for 16MHz 3.3V
27	М	Reserved
28	М	Reserved
29	М	Reserved
2A	М	Reserved
2B – 2D	М	Reserved
2E – 2F	М	Internal Reference LSB/MSB
30	М	SOSC 128KHZ Trim Value
31 – 33	М	Reserved
34	М	Timer 0 High TRIM *
35	М	Timer 0 Low TRIM *



Address	Туре	Description
36 – 38	М	Reserved
39	М	Checksum for 0x20 – 0x39
3A – 3F	М	Retention Value
40	M/U	 Boot Code Wait Time. Boot code uses this byte to determine the ISP wait-time. This wait-time is necessary for a stable ISP. After the user program is downloaded, the wait time can be reduced to minimize power-on time. Each "1" in bit [1-0] constitutes 1 second, bits [3-2] constitutes 2 second and bit [7] is check of I2CSCL2. For example, 0b10000111 is a 4-second wait time and also checks I2CSCL2 pad status. If I2CSCL2 is low, then wait time of 6 second is used regardless of bit [3-0] setting. The maximum wait time is 6 second, and minimum wait time is 0 second.
41 – 43	М	Reserved
44 - 1FF	U	User One-Time Programmable Space

Table 19-1 Information Block (IFB)



20. Writer Mode

Writer Mode (WM) is used by the manufacturer or by users to program the flash (including IFB) through a dedicated hardware (Writer or Gang Writer). Under this setup, only WM related pins should be connected, and all other unused pins left floating. Writer mode follows a proprietary protocol and is not released to general users. Users must obtain it through a formal written request to the manufacturer and must sign a strict Non-Disclosure-Agreement. The Writer Mode provides the following commands.

ERASE Main Memory

ERASE Main Memory and IFB

READ AND VERIFY Main Memory (8-Byte)

WRITE BYTE Main Memory

READ BYTE IFB

WRITE BYTE IFB

Fast Continuous WRITE

Fast Continuous READ

The writer mode is protected against code piracy. The default state of the device is locked writer mode. Only ERASEMM and ERASEMMIFB, and READVERIFYMM commands can be executed. It can be unlocked by READVERIFYMM the range of 0x06F8 to 0x06FF. These locations contain an 8-byte security key that user can place to secure the e-Flash contents. The probability of guessing the key is 1 in 2^64 = 1.8E19. Since each trial of READVERIFYMM takes 10usec, it takes about 6E6 years to exhaust the combinations. If the key is unknown, a user can choose to issue the ERASEMM command then fully erase the entire contents (including the key). Once fully erased, all data in the flash is 0xFF, and it can be successfully unlocked by READVERIFYMM with 8-bytes of 0xFF. The users must not erase the information in IFB. And the user should not modify the manufacturer data. Any violation of this results in the void of manufacturer warranty. The following pins are used for e-Flash writer mode. P10 is optional.

PIN	ю	Description	Function
P22	0	Flash serial data output.	SDO
P21	I	Flash serial data input	SDI
P20	I	Flash serial clock input.	SCLK
P17	I	Flash serial port enable, low active	SCE
RSTN	I	Write mode entry input using timing sequence	RSTN
P23	0	TBIT status output	TBIT
VDD	I	Power supply for DUT	VDD
VSS	I	Ground supply for DUT	VSS



21. Boot Code and In-System Programming

After production testing of the packaged devices, the manufacturer writes the manufacturer information and calibration data in the IFB. At the last stage, it writes a fixed boot code in the main memory residing from 0x7000 to 0x7FFF. The boot code is executed after resets.

The boot code first reads IFB's wait time setting and scans the I²C slave for any In-System-Programming request during the wait time duration. If any valid request occurs during the scan, the boot-code proceeds to follow the request and performs the programming from the host. Otherwise, the boot code jumps to 0x0000 after the wait time is expired. The default available ISP commands are as below.

UNLOCK

DEVICE NAME

BOOTC VERSION

READ AND VERIFY Main Memory (8-Byte)

ERASE Main Memory excluding Boot Code

ERASE SECTOR Main Memory

WRITE BYTE Main Memory

SET ADDRESS

CONTINUOUS WRITE

CONTINUOUS READ

READ BYTE IFB

WRITE BYTE IFB

Like writer mode, ISP is in the locked state at default. No command is accepted under a locked state. To unlock the ISP, an 8-byte READ and VERIFY of 0x06FF8 to 0x06FFF must be successfully executed. Thus, the default ISP boot program provides similar code security as the Writer mode.



22. Electrical Specifications

22.1 Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	Note
VDD	Supply Voltage	5.5	V	
ТА	Ambient Operating Temperature	-40 – 85	°C	
TSTG	Storage Temperature	-65 – 150	°C	

22.2 Recommended Operating Condition

Symbol	Parameter	Rating	Unit	Note
VDD	Supply Voltage for IO and 1.5V regulator	2.5– 5.5	V	
ТА	Ambient Operating Temperature	-40 – 85	°C	

22.3 DC Electrical Characteristics (VDD=2.5V to 5.5V TA=-40°C to 85°C)

Symbol	Parameter	Min	Тур	Max	Unit	Note
Power Suppl	ly Current					
IDD Normal	Total IDD through VDD at 16MHz	-	7	-	mA	
IDD versus Frequency	Total IDD Core Current versus Frequency	-	150	-	μΑ/ MHz	
IDD, Stop	IDD, stop mode	-	150	-	μA	Main regulator on
	IDD, sleep mode, 25°C	-	1	3	μA	
IDD, Sleep	IDD, sleep mode, 85°C	-	5	15	μA	Main regulator off
GPIO DC Ch	naracteristics					
VOH,4.5V	Output High Voltage 1 mA	-	-0.2	-0.4	V	Reference to VDD
VOL,4.5V	Output Low Voltage 8 mA	-	0.3	0.5	V	Reference to VSS
VOH,3.0V	Output High Voltage 1 mA	-	-0.3	-0.5	V	Reference to VDD
VOL,3.0V	Output Low Voltage 8 mA	-	0.3	0.5	V	Reference to VSS
IIOT	Total IO Sink and Source Current	-100	-	100	mA	
VIH	Input High Voltage	¾VDD	-	-	V	
VIL	Input Low Voltage	-	-	1⁄4VDD	V	
VIHYS	Input Hysteresis	-	600	-	mV	
RPU	Equivalent Pull-Up resistance	-	5K	-	Ohm	
RPU,RSTN	RSTN Pull-Up resistance	-	5K	-	Ohm	
RPD	Equivalent Pull-Down Resistance	-	5K	-	Ohm	
REQAN1	Equivalent ANIO Switch Resistance, 3.3V	-	220	-	Ohm	ANIO1 Switch
	Equivalent ANIO Switch Resistance, 5V	-	70	-	Ohm	ANIO1 Switch
REQAN2	Equivalent ANIO Switch Resistance, 3.3V	-	220	-	Ohm	ANIO2 Switch
	Equivalent ANIO Switch Resistance, 5V	-	70	-	Ohm	ANIO2 Switch
VDDC Chara	acteristics					
VDDCN	Normal Core Voltage 1.55V (Calibrated)	1.45	1.55	1.65	V	Normal Mode
VDDCS	Sleep Core Voltage 1.5V	-	1.40	-	V	Sleep Mode
Low Supply	(VDD) Voltage Detection					
VDET	Detection Range	2.0	-	4.8	V	

T	
	MICROSYSTEMS

Symbol	Parameter	Min	Тур	Мах	Unit	Note		
VDETHYS	Detection Hysteresis	-	100	-	mV			
22.4 AC Electrical Characteristics (VDD =2.5V to 5.5V TA=-40°C to 85°C)								
Symbol	Parameter	Min	Тур	Max	Unit	Note		
Supply Timi	ng							
TSUPRU	VDD Ramp Up time	1	-	50	msec			
TSUPRD	VDD Ramp Down Time	-	-	50	msec			
TPOR	Power On Reset Delay	-	5	-	msec			
IOSC								
	IOSC Calibrated 16MHz	-1	0	+1	%			
	IOSC Startup Time	-	-	1	µsec			
FIOSC	Temperature and VDD variation 85°C	-2	0	+2	%			
	Stable Time and Reset for IOSC after power up	2	-	-	msec	After VDD > 2.0V		
SOSC								
FSOSC	Slow Oscillator frequency	-	128	-	KHz			
GPIO Timin	g							
	Propagation Delay 3.3V No load	-	6	-	nsec			
TPD3 ++	Propagation Delay 3.3V 25pF load	-	15	-	nsec			
	Propagation Delay 3.3V 50pF load	-	20	-	nsec			
	Propagation Delay 3.3V No load	-	5	-	nsec			
TPD3	Propagation Delay 3.3V 25pF load	-	12	-	nsec			
	Propagation Delay 3.3V 50pF load	-	15	-	nsec			
	Propagation Delay 3.3V No load	-	5	-	nsec			
TPD5 ++	Propagation Delay 3.3V 25pF load	-	12	-	nsec			
	Propagation Delay 3.3V 50pF load	-	16	-	nsec			
	Propagation Delay 3.3V No load	-	4	-	nsec			
TPD5	Propagation Delay 3.3V 25pF load	-	9	-	nsec			
	Propagation Delay 3.3V 50pF load	-	12	-	nsec			

22.5 CLASSIFICATION REFLOW PROFILES

Pb-Free Process-Package Classification Temperatures

Package Thickness	Volume mm3<350	Volume mm3: 350-2000	Volume mm3>2000
<1.6 mm	260°C	260°C	260°C
1.6 mm-2.5 mm	260°C	250°C	245°C
>=2.5 mm	250°C	245°C	245°C

Profile Feature	Pb-Free Assembly
Ramp-Up Rate (TL to Tp)	3 °C / second max.
Preheat – Temperature Min (Tsmin) to Max (Tsmax)	150~200 °C
–To,e (tsmin to tsmax)	60-120 seconds



Profile Feature	Pb-Free Assembly
Time maintained above – Temperature (TL)	217 °C
– Time (tL)	60-150 seconds
Peak package body temperature (Tp)(Note 2)	See package classification
Time within 5°C of specified classification Temperature (tp)	30 second min. (Note 3)
Ramp-Down Rate (Tp to TL)	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.
Number of applicable Temperature cycles	3 cycles max.

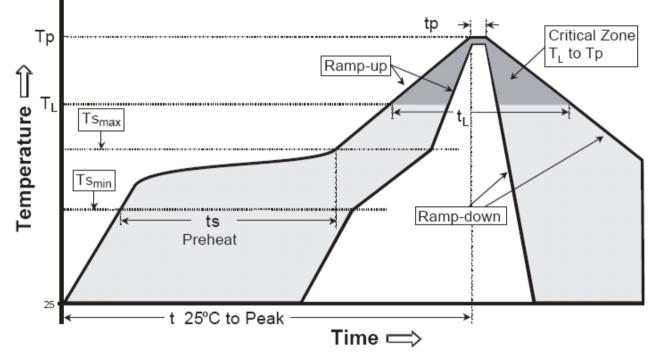


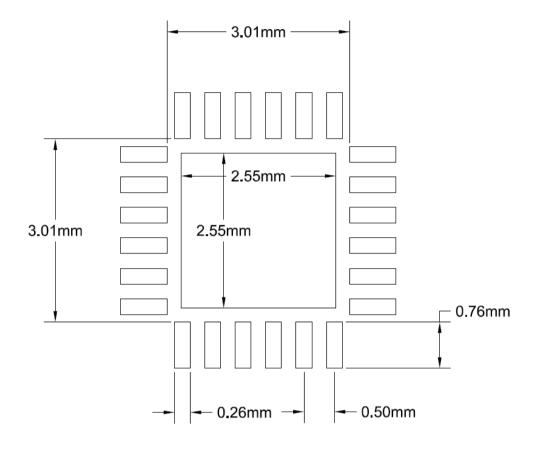
Figure 22-1 Temperature Reflow Profile



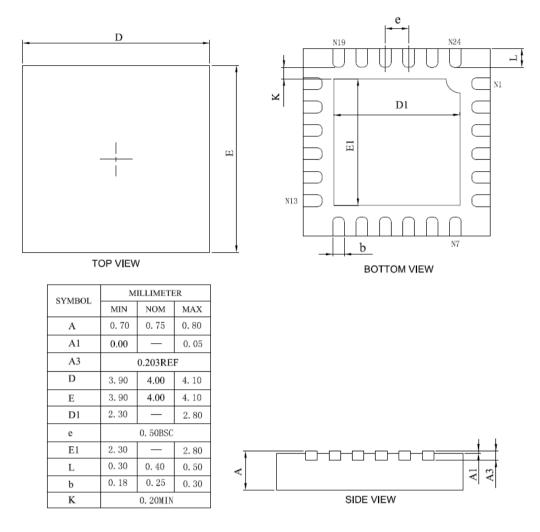
23. Packaging Outline

23.1 24-pin QFN

23.1.1 Recommended Land Pattern



23.1.2POD



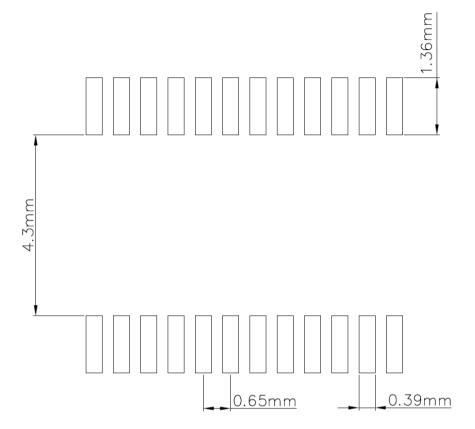
NOTES:

The thermal pad shows different shape among different factories.



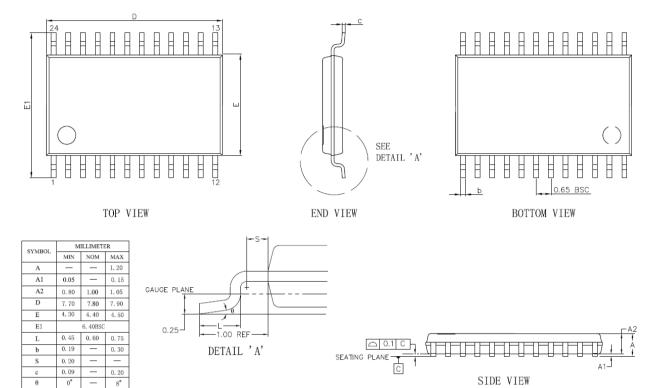
23.2 24-pin TSSOP

23.2.1 Recommended Land Pattern





23.2.2POD





24. Ordering Information

Operating temperature: -40°C to 85°C

Order Part No.	Package	QTY
IS31CS8974-ZNLA3-TR	TSSOP-24, Lead-free	2500/Reel
IS31CS8974-QFLS2-TR	QFN-24, Lead-free	2500/Reel

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a.) the risk of injury or damage has been minimized;

- b.) the user assumes all such risks; and
- c.) potential liability of Lumissil Microsystems is adequately protected under the circumstances

25. <u>Errata</u>





26. <u>Revisions</u>

Revision	Detailed Information	Date
А	First formal release	2021.04.09
в	 Add packaging type "tray" on ordering information Add I/O PAD block diagram Revise SPI timing illustration Update EUART2 and LIN controller SYNCMD description 	2022.04.08
С	 Rename SIOSC to SOSC32KHz, and SOSC32KHz is 32KHz which is divided from SOSC (128KHz) Remove read bit START from I2CSCON2[4] Bits 4-7 of RSTCMD register can't be read The above description is for Section 1.23 Reset – RSTCMD register Revise "IOSC uses VDDC as Power supply and can be calibrated and trimmed." instead of early description of VDD18 The above description is from Section 11. IOSC and SOSC Update Section TK2CFGB bit 5-7 ZER0[2:0] description The above description is for Section 12 Touch Key Controller II TK2CFGB IFB address 40 bit 6 I2CSCL1 is not supported. The above description applies to TCON descriptions in Section 1.5 Interrupt System and Section 1.9 System Timers – T0 and T1 TA/TB Protect support modification: A. Remove TA Protect support of register for TA Protect Modification TB Protect support of Flash Zone protection from FLSHPRT[0] to FLSHPRT[31] TB Protected is not * TB Protect support for register LVDCFG except bit 0 LVTIF Revise some typos Reword some contents for clear explanations Reword some contents for clear explanations Revise product features "Up to 25MHz 1-Cycle 8051 CPU core (16MHz zero wait state) " and 2.5v to 5.5V single power supply 	2022.07.26
D	 Support passive proximity sensing Update the device package as "RoHS & Halogen-Free compliant" in the product "Features" Modify Boot code execution procedures in Section 17. Boot Code and In-System Programming Definitions of IFB address 2B~2D are all updated as "Reserved" in Section 15. Information Block IFB Update "Features" for interrupt support as "All GPIO pins can be assigned to two external interrupts" Update XRAM up to 0x07FFH in Data Memory Map table in MEMORY MAP section Update the operation descriptions for CRCMODE[2-0] of CCCFG register in Section 1.16 Checksum/CRC Accelerator Update power saving mode support for idle, stop, and sleep in "Features" section. Revise VDDC from 3v ~ 5.5v to 2.5v ~5.5v for 18.3 & 18.4 DC and AC Electrical Characteristics Remove "ZTRGEN" and "CTRGEN" bits for Zero and Center ADC Trigger Enable support of PWMCFG2 register and also ADC information in this document. Add IFB addresses 34 & 35 Timer 0 TRIM function and update IFB address 41~43 as reserved. Please refer to Section 15 Information Block IFB Add "TSCA compliance" support 	2023.07.28



Revision	Detailed Information	Date
E	 Modify IOCFGI bit 1 read as DSTAT instead of DBNST in the register descriptions. CS8974/CS8975/CS8976 modification Update Figure 9-1 EUART2 with LIN Controller block diagram 	2024.05.17